SitePro™ Controller

Shelf Assembly EA101209V1

tyco Electronics

MACOM

ADDENDUM NUMBER 1 TO SITEPRO MAINTENANCE MANUAL MM101271V1 R2A

This addendum adds an improved high-speed data (HSD) adjustment procedure to the following manuals:

- SitePro Controller Maintenance Manual MM101271V1 R2A
- SitePro Simulcast Controller Card Maintenance Manual MM101509V1 R1A
- GPS Simulcast Systems (with SIM and SitePro Controllers) System Alignment and Field Testing Procedures MM101724V1 R1A

This improved procedure allows the adjustment to be made on-the-fly without the need to put the SitePro Controller into Test Mode. The adjustment range is the same as with the earlier procedure [two hexadecimal digits 00-FF]. The values entered will take effect immediately. By writing these values to EEprom they will persist through a reset. From a hyper-terminal connected to the SitePro Controller serial port[1] perform the following:

HIGH-SPEED DATA ADJUSTMENT PROCEDURE

Adjust HSD by modifying the pot setting. Once the correct level is found it must be stored in permanent memory.

1. Adjust the 'real time' high-speed level:
   SI2C 50 1 5 <rtn> sets slave device for all subsequent read/write operations (50 is EE pot)
2. Read current data from the HSD pot:
   RI2C A9 A9 <rtn> reads current data at specified address range (A9 is location of the HSD pot)
3. Write new values to the HSD pot. The value from step 2 provides an initial set point. The command to write a value is:
   WI2C A9 xx <rtn> were xx is the hexadecimal value written to the HSD pot. Write new values until the desired deviation is achieved.
4. Store the new value which achieves the desired deviation into permanent memory (novRAM) using the following commands:

   SI2C A6 2 5 <rtn> sets slave device for all subsequent read/write operations (A6 is EEprom)
   WI2C 03 xx <rtn> writes new value of the HSD Pot in EEprom (03 is location of HS level)
   RI2C 03 03 <rtn> reads current value of the HSD Pot from EEprom (to check if written correctly)

[1] This procedure can also be performed through an ethernet port. Refer to the applicable manual for instructions.

NOTICE!

This manual covers products manufactured and sold by **M/A-COM Private Radio Systems, Inc.**

NOTICE!

Repairs to this equipment should be made only by an authorized service technician or facility designated by the supplier. Any repairs, alterations or substitution of recommended parts made by the user to this equipment not approved by the manufacturer could void the user's authority to operate the equipment in addition to the manufacturer's warranty.

NOTICE!

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1.0 SPECIFICATIONS[1]

INPUT VOLTAGE	+13.8±20% VDC
CURRENT DRAIN	
Without 9600 baud modem	900mA (typical), 1.5 Amps (maximum)
With 9600 baud modem	1.5 Amps (typical), 2 Amps (maximum)
OPERATING TEMPERATURE	-22°F to +140°F (-30°C to +60°C)
DIMENSIONS (H x W x D)	1.75 x 17.12 x 15.625 inches (4.44 x 43.48 x 39.69 cm)
DATA TRANSMISSION	
High Speed (RF and phone line)	9600 ±1bps (EDACS Wideband)
Low Speed	150 ±1bps
COMMUNICATION INTERFACE	
Redundant Communication Link	
Data Levels	0 to 13.8 VDC (nominal)
Data Format	1 start bit, 1 stop bit, and 8/9 data bits
Data Rate	38.4 kbaud
Ethernet Interfaces	10 Mbit

[1] These specifications are intended to be used by the service technician during servicing. Refer to the appropriate Specification Sheet for the complete Specification.

2.0 RELATED PUBLICATIONS

Publication	Title
LBI-39152	Rockwell Modem Interface Card ROA 117 2247/1 Rockwell Modem Assembly, RYTUA 921 01/1 RS-232 INTERFACE CARD, ROA 117 2247/2
MM101343V1	SitePro Controller Installation and Configuration Manual
MM101461V1	SitePro Personality Programming Manual

3.0 SAFETY SYMBOLS AND INFORMATION

The **WARNING** symbol calls attention to a procedure, practice, or the like, which, if not correctly performed or adhered to, could result in personal injury. Do not proceed beyond a WARNING symbol until the conditions identified are fully understood or met.

The **CAUTION** symbol calls attention to an operating procedure, practice, or the like, which, if not performed correctly or adhered to, could result in damage to the equipment or severely degrade the equipment performance.

The **NOTE** symbol calls attention to supplemental information, which may improve system performance or clarify a process or procedure.

The **ESD** symbol calls attention to procedures, practices, or the like, which could expose equipment to the effects of **E**lectro-**S**tatic **D**ischarge. Proper precautions must be taken to prevent ESD when handling circuit modules.

- The means of disconnecting power from a station cabinet is the cabinet power supply plug.
- When conducting repair/maintenance, disconnect the cabinet power supply plug from the AC source.
- In European applications, equipment must be installed in a closed cabinet.
- Only replace components with components specified by M/A-COM Private Radio Systems.

4.0 INTRODUCTION

The SitePro Controller was developed by M/A-COM Private Radio Systems as the next generation trunking controller. This GETC replacement increases site reliability and security, and enables new site features.

4.1 Overview

SitePro Controller EA101209V1 is the distributed control equipment used at the base station of an EDACS® or ProVoice™ communication system. The SitePro Controller interprets and directs inbound calls, processes these calls, and issues appropriate commands about how calls are handled. The SitePro Controller is the heart of an EDACS or ProVoice critical communications system (Figure 1 - SitePro/Site Interface Module (SIM) Controller).

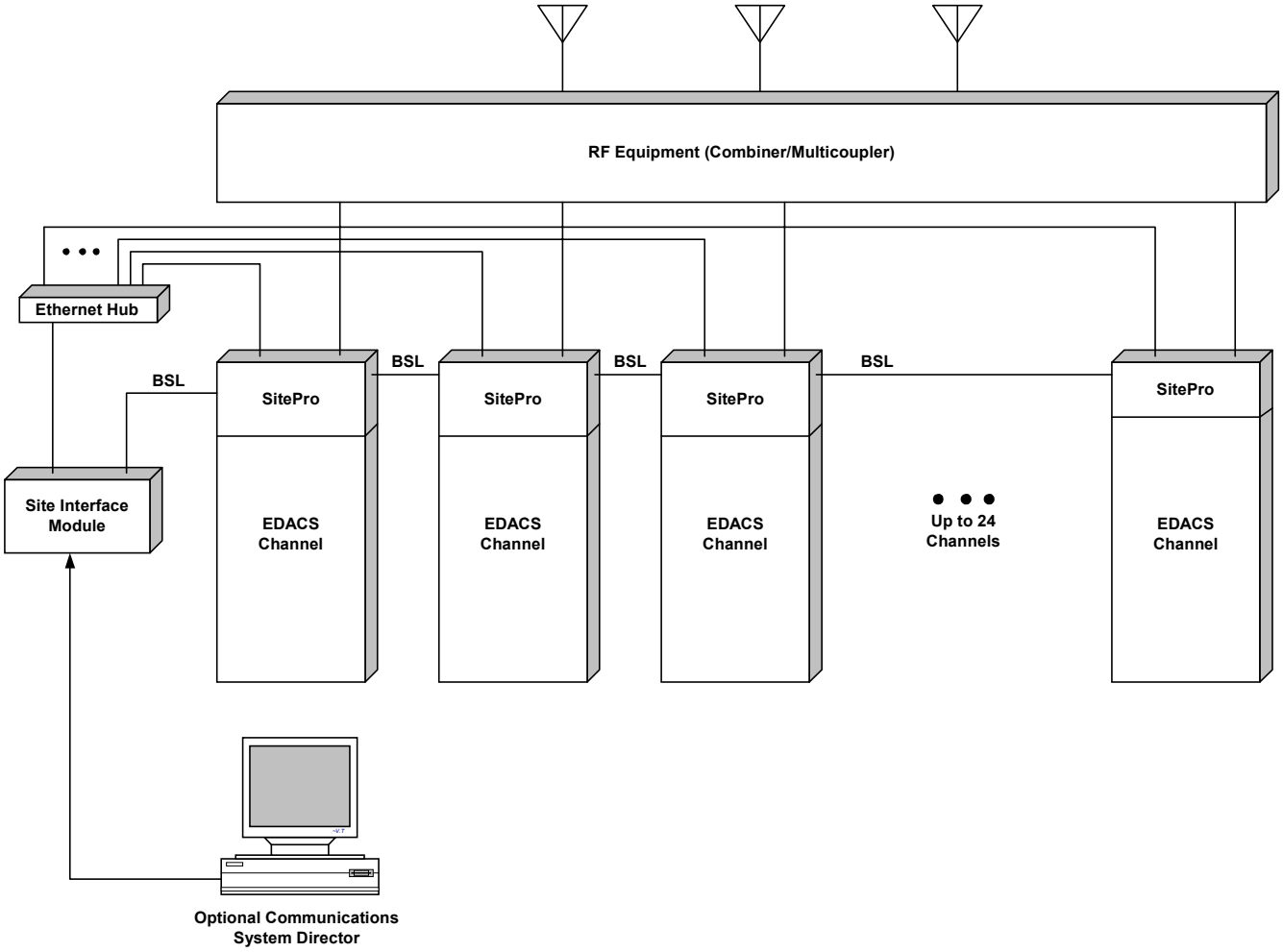

Figure 1 - SitePro/Site Interface Module (SIM) Controller

4.2 Operational Features

The CSD allows access to the user and site database utilized by the SitePro Controller. The SitePro Controller offers the following features:

1. **Eight Priority Levels** – The SitePro Controller prioritizes calls from a list of individual and group identification numbers (LIDs and GIDs) for use during queuing. This prioritized list ensures that higher priority calls are processed first for critical communications.
2. **Call Validation** – The SitePro Controller checks the ID of every radio attempting to access the system. An invalid ID attempting to use the system will be denied access, eliminating system security breeches.
3. **Unit Enable/Disable** – The SitePro Controller has the capability to disable and enable radios over the air. This feature prevents intruders from accessing the system with stolen or misplaced radios.
4. **Dynamic Regroup** – This feature allows the SitePro Controller to reconfigure radio-operating groups in response to critical emergency situations.
5. **Recent Priority Increments** – The SitePro Controller is able to increase the priority level of ID's that have recently placed calls. This allows ongoing conversations to have a higher priority.
6. **Local Telephone Interconnect** – The SitePro Controller supports local telephone interconnect. Calls can be made to and from an individual or to a group in an EDACS or ProVoice system.
7. **Multiple Channel Partition (MCP)** – Using MCP, the SitePro Controller is capable of segregating sets of channels for exclusive use by select users. Up to 15 distinct partitions may be defined to ensure channel availability for critical communications.
8. **Toll Call Restriction** - The SitePro Controller is able to restrict Hotline telephone access by radio for both local and long distance calls.
9. **Patch and Simulselect** - The SitePro Controller allows console dispatchers to "patch" together different talkgroups. This feature allows maximum response to emergency situations.
10. **Site Configuration** - The SitePro Controller is the repository for critical site configuration data resident on the **C**ommunications **S**ystems **D**irector (**CSD**).
11. **Redundant Downlink GETC™ (Optional)** - A Downlink GETC shelf provides the 9600-baud Integrated Multisite and Console Controller (IMC) link for communications control from the repeater site to the dispatch center site or multisite switch.

4.3 Options and Accessories

Site Sentry Alarm and Control System – The Site Sentry alarm and control equipment enables the SitePro Controller to monitor key aspects of the site operation, including the following:

1. Remote reporting of inputs from customer-specific alarm sensors.
2. Remote control of relays that operate customer-specific devices.

3. Diagnostic testing of system operation.
4. Local display of system status

The Site Sentry also keeps track of transmitter performance and the antenna system. The parameters monitored to verify the system health are transmitter power, forward and reflected antenna power, and antenna **V**oltage **S**tanding **W**ave **R**atio (**VSWR**).

Site SureCall Test Call System – Site SureCall allows remote channel monitoring and testing of repeater stations via a **T**est **U**nit (**TU**) radio.

Hotline Local Telephone Interconnect – The SitePro Controller provides the processing for Hotline. Calls can be made from the **P**ublic **S**witched **T**elephone **N**etwork (**PSTN**) to an individual or group as well as from a radio to the PSTN.

4.4 SUMMARY

The SitePro Controller provides the latest control technology to ensure that the EDACS or ProVoice critical communication system is unmatched in system performance. The SitePro Controllers are capable of maintaining the following critical communication features even if the SIM, due to a temporary failure, is taken out or service:

1. Eight Priority Levels
2. Call Validation
3. Recent Priority Increment
4. Multiple Channel Partition
5. Patch and Simulselect

5.0 MAINTENANCE AND SERVICE

This manual provides maintenance and servicing information for M/A-COM SitePro Controller Shelf Assembly EA101209V1[2]. Production versions of this shelf consist of the following components:

- Shelf Assembly — MA101080V1
- Interconnect Board Assembly (A1) — CB101073V1
- Controller Board Assembly (A2) — CD101069V1
- SitePro Modem Board (A2-A1) — CB101074V1
- Rockwell Modem Interface
  Card Assembly (A3) — ROA 117 2247
  Rockwell Modem Assembly (A7) — RYTUZ 921 01/1
- Analog Board (A4) — CB101070V1
- Power Supply Module (A5) — PS-PS101328V1
- Display Module (A6) — MA101082V1
  Display Board Assembly (A6-A1) — CB101077V1
  Cable (A6-W1) — CA101222V1
- Input Cable to the Power Supply (W1) — CA101211V1
- Output Cable from the Power Supply (W2) — CA101212V1

5.1 APPLICATIONS

The SitePro Controller can be installed and configured for several different station applications. Initially the basic configuration is for the EDACS Station Trunking Shelf. This shelf enables the station to function as part of an EDACS trunked communication system by providing digital signaling and control of the associated base station. In addition, the SitePro Controller provides an interface between the base station repeater, the **S**ite **I**nterface **M**odule (**SIM**) and other channel SitePro Controller(s) at the same time.

5.2 COMPATIBILITY AND MIGRATION

The SitePro Controller, with the exception of the Site Controller, is compatible with **GETC** compatible devices as follows:

- Downlink GETC
- SIM
- SureCall
- Hotline
- Site Sentry

[2] The Service Technician(s) should always consult any application manuals, Software Release Notes (SRN), and Specific Customer information provided with the system whenever the equipment requires service or repair.

The requirements for compatibility and migration are that:

1. The SitePro Controller will only switch modes if the Control Channel fails or a configuration command is received. The SitePro Controller will, however, change modes as currently implemented by the GETC. For example, the SitePro Controller Control Channel can switch modes, without failure or configuration command, if it detects carrier.
2. For High Speed Data Modulation, the SitePro Controller has a separate Analog Board (A4) providing software configurable filtering, which is compatible with high-speed data types.

5.3 SYSTEM EXTERNAL INTERFACES

(SitePro Trunked Interface Specification)

The following is a description of all electrical connections to the SitePro Controller. All input/output definitions are relative to the SitePro Controller. This configuration supports EDACS, Simulcast and Voted systems. The analog and digital control signals provide an interface to a variety of base stations and are grouped by functionality.

5.3.1 Station Control

- **LocRxAudio** - Analog input

  MASTR III level = 1 Vrms, Zin = 100Kohm, bias = ac coupled

  This signal is unfiltered local receiver audio from the base station also called Volume/Squelch or VolSqHi and carries either High Speed Data (control signaling/digital audio) or Low Speed Data with analog audio. The two components are internally separated.

- **RUS** - Digital TTL active high input

  This signal is the Receiver UnSquelch signal from the base station and is activated when a carrier of sufficient signal strength (as determined by the squelch pot setting) is present.

- **LSD** - Analog output

  level = 300 mVrms
  Zout = 100ohm, bias = 0 volts

  This signal is the Low Speed Data output to the base station. The signal is conditioned through a low pass filter to remove frequency components above 300 Hz to allow multiplexing with analog voice audio.

- **HSD** - Analog output

  level = 1.1 Vrms
  Zout = 100ohm, bias = 0 volts

  This signal is the High Speed Data output to the base station modulator. The signal is conditioned through a specially designed filter needed to meet precise RF modulation bandwidth limitations.

- **LocPTT** - Digital active low open drain output

  This signal is the Local PTT control. This line, when low, will key up the base station transmitter and select the local receiver audio source for transmission.

- **RemPTT** - Digital active low open drain output

  This signal is the Remote PTT control. This line, when low, will key up the base station transmitter and select the remote audio source for transmission.

- **A/DmodCtrl** - Digital output TTL

  This is the Analog/Digital Modulation Control signal. When high, HSD is routed to the base station transmit. When low, LSD/audio is routed to the base station transmit.

- **HSAcq** - Digital output open drain output

  This is the High-Speed Acquisition control signal. A high or low signal produces a corresponding high or low time constant in the limiter circuit.

- **LocRxMute** - Digital active low output (8.5 volt low Z source)

  This signal is the Local Receiver Mute control. This line, when low, blocks the routing of receiver audio to the base station transmitter and line out. Muting occurs during HSD transmission, no valid carrier present, or no valid LSD present.

- **Walsh1/Walsh2** - Digital output TTL

  These two signals are combined to form a two bit Walsh Function DAC. This signal is the Low Speed Data source.

- **Synth_Clk** – Digital open drain output

  This signal provides the clock source for loading the base station frequency synthesizer (required for MIIe). Data is clocked on the negative edge of the clock. The baud rate is approximately 2.4Kbaud.

- **Synth_Data** – Digital open drain output

  This signal provides the data source for loading the base station frequency synthesizer (required for MIIe). Data is clocked on the negative edge of the clock. The baud rate is approximately 2.4Kbaud.

- **Synth_LdEn** – Digital open drain output

  This signal is the Synthesizer Load Enable control. This line, when high, permits the base station frequency synthesizer to be loaded and is used for protection against invalid transitions on the clock and data lines.

- **Synth_Locked** – Digital TTL active high input

  This is the Synthesizer Locked signal. This line, when high, indicates that the base station synthesizer is locked. This is used for verifying successful synthesizer loading and is also continuously monitored as a failure mode.

- **PAFail** - Digital TTL active high input diode isolated with pull-up

  This is the Power Amp Failure indicator. This line, when high, indicates that the base station PA has failed. A floating line asserts PA Fail.

- **RemAudioFlag** - Digital TTL active low input, diode isolated

  This is the Remote Audio Present indicator. This line, when low, indicates that remote audio from the IMC is present. This is generated by the base station in response to 2175Hz or E&M from the IMC.

- **FSL** - Digital open drain bi-directional

  output: 300-mA sink (low), 10mA source (high)

  input: Zin = 1k ohm

  This is the bi-directional Frame Sync Line. The line is used as an output in the Control Channel and as an input in the Working Channel.

- **ADCin** – Analog input

  level = 0 to 5 volts, Zin = 100Kohm

  This is the 8-bit Analog to Digital Converter (ADC) input. This may be used to monitor station PA power.

5.3.2 Simulcast Control

- **ext_PTT** - Digital TTL active low input, diode isolated

  This is the external source for Local PTT and is only active in a Simulcast configuration.

- **ext_A/Dmodctrl** - Digital TTL active low input, diode isolated

  This is the external source for the Analog/Digital modulation control and is only active in a Simulcast configuration.

- **ext_150** - RS422 input

  This is the external source for Low Speed Data and is only active in a Simulcast configuration.

- **ext_9600baud** - RS422 input

  This is the external source for High Speed Data and is only active in a Simulcast configuration.

- **bypass** - Digital TTL active low input, diode isolated

  This is the Simulcast bypass control signal. This line, when low, forces the site to operate in non-Simulcast mode and is driven by the Simulcast control equipment.

- **inhibit** - Digital TTL active low input, diode isolated

  This signal is the Simulcast alarm indicator. This line, when low, indicates the presence of a Simulcast alarm and is driven by the Simulcast control equipment.

- **txclk_in** - Digital TTL active low input, diode isolated

  This is the external source for High Speed Clock and is only active in a Simulcast configuration.

- **txclk_alarm** - Digital TTL active high output

  This signal is the Simulcast Tx Clock alarm indicator. This line, when high, indicates

that the external source for High Speed Clock is missing and is only active in a Simulcast configuration.

- **9.6 REF** - External source of systems clock (RS422 input). Only active with Simulcast

5.3.3 Conventional Control

- **CPTT** – Digital open drain output

  This signal is the Combined PTT control. This line, when low, will key up the base station transmitter.

- **TxCGDis** – Digital open drain output

  This signal is the Transmit Channel Guard Disable control. This line, when low, prevents the transmission of Channel.

- **CGMon** - Digital TTL active low input, diode isolated

  This signal is the Channel Guard Monitor control.

5.3.4 Voter Control

- **vot_emsq** - Digital open collector output

  This is the Voter E&M Squelch signal. This line, when pulled up to +12V through a 4.7k ohm pull-up resistor, indicates the presence of E&M from the Voter. Open output indicates no E&M.

- **vot_rcvng** - Digital active low input

  This is the Voter Receiving signal. This line, when low, indicates that the Voter is receiving.

5.3.5 Asynchronous Serial Ports

The following asynchronous serial ports provide control links to the SitePro Controller.

Table 1 –Asynchronous Serial Ports

PORT	FORMAT	FUNCTION
ENet0	Ethernet 10baseT	Management
ENet1 (SCC1)	Ethernet 10baseT	Spare
SCC2	RS232	Spare
SCC3	RS232	Spare
SCC4	RS485	Spare
QUART A	38400 baud	BSL0
QUART B	38400 baud	BSL1
QUART C	RS232	Spare
QUART D	RS232	Spare

PORT	FORMAT	FUNCTION
SMC1	RS232 (38400 baud (8N1))	Program/Debug
SMC2	RS232	Spare
80C323 SP0	RS232 (38400 baud (8N1))	Debug
80C323 SP1	RS232 (38400 baud (8N1))	Spare

5.3.6 Synchronous Serial Ports

The following synchronous serial ports provide data and control paths from the SitePro Controller to the base station (High Speed Data), to the IMC (Phone Line), and to optional Voter equipment (VDI).

Table 2 - Synchronous Serial Ports

PORT	FORMAT	FUNCTION	SIGNALS
SSP0	4800/9600 baud	Local (RF) Comm Link	TxData, TxClock RxData, RxClock
SSP1	9600 baud	Remote (PL) Comm Link	TxData, TxClock RxData, RxClock CTS, RTS
SSP2	9600 baud	Voter (VDI) Comm Link	TxData, TxClock RxData, RxClock CTS, RTS

5.3.7 Power

- **+13.8V** - power supply input

  +13.8 volts, 1.5 amps (nominal)

  This signal is the positive voltage supply for the SitePro Controller and should be externally fused. An internal switching DC-DC converter will be used to supply +/- 12 and +5volts to the SitePro Controller sub-components.

- **GND** – power supply input

  This signal is the ground connection for the SitePro Controller.

6.0 DESCRIPTION

The SitePro Controller is essentially a processor with audio filtering and specialized I/O capability. Flexibility in design allows the SitePro Controller to be configured to function in many applications as suggested in the APPLICATIONS section. The SitePro Controller software is stored in ***flash*** memory. Configuration Data is stored in **NO**n**V**olatile **R**andom **A**ccess **M**emory (**NOVRAM**).

The Controller Board, Rockwell Modem, Analog Board, Power Supply, Display Module, and Display Board are mounted on a tray and enclosed in shelf (Figure 2 - SitePro Controller Shelf Assembly*)*. The SitePro Controller shelf is a one-rack unit assembly (1.75-inches x 19-inches), which mounts in a standard 19-inch wide equipment cabinet/rack. This shelf does not slide out, but by reversing the mounting ears can be mounted approximately 2/3 of the way out of the cabinet for troubleshooting.

Controller Board A2 uses Dual High Speed Diodes BAV99's for surge protection on all TTL inputs. However, maximum surge protection is achieved when the SitePro Controller is grounded to the cabinet earth-ground using Lightning Protection Circuitry Ground Kit 344A4500 and the Cabinet Grounding strap Kit 344A4730. Specific details for installing these grounding kits are found in the **LIGHTNING PROTECTION** section **10.0** of this manual.

6.1 INDICATORS AND CONTROLS

This section describes the indicators and controls visible and accessible from the front panel of the SitePro Controller Shelf Assembly.

There are two hinged doors on the front panel of the shelf assembly. Each door has a window so that indicators mounted on Control Board A2 and Rockwell Modem Interface Card A3 can be seen. Opening the Controller Board door provides access to **Reset Pushbutton** switch S1. This door also provides access to **PROGRAMMING and DIAGNOSTIC SERIAL PORT** J8. Programming is available through this port.

The circuit boards can be removed from the shelf assembly through these doors.

6.1.1 Indicators

6.1.1.1 Controller Board Power Indicator

Green LED indicator D12 provided on the Controller Board indicates when power is applied to the shelf. This indicator is visible by looking diagonally through the window in the hinged door on the front panel of the shelf.

6.1.1.2 Controller Board Status Indicators

Four Red LED status indicators L1 thru L4 (D1 thru D4) are visible through the window in the hinged door. These indicators show the state of operation of the SitePro Controller. The interpretation of these indicators depend on the system application *(refer to the* SitePro Controller *configuration manual for the specific application)*.

Green **ETHERNET** indicators **ETH0** and **ETH1** are also visible through the window in the hinged door. These indicators indicate when a compatible source is connected to **ETHERNET 1** or **ETHERNET 2** ports.

There are six other LED indicators on the Controller Board that are not visible from the front panel. Yellow LEDs D7 and D10 indicate when there is transmit activity on **ETH0** and **ETH1**. Yellow LEDs D6 and D9 indicate when there is receive activity on **ETH0** and **ETH1**. Green LEDs D5 and D8 indicate when there is link activity (*refer to Ethernet Ports, section 7.3.7).*

6.1.1.3 Rockwell Modem Interface Card Indicators

There are five Red LED indicators on Rockwell Modem Interface Card A3. These LEDs are visible through the window in the hinged door and indicate +5V, +12V, -12V, RLSD and CTS respectively. **R**eceived **L**ine **S**ignal **D**etect (**RLSD**) indicates data is being received. **C**lear-**T**o-**S**end (**CTS**) indicates a control signal is being sent to the CPU selector.

6.1.1.4 Display

Eight-character LED Display Board A6-A1 mounts between the two hinged doors on the front panel of the SitePro Controller Shelf Assembly. Green LED D1 indicates **POWER ON** to the shelf. This display displays Channel Status and Channel Information.

6.1.2 Controls

Reset Pushbutton Switch S1 is the only control available on the front panel of the SitePro Controller Shelf Assembly. It is used to reboot the SitePro Controller.

6.2 ROCKWELL MODEM

The 9600 Baud Rockwell Modem Board RYTUZ 921 01/1 mounts on top of Modem Interface Card A3 (ROA 117 2247). This Modem Board is used to generate a 9600 baud, fast-train, synchronous, serial data stream suitable for transmission over audio (phone) line or microwave link. The data stream is sent over a full-duplex, four-wire, dedicated 3002 grade telephone line.

Receive and Transmit Phone Data Lines are two balanced pairs carrying Modem data to and from the station where the data is combined with station audio (voice) and routed to the Remote Line input and Line output.

In addition to transformer isolation and conditioning provided by the SitePro Controller, the modem provides automatic adaptive signal equalization. The Rockwell Modem demodulates the input signal and the resulting data is transferred using a serial interface between the Rockwell Modem and the controller.

The modem senses a received signal by initiating a training state upon detecting an increase in the input signal level. The modem begins processing data at the end of the training state if the input signal is still above the nominal -40 dBm receiving threshold value. Otherwise, the modem returns to an idle mode at the end of the training state if the input signal is below the nominal receiving threshold value.

6.3 LOW SPEED AND HIGH SPEED DATA FILTERS

6.3.1 Low Speed Data Decode Filter

The **L**ow **S**peed **D**ata (**LSD**) Decode Filter, part of Analog Board A4, provides additional filtering to remove voice-audio from the receiver unfiltered audio (vol/sq/hi), thus leaving only the low-speed subaudible data for input to the microprocessor.

6.3.2 High Speed Data Encode Filter

The **H**igh **S**peed **D**ata (**HSD**) Encode Filter, part of Analog Board A4, is configurable based on personality data and shapes the data for the most efficient RF transmission. This data can be control signaling or digital voice. The data is generated by the RF modem under control of the 80C323 microprocessor.

6.4 INTERFACE CONNECTIONS

Table 3 - Interface Connections

CONNECTOR	INTERFACE CONNECTIONS
J1	96 Pin connector interfaces with Controller Board CB101069V1.
J2	96 Pin connector interfaces with Analog Board CB101070V1.
J3	96 Pin connector interfaces with Rockwell Modem Interface Card ROA 117 2247.
J4	2 over 2 BSL/RM (Rockwell Modem). This connector consist of four RJ11 connectors as follows: RM 0 — BSL 1 QUART A RM 1 — BSL 0 QUART B
J5	Ethernet 0
J6	Ethernet 1
J7	4 Pin Power connector (+13.8 VDC).
J8 *(Controller)*	Programming connector on the front of Controller Board A2
J8 *(Interconnect)*	Connects +13.8 VDC from Interconnect Board A1 to power supply module A5 input through cable W1
J9	Power Supply Output +12V, -12V and +5V. Cable W2 connects between J9 and J2 on Power Supply Module A5
J10	Connects through cable A6-W1 to Display Module A6.
J11	20 Pin connector for interfacing with a Conventional/DSP system.
J12	24 Pin connector for connecting to an **E**nhanced **D**igital **A**ccess **C**ommunication **S**ystem (**EDACS**)
J13	26 Pin connector for interfacing with a Simulcast System.

<table>
<tr><th>CONNECTOR</th><th>INTERFACE CONNECTIONS</th></tr>
<tr><td>J14</td><td>6 over 6 phone lines and serial ports. This connector consists of twelve RJ11 connectors as follows:
<table>
<tr><td>RM 0</td><td>QUART C</td><td>SCC4
RS 485</td><td>SCC3</td><td>80C323
PORT 0</td><td>N/U</td></tr>
<tr><td>RM 1</td><td>QUART D</td><td>SCC2</td><td>SMC2</td><td>80C323
PORT 1</td><td>N/U</td></tr>
</table>
</td></tr>
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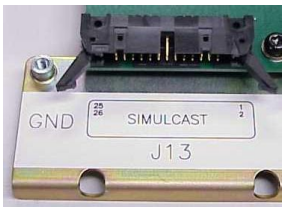
6.5 COMMUNICATION LINKS

Communication Modes available to the SitePro Controller are:

1. The SitePro Controller can communicate with other devices such as the Communication System Director (CSD), IMC, and RF Station. Communication occurs primarily through an RS-232C serial interface normally operating at 38.4 kilobaud. For a SitePro Controller interfacing with a **S**ite **I**nterface **M**odule (**SIM**) this is set to 38.4 kilobaud.
2. The SitePro Controller can communicate with other SitePro Controllers in the normal mode of operation, over a **B**ackup **S**erial **L**ink (**BSL**). The link uses 0-13.8 VDC levels and operates at 38.4 kilobaud and is ordinarily used in a bus configuration. For a SitePro Controller interfacing with a SIM this is set to 38.4 kilobaud.
3. A timing signal called the **F**rame **S**ync **L**ine (**FSL**) helps arbitrate the use of the BSL serial bus. The FSL is also used for timing purposes. In the station configuration, FSL signals use 0-13 VDC levels to produce a periodic negative going pulse (2.5 ms wide every 30 ms).
4. A 9600/4800 baud full duplex, synchronous communication interface over an RF channel.
5. A 9600 baud phone line or microwave communication interface *(this may be RS-232 or modem data)* through a Rockwell Modem.

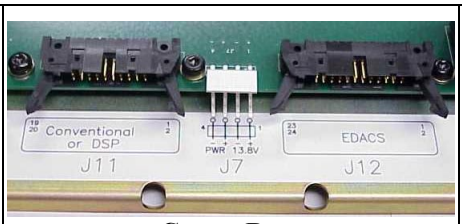
NOTE

SitePro Controller interface functions vary from application to application and between EDACS systems using MASTR III repeaters. It is necessary to refer to the Application Configuration Manual for details regarding the specific hardware and software configuration of the SitePro Controller.



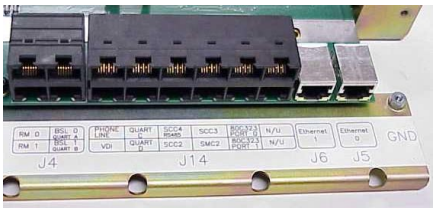
Left Rear

20-Pin SIMULCAST Connector



Center Rear

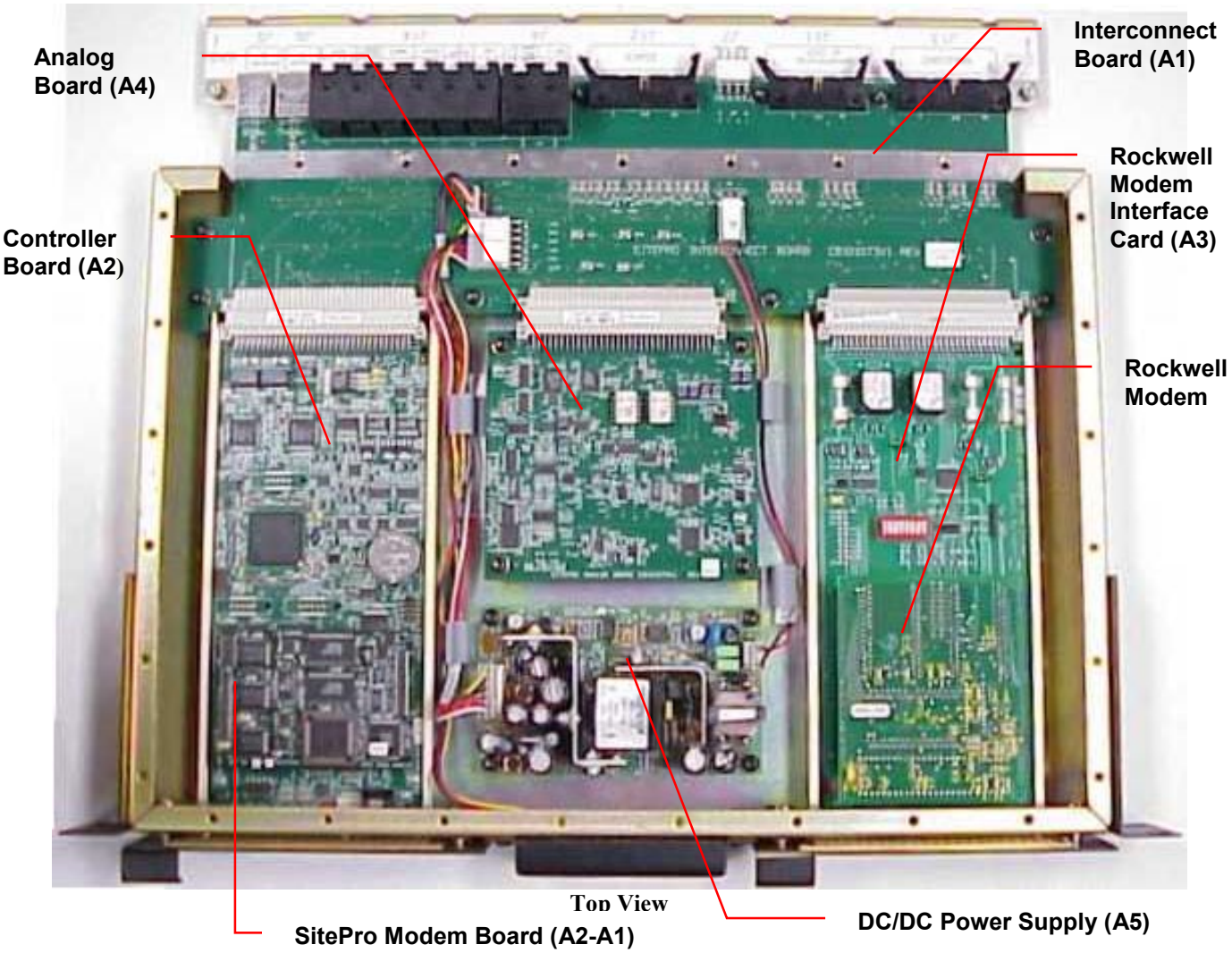
24-Pin EDACS, 4-Pin POWER & 20-Pin CONV/DSP Connectors



Right Rear

Ethernet, SERIAL PORT & BSL/RM Connectors

Rear Views



Top View

Front View

Figure 2 - SitePro Controller Shelf Assembly

7.0 CIRCUIT ANALYSIS

The Theory of operation of each circuit board/card and module used in SitePro Controller Shelf Assembly EA101209V1 is described in the following paragraphs. Refer to the Block Diagram in Figures 3 and 4 and Outline and Schematic Diagrams as listed in the **TABLE OF CONTENTS**.

The SitePro Controller is a Base Station Controller with redundant communication links [**B**ackup **S**erial **L**inks (**BSL**'s)]. The BSL's provide for inter-channel communication. Two 10Mbit Ethernet Ports provide system level communication. The BSL's provide trunking communications as well as site configuration and database messaging. One Ethernet port is dedicated to Management System information. The second Ethernet Port is ***not*** supported at this time.

The SitePro Controller and **S**ystem **I**nterface **M**odule (**SIM**) will use the primary BSL for trunking information and limited management system information. The secondary link will ensure continued trunking operation in the event of a primary BSL failure.

The SitePro Controller/base station interface for digital information, both receive and transmit, is 9.6k baud synchronous data. Additional digital control information is provided via discrete I/O at both the base station and controller. The following diagram (Figure 2) is a high level picture of the SitePro Controller and external interfaces.

7.1 SHELF ASSEMBLY

SitePro Controller shelf Assembly EA101209V1 is a 19" Rack Mount, one Rack Unit device. It is enclosed to reduce emissions and interference with other devices. Serial ports, Ethernet, power, and I/O connections are accessible at the back of the shelf *(Figure 1).* The serial port connections (**6 OVER 6 PHONE LINES & SERIAL PORTS**) are stacked two high using RJ45 type connectors (J14) and RJ11 type connectors (J4). The Ethernet connectors J5 & J6 (**ETHERNET 0** & **ETHERNET 1**) are single height RJ45 connectors. The power connector (J7) and I/O connectors (J11, J12 & J13) are Molex type.

The front panel has two hinged access doors for insertion/removal of the Controller Board and the Rockwell Modem card for troubleshooting and ease of maintenance. These doors have RF fingers to reduce emissions. Diagnostic LEDs and the eight-character display are viewable from the front panel.

The Shelf Assembly consists of Interconnect Board A1, which provides connectors to accommodate:

- Controller Board CB101069V1 (A2)
- Rockwell Modem Interface Card Assembly ROA 117 2247 (A3)
- Analog Board CB101070V1 (A4)
- Power Supply PS101328V1 (A5)
- Display Module MA101082V1 (A6)

SitePro Interface

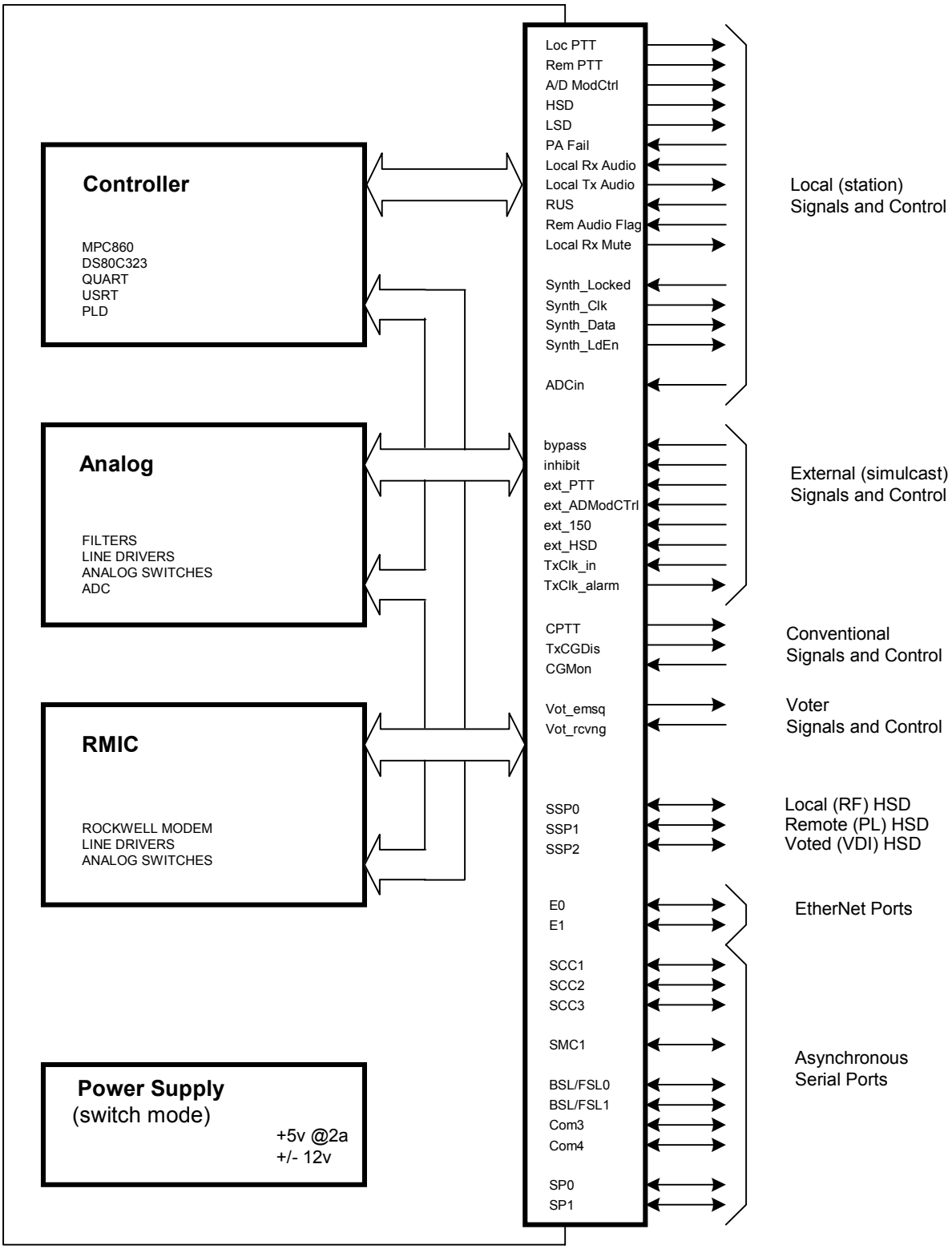


Figure 3 - SitePro Shelf Assembly Block Diagram

7.2 INTERCONNECT BOARD (A1)

Interconnect Board CB101073V1 is a passive printed circuit board that provides interconnections between all internal components of the SitePro Controller shelf and interfaces the SitePro Controller shelf with the outside world (Refer to **Table 3 - Interface Connections, and** Interconnection**,** Outline and Schematic Diagrams). Pi filters U1 thru U29 reduce any **E**lectro **M**echanical **I**nterference (**EMI**).

7.3 CONTROLLER BOARD (A2)

Controller Board CB101069V1 contains all SitePro Controller logic and control functions except the power supply and Rockwell Modem (Refer to the Outline and Schematic Diagrams for the Controller Board as listed in the **TABLE OF CONTENTS**).

This Controller Board is based on an MPC860 microprocessor, the primary responsibility being message processing. This board has multiple high-speed serial ports, two of, which are used for primary and secondary BSL's. It has hardware and dual port RAM to support the SitePro Modem Board and a 10/100 Mbit ethernet port. This port is available for Voice Over IP traffic. A second 10 Mbit ethernet port is available for management functions.

This board has sufficient memory to support 1M LIDs and 64k GIDs. It has LID and GID validation for all calls.

7.3.1 Block Diagram

Figure 4 - Controller Board Block Diagram shows the connection of major components from a high level viewpoint. Schematic Diagram WD-CB101069V1, Sheet 2 also provides a Block Diagram for the Controller Board. These diagrams show the major components of this board as:

- CPU (MPC860P)
- Ethernet 10 Base T
- Ethernet 10/100 Base T
- EEPROM
- Modem Board
- Memory:
  - ⇒ FLASH
  - ⇒ DRAM
- **E**lectronically **P**rogrammable **L**ogic **D**evice (**EPLD**)
- **Q**uad **UART** (**QUART**)
- LEDS
- DIPSWITCH
- I^2C **R**eal-**T**ime-**C**lock (**RTC**)
- Serial Ports
- Regulator
- **H**ot **S**wap **C**ontroller (**HSC**)
- Interconnect Board (Backplane)

7.3.2 System I/O

The System I/O circuits for the Controller Board are shown on Schematic Diagram WD-CB101069V1, Sheet 3 and include:

- Oscillator For PHYs
- JTAG Port
- Board Insert Detection Circuit
- Hot Swap Controller
- 3.3V Regulator
- 3.3V Power Monitor
- Test Points
- Programming Serial Port J8
- Decouplers

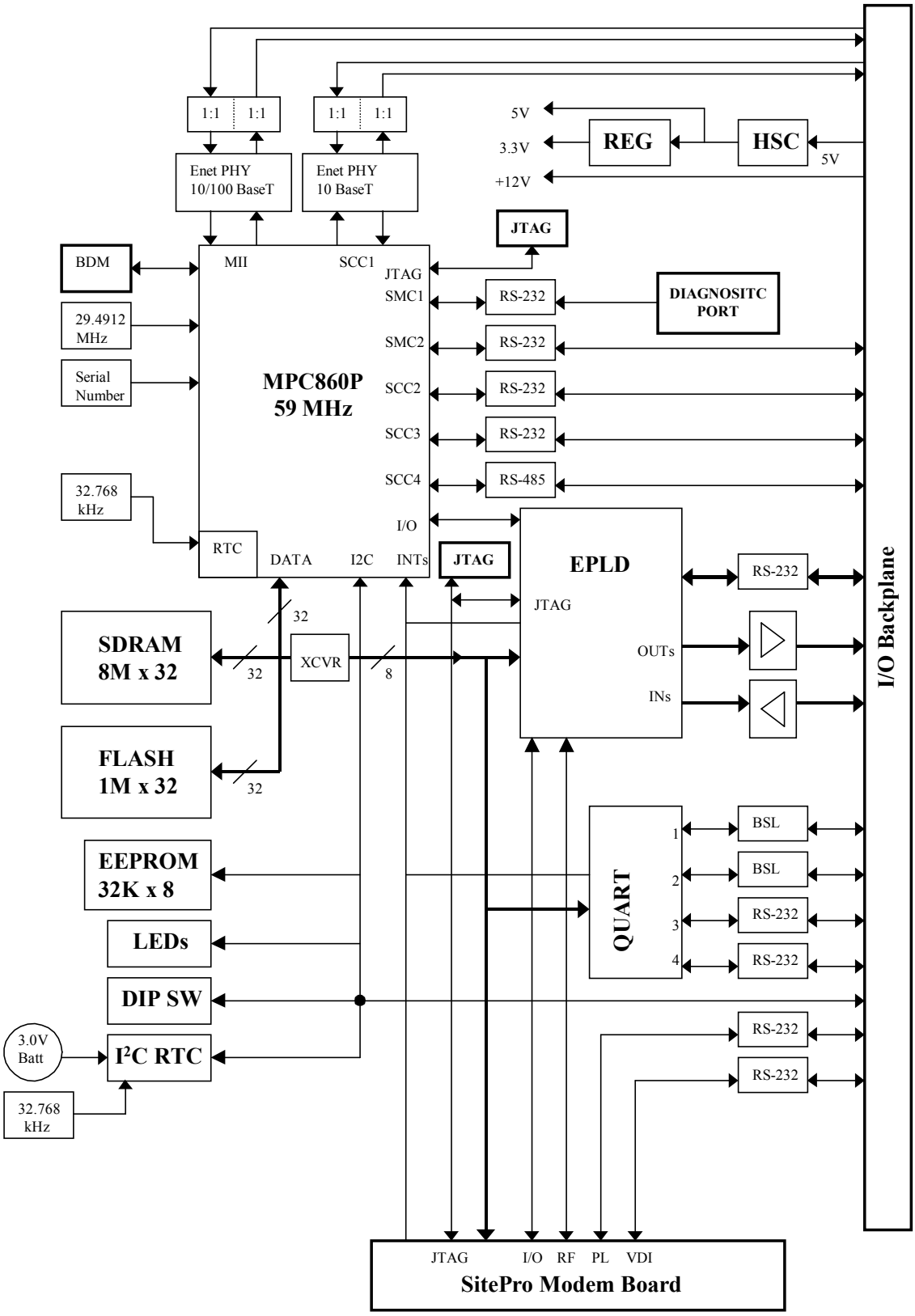


Figure 4 - Controller Board Block Diagram

7.3.2.1 Oscillator For Ethernet PHYs

This circuit consists of crystal oscillator circuit Y1 powered by 3.3 V applied to Y1, Pin 4, Vcc. Oscillator circuit Y1 is biased on by resistor R49 connected to Y1, Pin 3, CTRL and produces 25 MHz on the output at Pin 3 through resistor R51 (OSC 25MHz). This output connects to the **CLK25** inputs to the Ethernet 10 and Ethernet 10/100 Mbit PHYs[3].

7.3.2.2 JTAG Port

This JTAG PORT circuit consists of buffer U1 (NC7SZ125M5). This circuit allows programming directly to the microprocessor through connector J4. This circuitry is not presently used.

7.3.2.3 Board Insert Detection Circuit

This circuit consists of NPN transistors Q6 and Q7. When the Controller Board is inserted into a live Interconnect Board, the base circuits of these transistors are connected to ground through connector J1B, Pins B1 and B32 at either end of J2. Connector J1B, Pin B1 is MATE-DETECT-A and J1B, Pin B32 is MATE-DETECT-B. With the base of both transistors at ground, they are held in the off state. This allows POWER ON to cycle high if the output of U41 is high. The POWER ON voltage is applied to Pin 2 of Hot Swap™ Controller U37. If the base of either transistor (Q6 or Q7) is not connected to ground, POWER ON will not be applied to the HotSwap Controller. Therefore, if the card is not seated properly, power will not turn ON.

7.3.2.4 Hot Swap™ Controller

Hot Swap™ controller (HSC) U37 allows Controller Board CB101069V1 to be safely inserted in or removed from Interconnect Board CB101073V1 while voltage is applied. Using external N-channel pass transistor Q5, the supply voltage to the Controller Board is ramped up at a controlled rate. Hot Swap switch driver U37, Pin 6 controls the N-channel gate. A programmable electronic circuit breaker detecting over current by sensing voltage across 15 milliohm resistor R153 protects against shorts. The RESET output (U37, Pin 1) is used to generate a system reset when the supply voltage falls below the voltage preset by resistors R167 and R168. The POWER ON input to U37, Pin 2 is used to cycle the Controller Board power. The 555 timer circuit (U40) is connected to the HSC chip so that the HSC can be automatically reset in the case of a circuit breaker fault.

Because the Hot Swap Controller, U37, latches OFF if it senses an overload, a timer circuit has been added to occasionally turn it back ON. If the overload still exists, it turns off immediately but if the overload is not present, normal operation is restored. This circuit is needed for unattended operation.

The 555 timer is powered any time 5V is applied to the board since it is connected ahead of the Hot Swap Controller. As long as the HSC is ON, 5V is fed to inverter U42-2 through D34. The resulting low on U42-4 holds U40 at reset.

When the HSC turns power OFF, U42-4 goes high and the reset is removed. The timer now free runs with about a 1.1 second cycle time. U40-3 is high for about 0.7 sec and low

[3] PHY is an Industry Standard for "Physical Interface."

for about 0.4 sec. U40-3 is inverted by U41. During the high part of the cycle, the resulting low at U41-4 holds the HSC ON pin low keeping the HSC OFF.

When U40-3 switches low, U37-2, the HSC ON pin is allowed to go high through D35, pulled up by resistor R157. The HSC turns ON, but if the fault is still present, it turns OFF within 40µs and the cycle continues. If the fault is gone, the 555 is held reset and the Controller Board resumes normal functioning.

Capacitor C119 and resistor R191 act as a slugging filter on the FB input to prevent fast transients on the 5V from causing the HSC to generate a reset. Likewise, capacitor C118 and resistor R190 prevent large transients on the input 5V, i.e. when the RMIC is hot swapped, from causing the HSC to generate a reset due to a transient on the ON pin.

7.3.2.5 3.3V Regulator

The controller board is provided with 5 Volts and ±12 Volts from the Interconnect Board. Linear regulator U25 is used to provide 3.3 volts to be used by the majority of digital logic on the Controller Board and the Board.

The **H**ot **S**wap **C**ontroller (**HSC**) is used to ramp up the 5V-power rail at a controlled rate. This, in addition to other considerations, will allow the Controller Board to be hot swappable. The 5V output from this circuit will also power the 3.3-Volt regulator, thus causing the 3.3 V power rail to also ramp up at a controlled rate. As mentioned above, the HSC has a built-in electronic circuit breaker.

7.3.2.6 3.3V Power Monitor

The 3.3V Power Monitor (U31) uses a precision temperature-compensated reference and comparator circuit to monitor the status of the 3.3V supply. If a loss of power is detected an internal power-fail signal forces reset to the active state, which is low. When the 3.3V supply returns to a normal state, the reset signal is kept active for approximately 150 ms to allow the power supply and microprocessor to stabilize. This 3.3V Power Monitor circuit also monitors Reset Pushbutton S1 on the reset output, U31, Pin 1. If the reset is pulled low, by pressing S1, a reset signal is generated upon release. The output of U31 is held in reset output (low) for approximately 150 ms.

7.3.2.7 Test Points

Test Points TP1 thru TP10 are provided on the Controller Board as follows:

- TP1 thru TP3, TP7, TP8 and TP10 are ground connections
- TP4 is +12V
- TP5 is +3.3V
- TP6 is +5.0V
- TP9 is WALSHCLK

7.3.2.8 Programming Serial Port J8

This port (J8) is located at the front of the Controller Board just behind the hinged door. It is provided so that a programmer can easily program the microprocessor from the front of the SitePro Controller without removing it from the cabinet.

7.3.2.9 Decouplers

Decoupling capacitors (Decouplers) are used to eliminate high-speed transient noise in high-speed digital circuits. There are many decoupling capacitors used on the Controller Board. These capacitors are connected between a source and ground. For example, on sheet 3 of Schematic Diagram WD-CB101069V1 there are two 3.3V decoupling capacitors, C2 and C87.

7.3.3 Backplane

The Controller Board to Interconnect Board A1 (Backplane) connector circuits are shown on Schematic Diagram WD-CB101069V1, Sheets 4-7 and include:

- Board Connections
- Serial I/O
- I/O (1)
- I/O (2)

7.3.3.1 Board Connections

Schematic Diagram WD-CB101069V1, Sheet 4 shows the single DIN96 connector, J7. This 96-pin connector has three layers of pins, J7A, J7B and J7C. Each layer consists of 32 pins. J7B, Pins 1 and 32 are the MATE-DETECT-A and MATE DETECT-B connections. These two connections are used with the Board Insertion Detection circuit. Pins J7B; Pins 27 and 28 are the SCL and SDA connections. SCL and SDA make up the I^2C bus. CPU I/O SIGNAL PROTECTION DIODES D27, D29 connected to SCL and SDA provide surge protection for the I^2C bus.

7.3.3.2 Serial I/O

Numerous asynchronous and synchronous serial ports are brought to the Interconnect Board (Backplane) from the microprocessor, Modem Board and QUART. Most serial ports convert to standard RS-232 levels using RS-232 transceivers U13, U24, U30 & U36. Serial port U21 converts to RS-485 differential signal levels and supports a multidrop network. One microprocessor RS-232 port is used as a diagnostic or local programming port and is brought to RJ-11 connector J8 on the front of the board. Two ports from the QUART use BSL signaling.

All Serial ports are designed for full-duplex 115.2 kbaud communications with the exception of the RS-485 port U21 from the microprocessor SCC. This port is a half-duplex HDLC port and supports speeds up to 2 Mbaud.

U21 is a differential bus transceiver for bi-directional data communication on multiport bus transmission lines. This device combines a 3-state differential line driver and a differential input line receiver. The driver and receiver have active-high and active-low enables that are connected together externally to function as a direction control. The driver differential outputs and the receiver differential inputs are connected internally to form differential input/output I/O bus ports. These ports are designed to offer minimum loading to the bus when the driver is disabled or Vcc=0.

BSL signaling is accomplished through two identical circuits consisting of hex inverting Schmitt Triggers U23A/U23B, inverter buffer drivers U35A/U35B, **F**ield **E**ffect **T**ransistors (**FET**) Q3/Q4, NPN transistors Q9/Q10 and diodes D23/D25. Inputs to the microprocessor from the Interconnect Board (backplane) are through diode D23/D25 to the input of U23A/U23B. Schmitt Trigger U23A/U23B provides a well-defined output

for an input to the base of NPN transistor Q9/Q10. Transistors Q9/Q10 are used to convert the RX level from 5V to 3.3V. The output of Q9/Q10 (RXA/RXB) is applied at 3.3V to the microprocessor. When the input (BKP-BSL0/BSL1) is high, diode D23/D25 is reversed biased making the input to U23A/U23B high and the output on the collector of Q9/Q10 also high. When the input is low, diode D23/D25 is forward biased and the input to U23A/U23B is low. The output on the collector of Q9/Q10 is also low.

Outputs from the microprocessor to the backplane are through inverter buffer driver U35A/U35B, and FET Q3/Q4. The output RXA/RXB from the QUART is applied to the input of inverter circuit U35A/B35B. When this input to U35A/B35B is low, the output is high. This causes Q3/Q4 to conduct. Diode D32/D33 is forwarded biased and the output to BKP-BSL0/BSL1 is low. Diode D32/D33 prevents loading the BSL when power is off. When the input to U35A/U35B is high Q3/Q4 does not conduct and the output to BKP-BSL0/BSL1 is high. FET Q3/Q4 is powerful enough to drive 1k ohm loads on up to 25 parallel connected shelves.

7.3.3.3 I/O

Other I/O's are shown on Schematic Diagram WD-CB101069V1, Sheets 6 and 7. Inputs to the EPLD from the backplane consist of identical circuits for different inputs. These circuits consist of inverter buffer driver circuits U18A thru F, Schmitt Triggers U22B thru D and U23C thru F *(*Figure 5 - Input Circuits U18A thru F, U22B thru D and U23C thru F*)*. Identical circuits for different inputs also include inverter buffer driver circuits U22A, E, F, U29D and U32B *(*Figure 6 - Input Circuits U22A, E, F, U29D and U32B*)*.

Figure 5 shows inputs using 74HC14's with diode coupling. When the input from the backplane goes low the diode is forwarded biased and the input to the inverter goes low. This results in a sharp, well-defined output of the inverter going high. Outputs are:

- REM-AUDIO PRESENT (U18A)
- CAS (U18B)
- CGMON (U18C)
- LSDIN (U18D)
- PAFAIL (U18E)
- FSLIN (U18F)
- EXTPTTIN (U22B)
- EXTADIN (U22C)
- EXT150IN (U22D)
- RCVING-FROM-AV (U23C)
- SYNTH-LOCK DET (U23D)
- SIMULCAST-INHBIT (U23E)
- BYPASS (U23F)

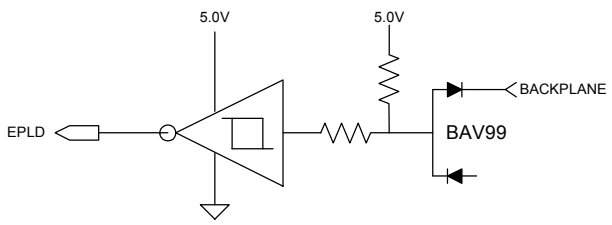


Figure 5 - Input Circuits U18A thru F, U22B thru D and U23C thru F

In Figure 6 the Schmitt Trigger provides a sharp, well-defined input to the microprocessor

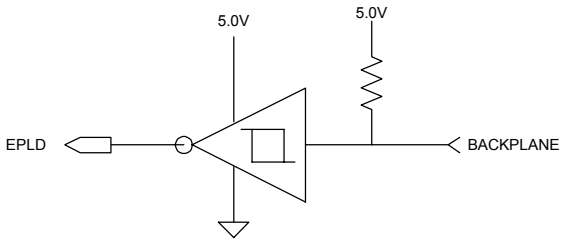


Figure 6 - Input Circuits U22A, E, F, U29D and U32B

The FSL output from the EPLD to the backplane is connected through inverter circuit U33A and FET Q2 (BKP-FSL).

The RX-MUTE output from the EPLD to the backplane is connected through Inverter U33D and transistor circuit Q1 (BKP-RX_MUTE).

The EMSQTOAV output from the EPLD to the backplane is accomplished through Inverter U35C and transistor circuit Q6 (BKP-EMSQTOAV).

Other outputs from the EPLD to the backplane are connected through identical circuits as shown in Figures 7 & 8. Figure 7 shows circuits using Schmitt Triggers U29B, C, E, F and U32A & C to provide sharp, well-defined outputs to the backplane and to provide 5V levels (Inputs are generally 3.3V). These outputs are:

- BKP-WALSH1 (U29B)
- BKP-WALSH2 (U29C)
- BKP-A/DMODCTL (U29E)
- BKP-RFTXDAT (U29F)
- BKP-RFTXCLK (U32A)
- BKP-LSDOUT (U32C)

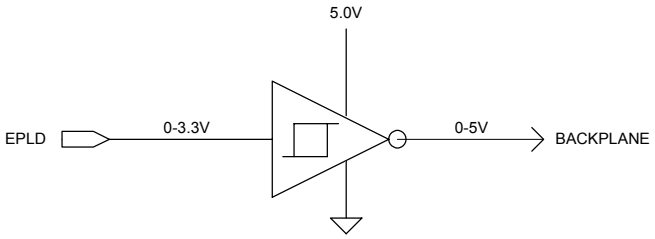


Figure 7 - Output Circuits U29B, C, E & F, U33C, E & F and U34A thru F

Figure 8 shows circuits using open collector inverters circuits U33B, C, E, F, U34A, B, C, D, E, F and U35C, D, E & F. These outputs are:

- BKP-SYNTH_DATA (U33B)
- BKP-SYNTH_DATA_CLK (U33C)
- BKP-RPTKEY (U33E)
- BKP-SPARE2 (U33F)
- BKP-CPTTOUT (U34A)
- BKP-SPARE1 (U34B)
- BKP-STNPTT (U34C)
- BKP-RPT_INH (U34D)
- BKP-TXCGDIS (U34E)
- BKP-HSACO (U34F)
- BKP-EMSOTCAV (U35C)
- BKP-TXC_MISSING_ALARM (U35D)
- BKP-REM_RPT (U35E)
- BKP-SYNTH_LD_EN (U35F)

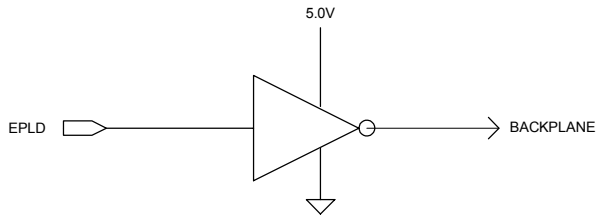


Figure 8 - Output Circuits U33B, C, E, F, U34A, B, C, D, E, F and U35C, D, E & F

7.3.4 CPU

The **C**entral **P**rocessing **U**nit (**CPU**) circuits, for the Controller Board, are shown on Schematic Diagram WD-CB101069V1, Sheets 8 & 9 and include:

- Microprocessor
- Microprocessor Support

7.3.4.1 Microprocessor

Microprocessor U9[4] is an MPC860P processor that has four SCC channels, two SMC channels, plus a 100 Mbit Fast Ethernet Controller. One of the SCC channels is used as a second ethernet port (10 Mbit) with all other SCC and SMC channels used as serial ports.

This microprocessor runs at 59 MHz using a 29.4912 MHz clock input. This frequency was selected for use by the baud rate generators to produce standard baud rates up to 115.2 kbaud without error. The microprocessor external bus runs at half the speed of the microprocessor (29.5 MHz).

The microprocessor provides an internal real-time clock that is used to provide time-of-day information to the application software. The real time clock runs off of a 32.768 kHz crystal. An external real-time clock is connected to the microprocessor through the 1^2C bus. The microprocessor accesses the internal real-time clock much faster than the external one. Therefore, whenever the board powers up, the battery-backed external real-time clock is used to set the time of the internal real-time clock. Once the internal real-time clock is set, it will always be used while the board is powered.

Four external interrupts are used in this design. The remaining unused three connect to the EPLD for future use. Connecting them to the EPLD makes later modifications easier. The external interrupt signals are specified in the following table.

Table 4 - External Processor Interrupt Signals

DEVICE	IRQ
(SPARE-EPLD)	IRQ (NMI)
QUART	IRQ1
MODEM DB DUAL-PORT RAM	IRQ2
(SPARE-EPLD)	IRQ3
ETHERNET 10/100	IRQ4
ETHERNET 10	IRQ5
(SPARE-EPLD)	IRQ6

All but one chip select are used in this design. The unused chip select is connected to the EPLD for future use. The microprocessor chip select signals are defined in the following table.

[4] Microprocessor U9A and U9B are two parts of the same processor. This was done for drawing convenience.

Table 5 - External Chip Select Signals

DEVICE	IRQ	MACHINE	DATA BUS WIDTH
FLASH	CS0	GPCM	32 Bit
SDRAM	CS1	UPMA	32 Bit
QUART REGISTERS	CS2	GPCM	8 Bit
QUART INTERRUPT VECTOR	CS3	GPCM	8 Bits
EPLD	CS4	GPCM	8 Bits
MODEM DUAL PORT RAM	CS5	UPMB[5]	8 Bits
MODEM CODE RAM	CS6	GPCM	8 Bits
(SPARE-EPLD)	CS7	N/A	N/A

Note that there is both a 32-bit data bus and an 8-bit data bus. The 8-bit data bus is connected to the 32-bit processor data bus via an 8-bit transceiver. The output enable for the transceiver is controlled by ANDing all 8-bit chip selects together inside the EPLD.

7.3.4.2 Microprocessor Support

The microprocessor support as shown on Schematic Diagram WP-CB101069V1, Sheet 9 includes:

- BDM Debug Port Connector
- Power-On Reset Configuration
- 32 kHz Crystal
- VDDSYN Filter
- Silicon Serial Number
- KAPWR Switch
- 8-Bit Bus Transceiver
- MICTOR Logic Analyzer Connectors

BDM Debug Port Connector

For debug and development, microprocessor U9A provides a dedicated serial port (BDM) for connecting a debugger/emulator. A debugger/emulator connected to this port allows a programmer to read/write registers and external peripherals, control program execution, etc. Many debuggers also have built-in capability to program on-board flash through this port. These serial port pins are brought to 10-pin header J1 using the standard BDM pinout.

Power-ON Reset Configuration

The Power-On Reset Configuration consists of four octal buffer/drivers U6A, U6B, U8A and U8B with 3-state outputs. This circuit ensures that at Power-On all circuits are reset to the starting state. Inputs to these circuits are through 10K BUS8 resistor networks RN7 and RN10. The outputs tie into bus D[0.31]. Each package is organized as two 4-bit line drivers with separate output-enable (OE) inputs. These inputs are tied together and connect to RESET-N. When RESET-N is low, data passes from A inputs to Y outputs. When RESET-N is high, the outputs are in the high-impedance state. This circuit imposes

[5] UPMB is only required if the system makes use of the BUSY_N signal coming from the dual port memory. If BUSY_N is not used, then a GPCM machine can be used for this chip select.

predetermined "start-up" information on the microprocessor data bus during RESET. The microprocessor reads the data bus state just before RESET goes inactive (high) and uses the result for start-up initialization.

At power up, the MPC860 samples the data bus and the MODCK bits to obtain the Hardware Configuration Word and clock setup parameters respectively. The SitePro hardware configures these as follows:

Data bus	0x017A 0000
MODCK1, 2	1,0

This results in the following configuration:
Internal arbitration
Interrupt vector location 0xFFF0 0000
Boot Port size is 32 bits.
IMMR is at 0xFF00_0000.
Debug Pin Configuration is as follows: VFLS[01], VF0, VF1, $\overline{\text{STS}}$, AT1, AT2, AT0, AT3, OP3.
Debug Port Pin Configuration is DSCK, DSD1, DSD0, PTR1, TCK, TD1 and TD0.
External Bus speed set to ½ system clock.
Pitrtc connected to extclk and div by 4, pitclk = 32.768/4 = 8192 Hz
Sys clk connected to EXTCLK vco factor is 1, sysclk = 29.4912 MHz

32 kHz Crystal

This crystal circuit consists of crystal package Y3, resistors R90 and R98, capacitors C49 and C63. This circuits connects to microprocessor U9A between pins N1 (EXTAL) and P1 (XTAL) and produces an oscillator frequency of 32.768kHz to drive the real-time clock.

29 MHz Clock

The 29 MHz Clock consists of oscillator circuit Y2 and resistors R82 and R105. This circuit produces the oscillator frequency of 29.4912 MHz and connects to microprocessor U9A at N2 (EXTCLK).

VDDSYN Filter

This circuit consists of inductor L1 and capacitors C50 and C57. It filters the 3.3V supply to the system **P**hase-**L**ocked-**L**oop (**PLL**) circuitry on microprocessor U9A. The PLL multiplies the EXTCLK by an integer factor to provide a bus clock.

Silicon Serial Number

A unique 64-bit electronic Serial Number chip U3 is used to store the board identification number. This chip has a 1-bit serial port, which interfaces to microprocessor U9 through an I/O port. In addition, four bits of hardware identification are made available to U9 through I/O ports. The Hardware ID is changed by selectively populating a bank of resistors.

Real Time Clock (RTC)

A battery backed up Real Time Clock, U43, is provided to retain the elapsed time even with power off. U43 can be read or written via the I^2C bus. The slave address for U43 is D0 hex. Accurate timing is maintained by 32.768kHz crystal Y5.

Processor U9 has an internal real time clock, however it consumes too much power to allow battery back up. Therefore the real time is read from U43 via the I^2C bus at power up and stored in the processors RTC. This is a fairly slow process. Afterward, the processor can quickly determine the time by reading the internal RTC. Timing for the processor RTC is provided by 32.768kHz crystal Y3.

KAPWR

The **K**eep-**A**live-**P**o**W**e**R** (**KAPWR**) circuit consists of 0-ohm resistor R196 and is used for the "real time" clock on the microprocessor (860). KAPWR is **not** powered when power is off. This circuit applies 3.3V supply to U9B, Pin R1 (KAPWR).

8-Bit Bus Transceiver

This circuit consists of 8-Bit Bus Transceiver U19 and resistor network RN15. The 8-Bit Bus connects to the microprocessor through 8-Bit Bus Transceiver U19. The output enable OE for the transceiver is controlled by ANDing all 8-bit chip selects together inside EPLD U27. This transceiver drives the data bus for all 8-bit devices.

MICTOR Logic Analyzer Connectors

These connections consist of J3, J5 and J6. These connectors are for software development and are not present in production units.

7.3.5 SitePro Modem Board Connector

The SitePro Modem Board connector circuits for the Controller Board are shown on Schematic Diagram WD-CB101069V1, Sheet 10 and include:

- QUICC Connector (J9)
- I/O Connector (J2)

7.3.5.1 QUIC Connector (J9)

The QUICC (J9) connector contains the microprocessor interface (Refer to the Modem Board Section).

7.3.5.2 I/O Connector (J2)

The I/O (J2) connector has miscellaneous I/O to/from the EPLD or Interconnect Board (Refer to the Modem Board Section).

7.3.6 Electrically Programmable Logic Device (EPLD)

The EPLD circuit for the Controller Board is shown on Schematic Diagram WD-CB101069V1, Sheet 11. Also, refer to the EPLD Drawings listed in the Table of Contents.

Access to various board inputs/outputs is made available through **E**lectronically **P**rogrammable **L**ogic **D**evice (**EPLD**) U27. The EPLD contains numerous read/write latches with a simple 8-bit interface to the microprocessor.

The EPLD is in-circuit programmable via the JTAG port using an Altera Byte-blaster cable. A 10-Pin header J10 is made available for this purpose. The EPLD JTAG port is also brought to microprocessor I/O pins to allow the microprocessor to load the EPLD configuration.

The JTAG port is routed to Modem board (A2-A1). This allows a future modem board to be designed with an Altera EPLD. If that future EPLD modem board is used, resistor R187 (0 ohms) must be removed from the board.

In addition to being an interface to the discrete I/O, the EPLD also divides clocks and provides the output enable logic for the 8-bit data bus transceiver. It also derives the FSL pulse stream from RFTXDAT and RFTXCLK in the Control Channel mode.

7.3.7 Ethernet Ports

There are two Ethernet Port circuits for the Controller Board shown on Schematic Diagram WD-CB101069V1, Sheets 12 & 13 as:

- 10 Base-T (10 Mbit PHY)
- 10/100 Base-T (10/100 Mbit PHY)

The 10/100 Mbit port (10/100 Base-T Transceiver U5) uses the **F**ast **E**thernet **C**ontroller (**FEC**) inside the microprocessor and supports full duplex (10/100 Base-T). The 10 Mbit port (10 Base-T Transceiver U12) uses SCC1 and only supports half-duplex (10 Base-T). The ethernet physical layer transceivers are the same for both ports, but the 10/100 Mbit port uses a **M**edia **I**ndependent **I**nterface (**MII**), whereas the 10 Mbit uses a *"7-wire"* interface. The ethernet transceivers support 10/100 Base-T with full auto-negotiation capability, while the 10 Mbit port only advertises 10 Mbit capability.

The RJ-45 ethernet connectors are actually located on Interconnect Board A1. The ethernet physical layer chips and transformers reside on the Controller Board with the ethernet differential RX/TX signals brought to the RJ-45 connectors through the Interconnect Board connector. A single LINK OK status LED is provided for each ethernet port on the front of the Controller Board.

The 10Mbit Ethernet port uses the *"7-wire"* interface to connect the Ethernet physical transceiver to the microprocessor SCC1 serial channel. When SCC1 is in Ethernet mode, the SCC pins have different functions (refer to the following table).

Table 6 - 10 Mbit Ethernet Connections

SCC ETHERNET SIGNAL	SCC PIN NAME	PHY SIGNAL
TX	TXD1	10TXD
TENA	RTS1	10TXEN
TCLK	CLKx	10TXCLK
CLSN	CTS1	10COL
RENA	CD1	10CRS
RX	RXD1	10RXD
TCLK	CLKx	10RXCLK

7.3.8 I²C Bus

The I²C-bus is a two-wire serial bus (SCL and SDA) used for microcontroller-based control. The I²C Bus circuits, for the Controller Board, are shown on Schematic Diagram WD-CB101069V1, Sheet 14. These circuits consist of Personality EEPROM U14 and 8-bit I/O expanders for the I²C bus U15 and U26.

EEPROM U14 provides 16k of non-volatile data storage. EEPROM U14 is organized as 16kx8 and is accessible via the I²C port of microprocessor U9.

Serial EEPROM U14 has a write protect pin. It is active high and has an external pull-up. To write to U14, port PB23 on the microprocessor is defined as an output and driven low. To write protect the EEPROM after writing to it, port PB23 is defined as an input and the pull-up activates the write protect signal.

Several peripherals are available to the microprocessor through the I²C Bus. In addition to a 16kbyte EEPROM, there is an 8-bit writable latch for driving 4 LEDs and an 8-bit readable latch for reading the status of an 8-bit DIP switch. The I²C bus is also brought to the Interconnect Board for accessing other off-board peripherals (i.e. LED display). I²C bus addresses are as follows:

Table 7 - I²C Bus Addresses

DEVICE	ADDRESSES
LEDs	0x40
DIP Switch	0x46
EEPROM (Controller Board)	0xA0
Digital Pot	0x50
ADC/DAC	0x9E
16-Bit Expander	0x4C
Display	0x4A
Real-Time Clock	0xD0
EEPROM (Analog Board)	0xA6

7.3.9 Memory

The Memory circuits, for the Controller Board, are shown on Schematic Diagram WD-CB101069V1, Sheets 15 & 16 and include:

- DRAM Circuits U2 & U7
- Flash Circuits U10 & U11

7.3.9.1 DRAM

Two 128-Mbit, 16 bit wide synchronous DRAM Integrated Circuits U2 and U7 are organized in a 4M x 32 configuration. These two chips provide a minimum of 16 Mbytes of storage, upgradeable to 64 Mbytes. The following table shows the MPC860P bank addresses for the different DRAM memory sizes.

Table 8 - DRAM Bank Memory Ranges

BANK	64-MBIT (DRAM)	128-MBIT (2XDRAM)	256-MBIT (SDRAM)
Bank 1	0x003FFFFF – 0x00000000	0x003FFFFF – 0x00000000 0x013FFFFF – 0x01000000	0x003FFFFF – 0x00000000 0x013FFFFF – 0x01000000 0x023FFFFF – 0x02000000 0x033FFFFF – 0x03000000
Bank 2	0x007FFFFF – 0x00400000	0x007FFFFF – 0x00400000 0x017FFFFF – 0x01400000	0x007FFFFF – 0x00400000 0x017FFFFF – 0x01400000 0x027FFFFF – 0x02400000 0x037FFFFF – 0x03400000
Bank 3	0x00BFFFFF – 0x00800000	0x00BFFFFF – 0x00800000 0x01BFFFFF – 0x01800000	0x00BFFFFF – 0x00800000 0x01BFFFFF – 0x01800000 0x02BFFFFF – 0x02800000 0x03BFFFFF – 0x03800000
Bank 4	0x00FFFFFF – 0x00C00000	0x00FFFFFF – 0x00C00000 0x01FFFFFF – 0x01C00000	0x00FFFFFF – 0x00C00000 0x01FFFFFF – 0x01C00000 0x02FFFFFF – 0x02C00000 0x03FFFFFF – 0x03C00000

7.3.9.2 FLASH

Two flash memory chips U10 and U11 are organized as 1M x 32 for non-volatile program storage *(Flash)*. These two chips have 4 Mbytes of flash memory with the ability of expansion up to 8 Mbytes. One or more flash sectors contain "bootloader" code, which contains enough functionality to load and store new versions of application code.

7.3.9.3 Quad UART

The QUART circuit for the Controller Board is shown on Schematic Diagram WD-CB101069V1, Sheet 17.

Quad **U**niversal **A**synchronous **R**eceiver-**T**ransmitter (**QUART**) U28 is used to handle asynchronous serial data communication.

The serial port is a general-purpose interface that conforms to the Recommended Standard–232C (RS-232C) and can be used to interface with almost any type of device (modem, mouse and serial printer, etc.).

Quad UART U28 provides four additional serial ports for microprocessor U9. U28 is powered by 3.3V, which forces the microprocessor interface to be asynchronous and run at 14.75 MHz, the microprocessor bus clock divided by 2 inside the EPLD. The communication clock input is 3.6864 MHz, the microprocessor bus clock divided by 8 inside the EPDL. None of the I/O ports of the QUART are used at this time.

The QUART uses two chip selects, CS2 and CS3. Chip select CS2 is used when accessing the QUART registers. Chip select CS3 is used after an interrupt to read the interrupt vector.

7.4 SitePro MODEM BOARD

The SitePro Modem Board contains three synchronous serial ports (modems) and a local microprocessor. This board plugs into the Controller Board using two connectors, QUICC (J9) and I/O (J2). Refer to Figure 9 - Site Pro Modem Board Block Diagram**.**

The microprocessor interface is a simple 8-bit bus port with two separate chip selects. One chip select controls access to an 8k x 8 dual port RAM. The other chip select controls access to the Modem Board microprocessor local code memory. The Controller Board microprocessor loads the Modem Board local code memory with code before releasing the Modem Board reset. The Modem Board microprocessor runs from a 14.7 MHz clock generated by dividing down the 29.5 MHz Controller Board microprocessor output clock inside the EPLD.

Circuits for the SitePro Modem Board, are shown on Schematic Diagram WD-CB101074V1, Sheet 1. The Outline Diagram is shown on AD-CB101074V1.

Modem Board CB101074V1 mounts on the Controller Board and exists primarily to support Modem chips, U9, U10, and U11. These modems process 9600 baud serial synchronous receive and transmit data from the RF path (U9), the **P**hone **L**ine (**PL**) path (U10) and the **V**oted **D**igital **I**nterconnect (**VDI**) path (U11).

Microprocessor U1, a Dallas 80C323, controls the three modem chips, generates transmit data, and processes receive data for use by the system.

The microprocessor communicates with the QUICC processor on the Controller Board via Dual Port RAM U3.

There is no non-volatile memory on the Modem Board. Code is loaded into Code RAM (U2) via an interface from the QUICC processor.

The microprocessor circuitry on the Modem Board operates from a 3.3V supply. The Modem chips, however, require 5V. Thus a 3.3V to 5V conversion (U6) is needed for all signals to the Modem chips.

7.4.1 Modems

Each Modem chip interfaces to the 80C323 microprocessor via an 8-bit bi-directional address/data bus, and Chip Select (CS/), Read (RD/), Write (WR/), ALE, and Interrupt (INT/) signals.

During transmit the microprocessor writes data to the Modem as requested by the Modem interrupt. The Modem converts the data to a 9600-baud synchronous serial data stream.

During receive the Modem chip receives the 9600-baud synchronous serial data stream and interrupts the 80C323 microprocessor whenever it has a complete byte to transfer. The modem must also acquire bit sync and word sync from the data stream.

7.4.2 3.3V/5V Interface

Because the Modems require a 5V supply, and the microprocessor is on a 3.3V supply, it is necessary to convert the voltage of signals passing between them. This is done by U6, an IDT74FCT164245 3.3V/5V converter. Both output enable and direction can be controlled for the two 8-bit sections of this IC.

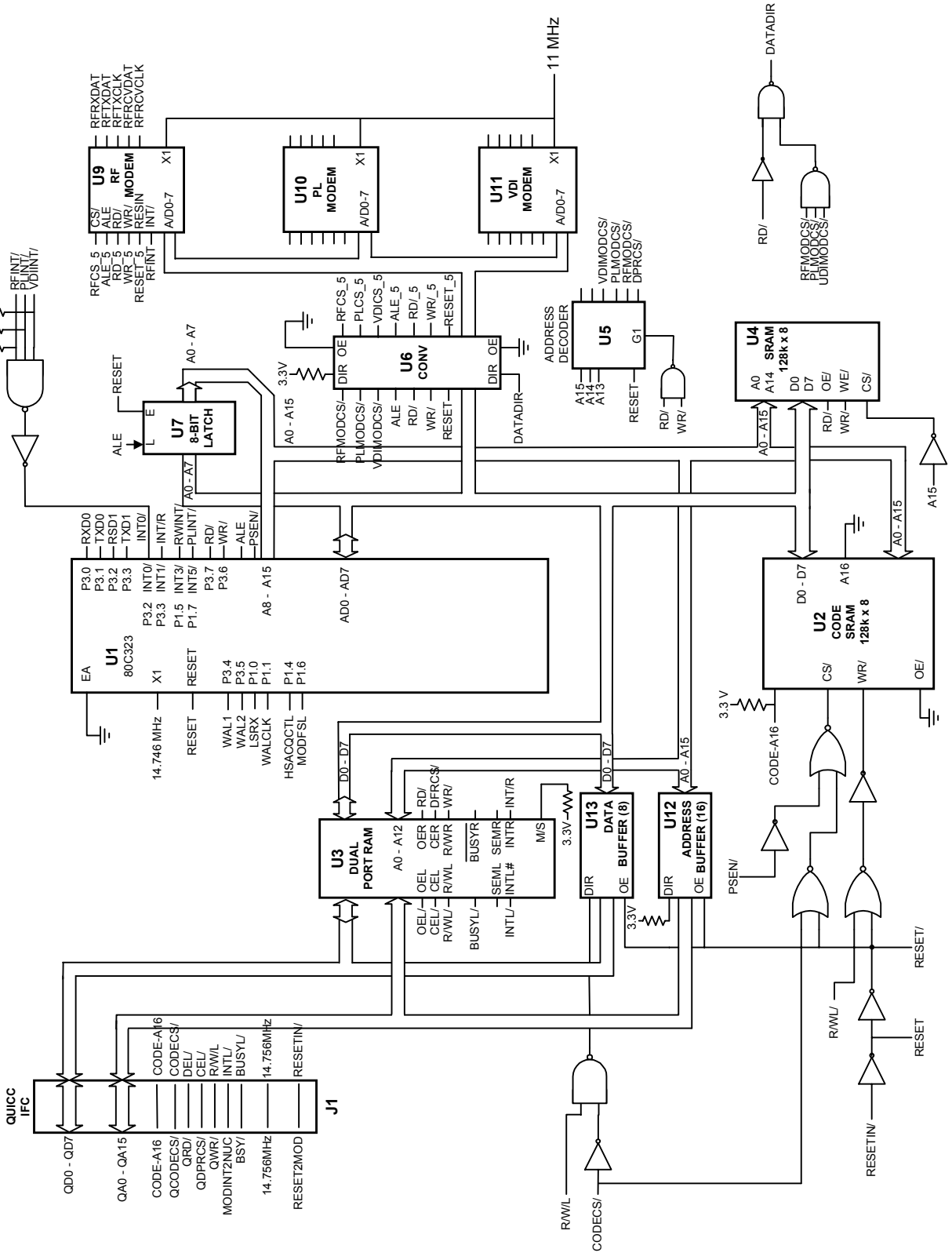


Figure 9 - Site Pro Modem Board Block Diagram

In this case, the outputs are always enabled, so the OE/ pins are tied low. Section 1 is used for signals which only go from the microprocessor to the Modems, so Pin 1 (1DIR) is tied high. Section 2 is used for the bi-directional bus. Pin 24 (2DIR) is driven by logic which sets the direction from microprocessor to Modems (high) most of the time. Only during a read of one of the modems is the direction reversed (low).

7.4.3 Microprocessor

The 80C323 microprocessor is a 3.3V version of the Dallas Speedy micro, an 80C32 derivative. It operates on a 14.7462 MHz. clock, which is convenient for generating standard baud rates. It interfaces with the Modems, Code RAM, Dual Port RAM, and Data RAM via standard address and data busses.

The microprocessor has 2 asynchronous serial ports (TXD0/RXD0 and TXD1/RXD1) which may be used in the SitePro Controller system for diagnostics. Both ports are available on the rear of the SitePro Controller shelf.

Six bits of 80C323 microprocessor I/O are used in a SitePro Controller configuration. WALCLK, WAL1, WAL2, and HSACQCTL are outputs, while LSRX and MODFSL are inputs.

The microprocessor has only two level sensitive interrupts, INT0/ and INT1/. The first, INT0/, is used for all Modem interrupts. The second, INT1/, is used for interrupts from the Dual Port Ram.

Since it is still necessary to distinguish between the three Modem interrupts, RFINT/ and PLINT/ are brought to I/O pins so the microprocessor can easily determine which Modem is interrupting. i.e. If a Modem interrupt occurs, the microprocessor looks at the two pins. If either or both are low, the corresponding interrupts are serviced. If neither is low, the VDI interrupt is serviced.

The 80C323 (U1) uses standard Intel multiplexed address/data bussing. During the first half of the bus cycle, U7 latches the lower 8 bits of address under the control of ALE.

Address decoder U5 generates the Chip Selects for the three modems and the Dual Port RAM using signals RD/, WR/, A13, A14, and A15.

Table 9 - Memory Map

MEMORY MAP		
Device	**Range**	**Addressable Size**
Code RAM	0-FFFF	64K Bytes
Dual Port RAM	0-1FFF	8K Bytes
Data RAM	8000-FFFF	32K Bytes
RF Modem	2000-2003	4 Bytes
PL Modem	4000-4003	4 Bytes
VDI Modem	6000-6003	4 Bytes

7.4.4 Code Memory

Code is stored in 128K byte RAM U2. The microprocessor can then access it via the Address and Data bus using PSEN/.

Code is loaded into U2 from the QUICC microprocessor. During loading, the QUICC holds the 80C323 reset with the RESETIN/ (low) signal. This is required so the 80C323

will not try to access U2 at the same time causing bus contentions. During loading, bus transceivers U12 (address bus) and U13 (data bus) are turned on. They are held inactive at all other times by the same RESETIN/ signal.

The QUICC controls Code memory access through signals RESETIN/, R/WL/, CODECS/ and CODE_A16. While RESETIN/ is held low, the QUICC can write or read U2. CODE_A16 can be used to control which 64K byte half of U2 is used. Thus, for instance, Control Channel code could be stored in one half and working channel code in the other. The switch is performed, while the 80C323 is held at reset, so it is entirely transparent to the 80C323.

When RESETIN/ is high, the bus transceivers U12 and U13 are off and the 80C323 controls the bus.

7.4.5 Data Memory

Data is stored in 128K byte RAM U4, however, only 32K is used. Chip select is A15/, thus the RAM is addressed in the upper half of memory space.

7.4.6 Dual Port Ram

Dual Port RAM U3, an IDT70V05 8K byte device, is the communication link between QUICC and 80C323 during normal operation. Either microprocessor can read or write any location in the RAM. Protocols must be established in software to avoid contention. The QUICC can interrupt the 80C323 by writing to Address 1FFF. This causes interrupt line INTR/ to go low. It is cleared by a read of the same address by the 80C323.

Likewise, the 80C323 can interrupt the QUICC by writing to address 1FFE, which causes a QUICC interrupt on line INTL/.

The 80C323 accesses the DPR via its address and data busses using signals DPRCS/, RD/, WR/, and INTl/.

The QUICC accesses the DPR via its address and data busses using corresponding signals CEL/, R/WL/, OEL/, and INTL/.

7.4.7 Troubleshooting Aids

Several signals are available on diagnostic connector J3 for troubleshooting purposes. Also probe points are provided for GND, 5V, and 3.3V.

7.5 ROCKWELL MODEM INTERFACE CARD (A3)

The SitePro Controller shelf uses Rockwell Modem Interface Card ROA 117 2247/1 and Rockwell Modem Assembly, RYTUA 921 01/1. For a Description and Circuit Analysis of this card refer to Maintenance Manual LBI-39152.

7.6 ANALOG BOARD (A4)

Analog Board CV101070V1 contains programmable high-speed filters, low speed encode and low speed decode filters. This board includes Simulcast Interface hardware, which eliminates the need for the older Simulcast Interface Board in Simulcast applications. Refer to Figure 11 - Analog Board Block Diagram, Outline Diagram AD-CB101070V1 and Schematic Diagram WD-CB101070V1.

7.6.1 Quad ADC and Single DAC

AD/DA Converter U23 is an 8-bit CMOS data acquisition device with four analog inputs, one analog output and a serial I^2C-bus interface. Three address pins A0 (Pin 5), A1 (Pin 6) and A2 (Pin 7) can be used for programming a hardware address, allowing up to eight similar devices to be connected to the I^2C-bus without additional hardware. In this application, these three leads are tied to +5V. Address, control and data to and from the device are transferred serially through the two-line bi-directional I^2C-Bus. The PWR SENSE lead is connected to analog input AIN0 at U23, Pin 1, converted to a digital word and read via the I^2C-bus. Monitoring PWR SENSE is the only application for the AD Converter at present.

The I^2C address is 9E hex. Bits 7-4 are hardwired in the device. Bits 3, 2, 1 are A2, A1 & A0. Bit 0 is the Read/Write bit.

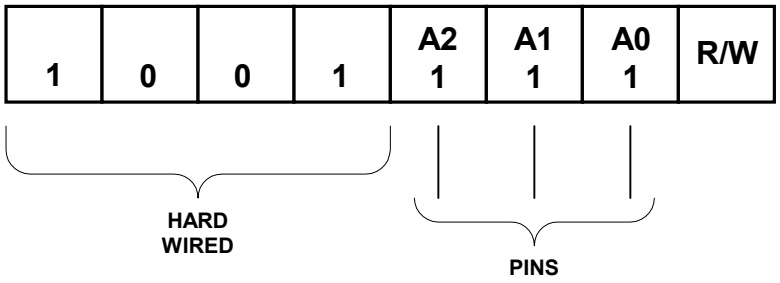


Figure 10 - I^2C Address

7.6.2 8-Bit I/O Expander for I^2C Bus

I/O Expander U4 is a 16-bit two-line quasi-bi-directional port and an I^2C-bus interface. The two-line I^2C inputs SCL and SDA connect to U4, Pins 22 and 23 respectively. These two-line inputs can be monitored at Test Points TP2 and TP3. The expanded outputs and connections are U4,

- Pin 4 (P0) – HS-FILTERSEL0 (Monitored at TP19)
- Pin 5 (P1) – HS-FILTERSEL1 (Monitored at TP24)
- Pin 6 (P2) – HS-FILTERSEL2 (Monitored at TP25)
- Pin 7 (P3) – HSACOCTL1 (Monitored at TP26
- Pin 8 (P4) – LSCTL (Monitored at TP30)
- Pin 9 (P5) - (Monitored at TP29) Not Used
- Pin 10 (P6) – MODCTL (Monitored at TP28)
- Pin 11 (P7) – LSDATAACC (Monitored at TP27)
- Pin 13 (P10) - ground
- Pin 14 (P11) - ground
- Pin 15 (P12) - ground
- Pin 16 (P13) – ground
- Pin 17 (P14) - ground
- Pin 18 (P15) – Pulled up to +5V through resister network R127, Pin 8
- Pin 19 (P16) – Pulled up to +5V through resistor network R127, Pin 7
- Pin 20 (P17) – Pulled up to +5V through resistor network R127, Pin 5

7.6.3 –5 Volt Generation

-5 Volt generation is accomplished through voltage regulator U2. –12 Volts is applied to U2, Pin 4 IN. Capacitors C3 and C4 provide filtering of this input. The output is at U2, Pin 3 Out. The –5 Volts is filtered by capacitors C5 and C6. –5Volts can be monitored at Test Point TP31.

7.6.4 High-Speed Data Transmit Filters

The High Speed Data Transmit Filter section consists of an input buffer, five selectable High-Speed filters, an 8:1 MUX, a digital pot, output buffering and an analog switch.

Buffer/follower circuit U6A precedes the high-speed data transmit filter circuits for RFTXDAT. The output of this circuit can be monitored at TP1. The output of U6A is applied to the inputs of high-speed Data Transmit Filters:

- 9600 Baud Wide Band
- 4800 Baud Narrow Band
- 9600 Baud Wide Band ETSI[6]
- 4800 Baud Narrow Band ETSI
- 9600 Baud Narrow Band Switched Capacitor Filter Circuit

The **H**igh **S**peed **D**ata (**HSD**) filter filters data transitions to minimize the high-speed-data transmission bandwidth. The frequency response of the HSD filter section is changed by selecting the output of only one filter circuit with 8:1 MUX U7.

High-speed data is a 4800 or 9600 bit per second data stream generated by the microcomputer through the RF data modem U9 on the Modem Board.

7.6.4.1 9600 Baud Wide Band

This HSD filter circuit consists of operational amplifier U5B followed by operational amplifier U5A. The output of U5A, Pin 1 is applied to the input of 8:1 MUX U7, Pin 4 (N01). This HSD amplifier filter output can be monitored at TP4.

Table 10 - 9600 Baud WB Filter Response

FREQUENCY	RESPONSE
1000 Hz	0 dB (ref)
10 Hz	0 dB ± 1dB
3000 Hz	0 dB ± 1dB
6000 Hz	-2 dB ± 1dB
7000 Hz	-3 dB ± 1dB
20000 Hz	<-20 dB

[6] **E**uropean **T**echnical **S**tandards **I**nstitute

7.6.4.2 4800 Baud Narrow Band

This HSD filter circuit consists of operational amplifier U5C followed by operational amplifier U5D. The output of U5D, Pin 14 is applied to the input of 8:1 MUX U7, Pin 5 (N02). This HSD amplifier filter output can be monitored at TP5.

Table 11 - 4800 Baud NB Filter Response

FREQUENCY	RESPONSE
500 Hz	0 dB (ref)
10 Hz	0 dB ± 1 dB
1500 Hz	0 dB ± 1dB
3000 Hz	-2 dB ± 1dB
3500 Hz	-3 dB ± 1dB
10000 Hz	<-20 dB

7.6.4.3 9600 Baud Wide Band ETSI

This HSD filter circuit consists of operational amplifier U10B followed by operational amplifier U10A. The output of U10A, Pin 1 is applied to the input of 8:1 MUX U7, Pin 6 (N03). This HSD amplifier filter output can be monitored at TP6.

Table 12 - 9600 Baud WB ETSI Filter Response

FREQUENCY	RESPONSE
1000 Hz	0 dB (ref)
10 Hz	0 dB ± 1dB
2000 Hz	0 dB ± 1dB
3600 Hz	-2 dB ± 1dB
4600 Hz	-3dB ± 1dB
12000 Hz	<-20 dB

7.6.4.4 4800 Baud Narrow Band ETSI

This HSD filter circuit consists of operational amplifier U510C followed by operational amplifier U10D. The output of U10D, Pin 14 is applied to the input of 8:1 MUX U7, Pin 7 (N04). This HSD amplifier filter output can be monitored at TP7.

Table 13 - 4800 Baud NB ETSI Filter Response

FREQUENCY	RESPONSE
500 Hz	0 dB (ref)
10 Hz	0 dB ± 1dB
1000 Hz	0 dB ± 1dB
2300 Hz	-2 dB ± 1dB
3000 Hz	-3 dB ± 1dB
8000 Hz	<-20 dB

7.6.4.5 9600 Baud Narrow Band

This HSD filter circuit consists of switched-capacitor filter circuit U11 required to produce a narrow frequency response. This circuit is driven by an external 400 kHz clock on U11, Pin 1. The output on U11, Pin 5 is applied to the input of 8:1 MUX U7, Pin 12 (N05). This HSD filter circuit output can be monitored at TP8.

Table 14 - 9600 Baud NB Filter Response

FREQUENCY	RESPONSE
100 Hz	0 dB (ref)
10 Hz	0 dB ± 1dB
3800 Hz	<-3 dB
4400 Hz	<-3 dB
11000 Hz	<-20 dB

7.6.4.6 8:1 MUX

Multiplexer circuit U7 is used to select the applicable HSD to be passed on to Dual Digital Potentiometer U8. The inputs to U7 are applied to N01 through N05 (Pins 4, 5, 6, 7 and 12). The selection of HSD is made by the HS-FILTER_SEL inputs on U7, Pin 1 (A0), Pin 16 (A1) and Pin 15 (A2).

Table 15 - HSD Selection

A2,A1,A0	ACTION	NO#	HSD	
000	Selects	NO1	9600 WB	
001	Selects	NO2	4800 NB	
010	Selects	NO3	9600 WB	ETSI
011	Selects	NO4	4800 NB	ETSI
100	Selects	NO5	9600 NB	
101		6	*Quiet*	
110		7		
111		8		

EN (Enable) on Pin 2 is connected to +5V always enabled. The 8:1 MUX output COM is on U7, Pin 8. Selections of NO6 through NO8 (all grounded) results in a quiet output.

7.6.4.7 Dual Digital Pot

The output of the MUX circuit connects to the input of Addressable Dual Digital Potentiometer U8, Pin 14 (HO). This device has two independently controlled potentiometers. Only one pot is used in this application. The wiper can be set to one of 256 positions and is controlled by the microprocessor through the I^2C data bus SCL (Pin 9) and SDA (Pin 10). The output on Pin 12 (WO) connects to the input of amplifier circuit U6B. Pot I^2C address is 50 hex.

7.6.4.8 Inverting Buffer/Amplifier

Amplifier circuit U6B is an inverting buffer/amplifier with a gain of approximately 1.5. The output of this circuit is connected to the input of analog switch U9. The output of this circuit can be monitored at TP9.

7.6.4.9 Analog Switch

Analog Switch U9 is a Single-Pole/Double Throw (SPDT) with one normally closed and one normally open switch. Analog Switch U9 switches between RFTXDATA (U9, Pin 2 (S1)) coming from inverting Buffer/amplifier U6B and ANALOG AUDIO (U9, Pin 8 (S2)) under the control of MODCTL, Pin 6 output of I^2C I/O Expander U4. S1, Pin 2 (RFTXDATA) is connected when MODCTL=0. The output is on U9, Pin 1 (D) MOD.

7.6.5 Clock Generation

Clock generation is accomplished by inverter circuits U32C and U32D and Dual 4-Stage Binary Ripple Counter U3. U32C and 400 kHz crystal Y1 form a 400 kHz Pierce oscillator circuit. The output of U32C connects to the input of buffer U32D. The 400 kHz clock (CLK) output of 32D connects to U3, Pin 1 (CP1). This 400 kHz CLK can be monitored at TP10. Counter U3 divides the 400 kHz CLK down to produce a 25 kHz CLK. This output can be monitored at TP11. The 400 kHz CLK is further divided down to produce a 3.125 kHz CLK. This output can be monitored at TP12.

7.6.6 Low -Speed Data Decode Filters and Slicer

The Low-Speed Data Decode Filter is used to remove voice-audio (300-3000 Hz) leaving only the low-speed or subaudible data for an input to the microprocessor.

VOL/SQ/HI couples both high and low speed data through capacitor C33 to the input of buffer/follower circuit U15A. The output of U15A, monitored at TP13, connects to the input of two circuits. The first connection is the input to the low speed data decode filter through operational amplifier U15B. The second connection is the input of a high-speed data slicer circuit consisting of MUX U31 and voltage comparator U33A.

Low-Speed Decode Filter:

Operational amplifier U15B provides an approximate gain of 2:1, monitored at TP15. The output of U15B connects to the input of high pass filter U16. High pass filter U16 is driven by a 3.125 kHzCLK on Pin 16 (CLK) and is a 4^{th} order Butterworth filter. It provides -3 dB rolloff @ 50 Hz and -35 dB rolloff @ 18 Hz (Table 16 - Low Speed Data Decode Filter Response). The output of U16, monitored at TP16, is applied to the input of low pass filter U14. Low pass filter U14 is synchronized by a 25 kHz clock applied to Pin 3 (CLK) and is an 8^{th} order elliptic filter. It is flat to 250 Hz and provides more than -40 dB rolloff @ 300 Hz.

The output of U14, monitored at TP17, is applied to the input of buffer/amplifier U28A though 0 ohm resistors R61 and R61. U28A provides a gain of 2, monitored at TP18. The output of U28A connects to the input of voltage comparator circuit U12B.

Analog switch U18 connects/disconnects resistor R67 normally in parallel with resistor R60 connected to U12B, Pin 6. This function is controlled by LSDATAACQ on U18, Pin 6 (IN). LSDATAACQ is one of the I^2C I/O expander outputs. When Pin 6 is low R67 is

in parallel with R60. When Pin 6 is high R67 has been removed from the circuit. Moving R67 in and out of the circuit adjusts the input time constant to U12B, Pin 6.

Voltage comparator U12B provides a square wave output that swings from +12 to -12 volts, monitored at TP14. This output is applied through resistor R58 to the base of NPN transistor Q1. Transistor Q1 interfaces the limited signal LSIN to the Controller Board.

Table 16 - Low Speed Data Decode Filter Response

FREQUENCY	RESPONSE
100 Hz	0 dB (ref)
50 Hz	-3 dB ± 1dB
18 Hz	-35 dB ± 3 dB
250 Hz	-0 dB ± 1dB
300 Hz	<-40 dB

High Speed Slicer

The High Speed slicer circuit converts 9600 baud noisy received data to hard 1's and 0's, producing a +5Volt square wave at the output of U33A. This output is controlled by the HSACQCTL0 and HSACQCTL1 inputs to U31, Pins 1 (A0) and 14 (A1) respectively. HSACQCTL0 is controlled directly by microprocessor 80C323 rapidly controlling the receive acquisition rate by adjusting the input time constant to U33A. The **T**ime **C**onstant (**TC**) is adjusted to provide a fast TC to follow the initial frequency variation of the transmitting radio, then a slow TC to better slice the data after the frequency becomes stable.

The TC is adjusted by selecting a resistor to connect in the negative input terminal of U33A (Pin 2). Resistors are selected as shown in the following table:

Table 17 - Acquisition Rates

A1, A0	NO#	RESISTOR	ACQUISITION
00	NO1	R40	FAST
01	NO2	R43	SLOW
10	NO3	R125	ETSI FAST
11	NO4	R126	ETSI SLOW

A0 = HSACQCTL0
A1 = HSACQCTL1

HSACQCTL1 is controlled by the I2C bus and is only changed at power up or reset to switch between US and ETSI bandwidths.

The output of the high-speed data decode filter RFRXDAT connects to the Controller Board.

7.6.7 Low Speed Data Encode Filter

The Low Speed Data Encode filter is used to smooth out transitions of data impressed upon the voice audio. Low-speed data is a 150 bit per second data stream generated by the microcomputer and used to produce subaudible data on the voice audio.

Low-Speed Data is generated by microcomputer U1 on the Modem Board through EPLD U27, Pins 81 and 80, Walsh Bit 1 and Walsh Bit 2 respectively. For low-speed data, the two Walsh bits are scaled by resistors R91 and R95 and summed through analog switch U22. The output of U22, Pin 1 (D) connects through operational amplifier U19A and buffer/follower U19B to the input of the low-speed-data encode filter U20. Operational amplifier U19A produces a loss of -9 dB at TP23. The output of buffer U19B, monitored at TP22 connects to the input of low-pass filter U20, Pin 14 (IN). Low pass filter U20 is synchronized by a 25 kHz clock applied to Pin 3 (CLK) and is an 8th order elliptic filter. For the frequency response refer to the following table.

Table 18 - Low-Speed Data Encode Filter Response

FREQUENCY	RESPONSE
100 Hz	0 dB (ref)
5 Hz	+1 dB ± 2dB
150 Hz	-1.5 dB ± 1 dB
250 Hz	-4 dB ± 1dB
300 Hz	<-40 dB

The output of this filter, monitored at TP21, connects through 0 ohm resistor R84 to the input of operational amplifier U17A, Pin 3. U17A provides a gain of 2:1. LSDTX connects to J1B, Pin 21 through Interconnect Board A1 to the EDACS connector J12, Pin 23 (LSDTXMOD). This provides the low frequency Channel Guard modulation input to the base station transmitter.

7.6.8 Simulcast Control Circuits

Simulcast control circuits, consisting of RS-232 and RS-422 drivers, convert (RS-232 - TTL - RS-422) and buffer control signals coming from SitePro Controller Board A2. Refer to the second page of Figure 11 - Analog Board Block Diagram. These signals are passed through Simulcast connector J13, on Interconnect Board A1, and connect to the Simulcast cross connect panel. Likewise, RS-422 drivers convert (RS-422 to TTL) and buffer signals coming from the cross connect panel, passing through A1 and going to SitePro Controller Board A2.

A Simulcast "bypass" control signal, when low, forces the Simulcast site to operate in a non-Simulcast mode and is driven by Simulcast control equipment. The active low bypass control line, BYPASS, originates at the Simulcast control equipment, and is used to re-route audio paths at the SitePro interface module located in a station interface panel. It also serves to re-route 9600 BPS data, 150 BPS data, A/D control line and the PTT control line, all of which are directed back to the SitePro Controller Board.

Control Signals

RS-232 Drivers/Receivers U24 and Quad RS-422 Line Driver U25 converts and buffers signals coming from the SitePro Controller Board and going to the Simulcast cross connect panel. These signals are:

- PLTXDAT (IN)
- PLTXCLK (IN)
- PLTXDAT + (OUT)
- PLTXDAT - (OUT)
- PLTXCLK + (OUT)
- PLTXCLK - (OUT)

Quad RS422 receiver U26 converts and buffers signals coming from the Simulcast cross connect panel going to the SitePro controller Board. These signals are:

- 150 Hz + (IN)
- 150 Hz - (IN)
- 9.6 DATA + (IN)
- 9.6 DATA - (IN)
- 9.6 REF + (IN)
- 9.6 REF - (IN)
- EXT 150 Hz + (OUT)
- EXT 9.6 DATA + (OUT)
- EXT 9.6 REF + (OUT)

Audio Switching

The audio bypass circuit consisting of relay driver U27 and relays K1 and K2 allows the audio to be interrupted and receive voice to be sent back to the station, when in the bypass mode.

In normal Simulcast operation Rx AUDIO L connects through relay K1 to RXV R. TX AUDIO L connects though K1 to TXV R. Also, RX AUDIO H connects through relay K2 to RXV T. TX AUDIO H connects through K2 to TXV T.

When the BYPASS signal goes low, forward biasing diode D15, relay drivers U27 cause relays K1 and K2 to activate. This action places the Simulcast System in the Bypass mode. RX AUDIO L now connects through K1 to TX AUDIO L. Likewise, RX AUDIO H connects through K2 to TX AUDIO H, returning the audio back to the station.

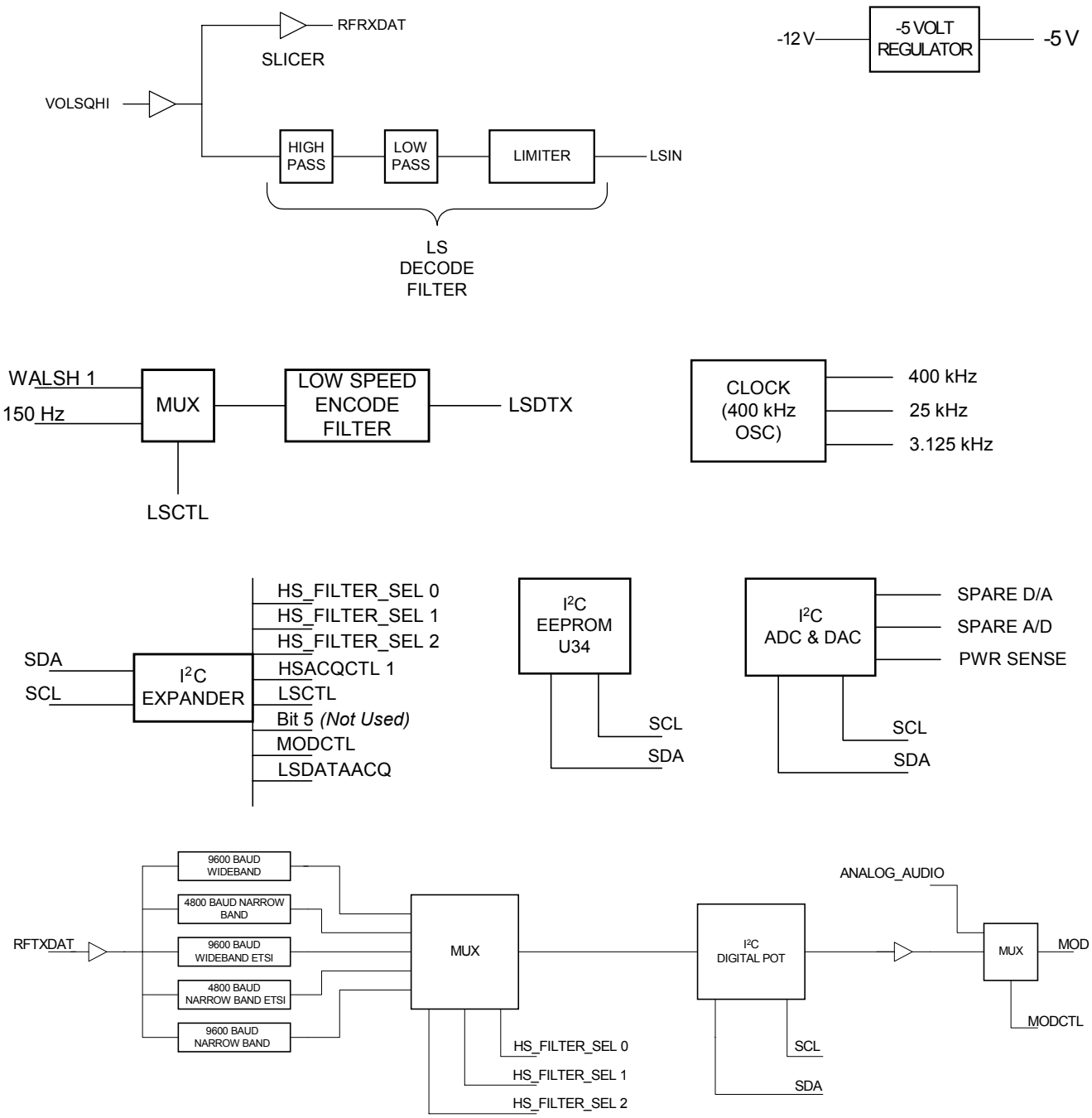


Figure 11 - Analog Board Block Diagram

SIMULCAST INTERFACE CIRCUITS

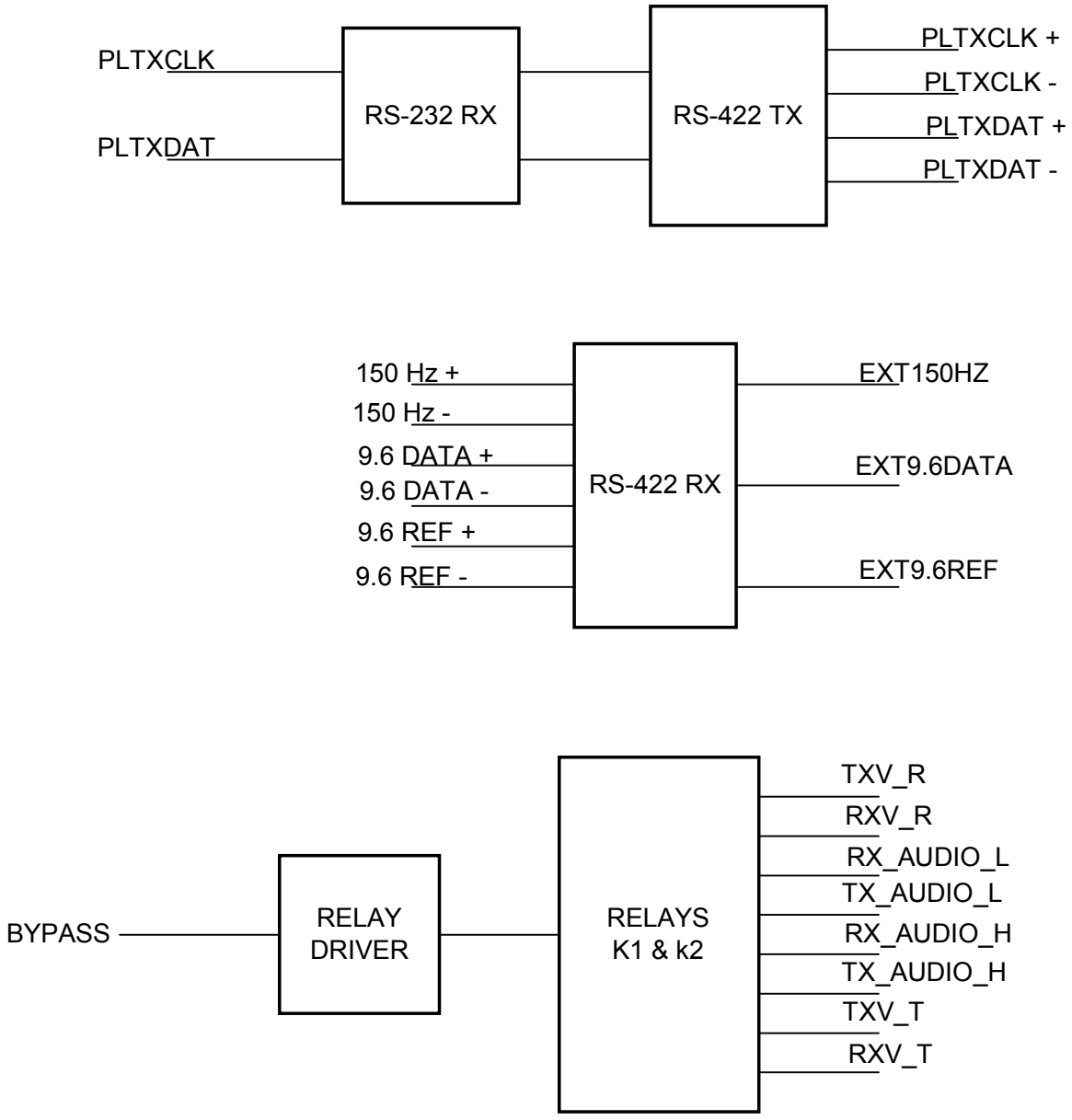


Figure 11 - Analog Board Block Diagram (Continued)

7.7 POWER SUPPLY (A5) PS101328V1

The power supply used with the SitePro Controller is a 40 watt DC-DC, open frame supply (Figure 2 - SitePro Controller Shelf Assembly). Specifications for this supply are:

INPUT VOLTAGE: 24 VDC nominal; 10-30 VDC continuous input.

INPUT CURRENT: Maximum input current at minimum 10 VDC with full rated output load at 6 Amps max.

DC OUTPUTS:

OUTPUT	OUTPUT (V)	MINIMUM LOAD	CURRENT (I)	TOTAL REGULATION	V1 OVP SET.	RIPPLE AND NOISE	NOTES
1	+5.1 V	0.1 Amp	4 Amps	2%	6.2±0.6V	1%	
2	+12 V	0.05 Amp	2 Amps	6%		1%	A & B
3	-12 V	0 Amps	0.4 Amp	5%		1%	

OUTPUT POWER: Normal continuous output power is 40 W, 45 W peak for 60 seconds.

OVERLOAD PROTECTION: Fully protected against short circuit and output overload.

TEMPERATURE RANGE: -30 to 60°C at full rated output power.

HUMIDITY: Operating 0-95% RH

ALTITUDE: Operating -500 to 10,000 ft.

7.8 MISCELLANEOUS INFORMATION

7.8.1 Serial Port Data Format

The serial ports transfer RS-232 asynchronous serial data at a rate of 38.4k using the half-duplex operating mode. That is, data flows in only one direction at a time. The characteristics of the communication link are:

Type:	RS-232C
Baud Rate:	38.4 kilobaud
Start Bits:	1
Stop Bits:	1
Parity:	None
Data Type:	Binary

8.0 PERSONALITY PROGRAMMING

A *personality* is a computer file generated by the user. This file (or personality) is downloaded into the SitePro Controller and contains data that directs operating characteristics of the SitePro Controller unit. This allows each SitePro Controller to be programmed as required by the application. The SitePro Controller personality includes system configuration information such as channel frequencies, call parameters, operating modes, and identification information.

The personality programming process stores data in non-volatile regions of memory. The SitePro Controller shelf has its personality stored in two locations. The first location is EEPROM U14 on Controller Board A2 and contains general site level information. The other location is EEPROM U34 on Analog Board A4 and contains general channel level information. Programming is performed through serial programming port J8 on the front of the Controller Board (Figure 13 - Location of Serial Programming Port J8). Programming can also be accomplished through an Ethernet connection.

The Personality Programming process involves using SitePro PC Programmer TQ3408 software, which creates the desired personality and transfers the Personality data to the EEPROM's U14 on the Controller Board and U34 on the Analog Board.

Equipment Required:

- Computer capable of running Windows95/98NT/2000/ME, which has a serial and/or Ethernet port according to following tables.
- Programming Manual MM101461V1
- Programming software TQ3408
- Programming cable CA101302V1
- Male DB-25 to female DB-9 adapter or cable if the computer serial port is a male DB-9 connector instead of a male DB-25 connector

Table 19 -Minimum Operating System Requirements

	Windows 9x	Windows NT	Windows 2000
Processor Speed	Pentium II 300 MHz	Pentium II 300 MHz	Pentium II 300 MHz
RAM for Windows	16 Megabytes	24 Megabytes	64 Megabytes
RAM for Hard Drive	10 Megabytes	10 Megabytes	10 Megabytes
Drives	CD ROM	CD ROM	CD ROM
Ports	1 Serial or Ethernet	1 Serial or Ethernet	1 Serial or Ethernet
Microsoft Internet Explorer	Version 5.0 or higher	Version 5.0 or higher	Version 5.0 or higher

8.1 PROGRAMMING A PERSONALITY

1. Install and run SitePro programming software TQ3408.
2. Connect one end of serial programming cable CA101302V1 (TQ3408) to the computer (Figure 12 - Programming Hook-Up). Connect the other end of the cable to the SitePro Controller Serial Programming Port J8 (Figure 13 - Location of Serial Programming Port J8).
3. Proceed with personality programming by running the program as instructed in Programming Manual MM101461V1.

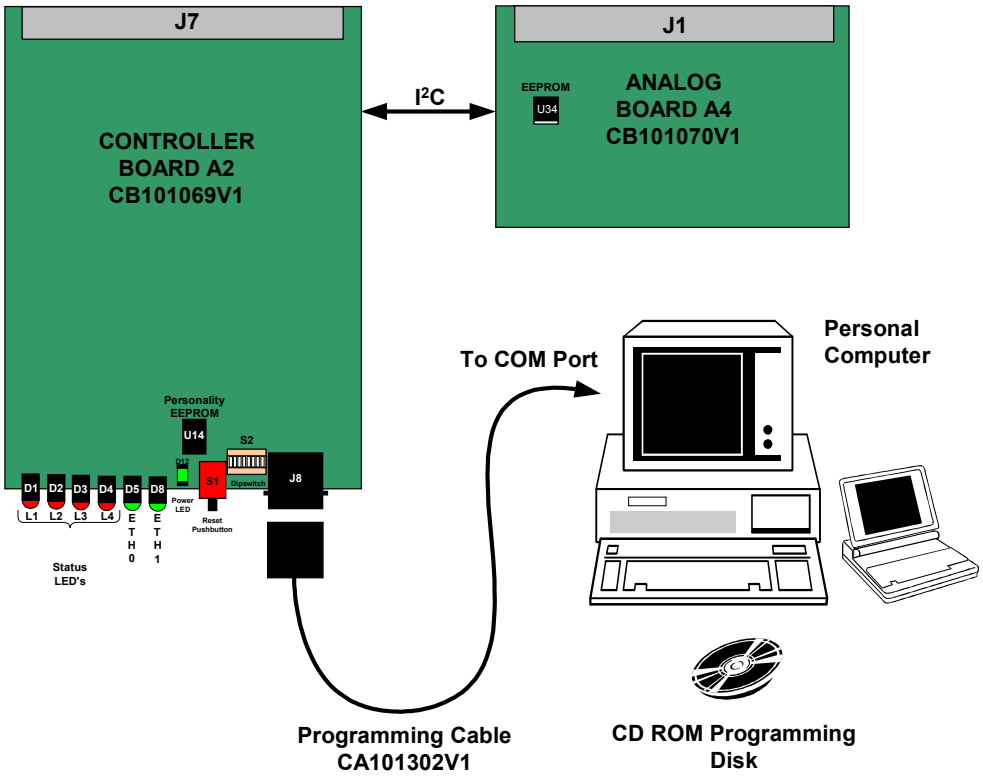


Figure 12 - Programming Hook-Up

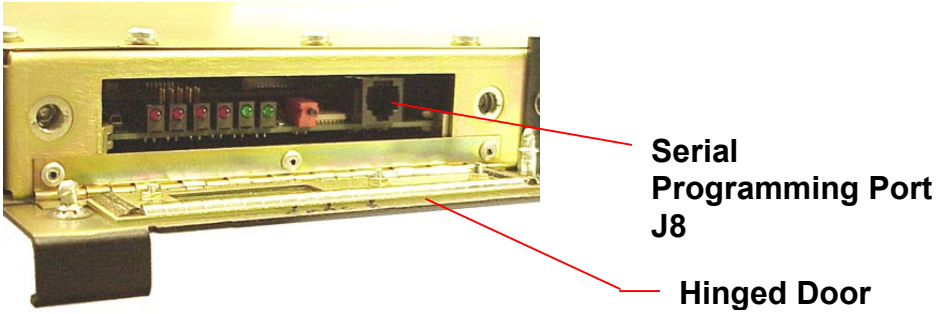


Figure 13 - Location of Serial Programming Port J8
(Front Left of SitePro Controller with Hinged Door Open)

9.0 TROUBLESHOOTING

The most common causes for problems encountered with the SitePro Controller are programming errors and interface connections.

9.1 ON SITE TROUBLESHOOTING

When troubleshooting a SitePro Controller on site:

1. Verify that all cables are properly connected and secure. Refer to the applicable configuration manual.
2. Verify the SitePro Controller personality is properly programmed for the specific application. Refer to the configuration manual and the software release notes.
3. If it is suspected that the SitePro Controller has failed, replace the controller with a known good unit, properly programmed for this application.
4. If the replacement SitePro Controller resolves the problem, bench check the defective unit using the test procedures provided in this manual or send it to the repair and return depot.

9.2 IN CASE OF DIFFICULTY

If unable to resolve a problem satisfactorily, contact the M/A-COM Technical Assistance Center (TAC) at 1 (800) 528-7711 (Outside USA, (434)-385-2400).

9.3 SITEPRO SHELF TEST

9.3.1 Equipment Needed

- 13.8V Power Supply (2A min)
- Current Meter
- PC with terminal emulator
- Loopback cables – described below
- Power Cable
- RJ-45 to PC serial cable
- RJ-11 to PC serial cable

Both serial cables are connected per the chart below. One cable is RJ-45 (8 pin modular) to DB-9F. The other cable is RJ-11 (6 pin Modular) to DB-9F.

Table 20 - Cable Connections

SIGNAL	RJ PIN	DB-9F PIN	SIGNAL
Tx	2	2	Rx
Rx	1	3	Tx
Gnd	3	5	Gnd

1. Connect power (13.8V) to J7 on the rear of the shelf. Measure total shelf current. Current should be within the limits shown in the table below. Connect +13.8VDC to J7-1 and GND to J7-2.

Table 21 - Current (I) Limits

SHELF DESCRIPTION	PART NUMBER	MIN CURRENT	MAX CURRENT
Fully loaded shelf	EA101209V1	1.0A	1.4A
W/O RMIC and RM	EA101209V2		
W/O Analog Board	EA101209V3		
W/O both	EA101209V4		

2. Check that the Green front power light came on.
3. Check that '**SITEPRO!**' appears on the front LED Display.
4. Check that the +5V, +12V, -12V, and CTS LEDs are lit on the (Rockwell Modem) RMIC Board.
5. Set up a terminal emulator on PC COM1 for 38.4Kbaud, 1 start bit, no parity. Connect the PC COM1 serial port to J8 (RJ-11modular jack) on the front of the Controller Board.
6. Set up a second copy of the terminal emulator (or a second PC) connected to COM2, 2400 baud, 7 bit, odd parity, connected to J14-I (80C323 Port0) (RJ-45 modular jack) on the rear of the shelf.

   The tester should become familiar with the Factory Test program, which is stored in the Controller boards when they arrive from the board manufacturer.

NOTE

Factory test software is available on a compact disc. The test software is loaded serially like application code.

The test program will come up in non-menu mode after three PNG's. There are several modes. For manual test, get into menu mode by typing ENTER, then 'q', then 'm'.

Menu Mode – Runs automated tests from a menu. Some menus have sub menus. '0' goes to Command mode.

Non-Menu Mode – Runs automated tests without displaying the menu (for automated testing). '0' goes to command mode.

Command mode – provides lower level control of board functions. See 'H' (help) menu. 'Q' goes to menu mode.

7. Select test 4 (Modem board tests). Then select sub test 1 (Load a file to the Modem board). Use the terminal emulator file transfer utility to send the file 'SIMON.HEX' to the Modem . The upload takes about 10 seconds. Hit ENTER.

   The header **********SIMON SITEPRO 2001**********' should appear on the second terminal.

8. Get the Factory Test into Command Mode. Send the following commands.

   SI2C 4C 01 02 (Sets up the I^2C to address the I/O expander on the Analog Board)

   WI2C 00 00 (Selects filter 0 and sets up normal path for RF data)

   SI2C 50 01 00 (Sets up the I^2C to address the Digital Pot on the Analog Board)

   WI2C A9 50 (Sets the pot to normal level)

9.3.2 RF Data Loop Test

1. Connect a loopback plug(Figure 16 - Loopback Test Connectors) into J12 (EDACS Connector) on the rear of the shelf (Refer to Figure 14 - RF Data Signal Path).

   This plug loops pin 19 (MODULATION) to pin 7 (VOL/SQ/HI).

   From terminal 2 type the command

   POR1=EF (sets HSACQ0CTL) to 1 on the Analog board.

   From terminal 2, type 'BERDE-02=1'. In a few seconds, the response below will appear on the terminal.

   "ERROR COUNT = 0000 RECEIVE CHECKSUM = 027C11"

   Sometimes the first line displayed is incorrect. Unit passes if the second line is correct.

2. Hit the ESC key to stop the test.

9.3.3 Modem Loop Test

1. Connect a loopback plug into J4A (RM0) on the rear of the shelf (Refer to Figure 15 - Phone Line Data Signal Path).

   This plug loops transmit to receive. It is made by tying wires together on an 8-pin modular plug. Tie pin 2 to pin 4 and pin 3 to pin 5.

2. On the RMIC Board, set up Rx and Tx levels by closing sections 2 and 6 of switch S1. Open all other sections

   From terminal 1, in menu mode, execute test 4, subtest 3 (Dual Port Ram Test). This resets the SitePro Modem Board. The SIMON turn-on banner will appear on terminal 2.

3. From terminal 2, type 'MDS 1'.

4. From terminal 2, type 'BERDE-0=1'. In a few seconds, the response below will appear on the terminal.

   "ERROR COUNT = 0000 RECEIVE CHECKSUM = 027C11"

   Sometimes the first line displayed is incorrect. Unit passes if the second line is correct.

5. Hit the ESC key to stop the test.

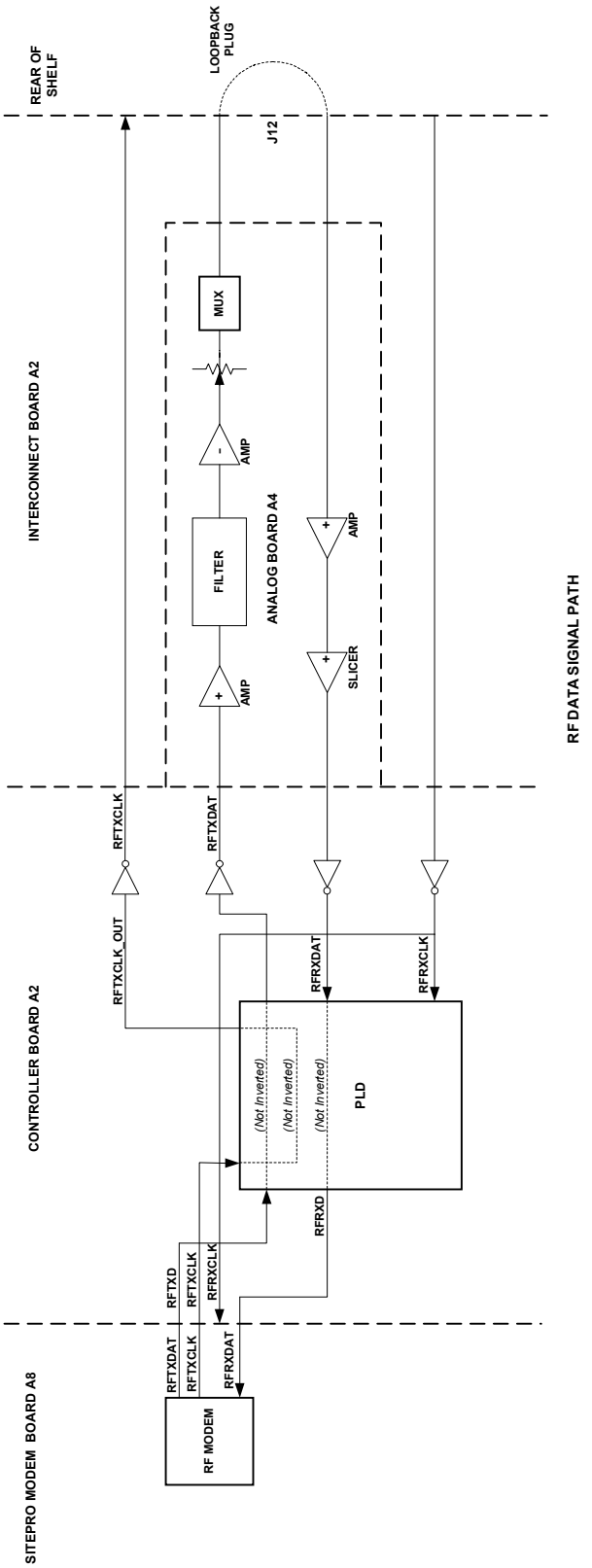


Figure 14 - RF Data Signal Path

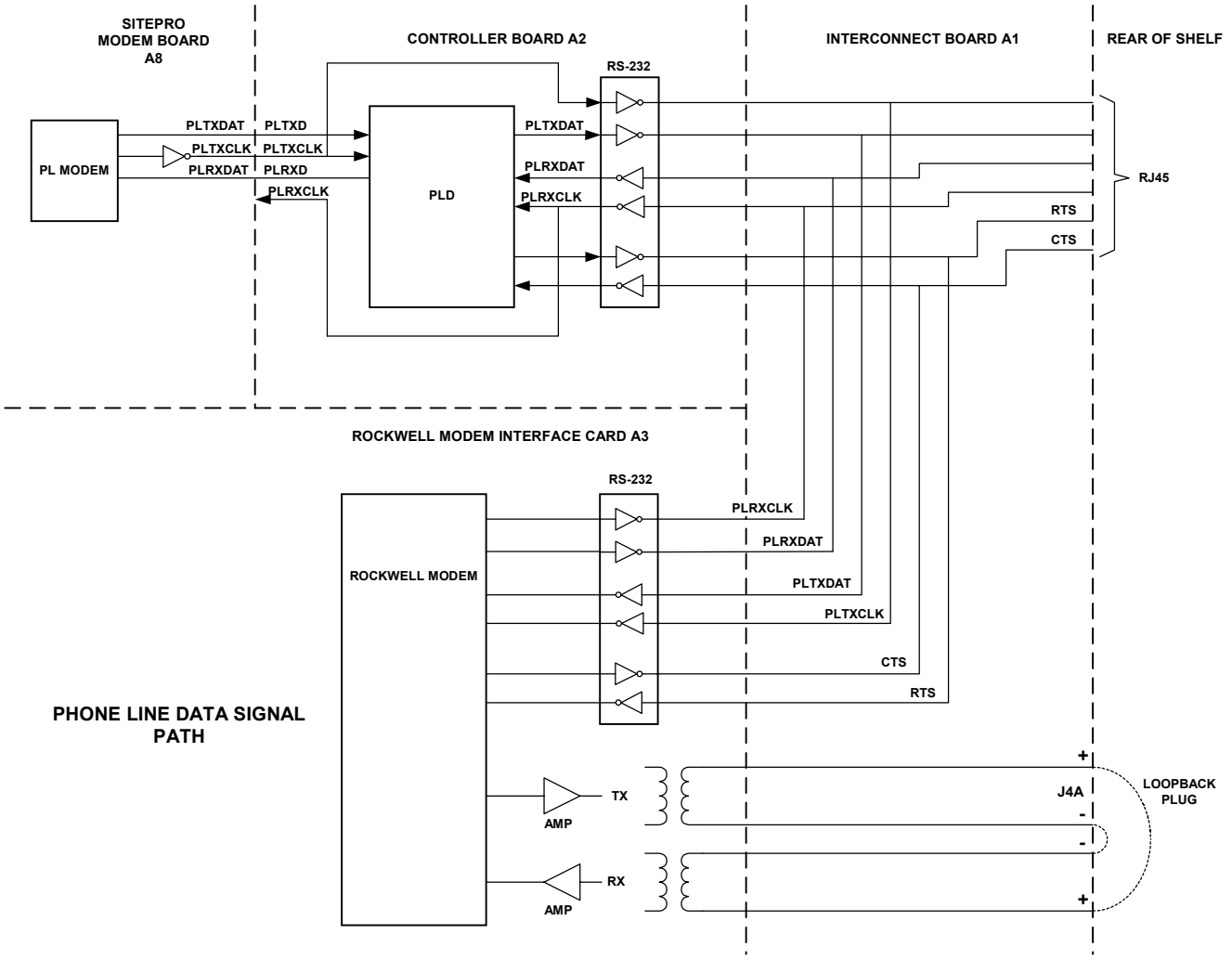


Figure 15 - Phone Line Data Signal Path

9.3.4 Loopback Connectors

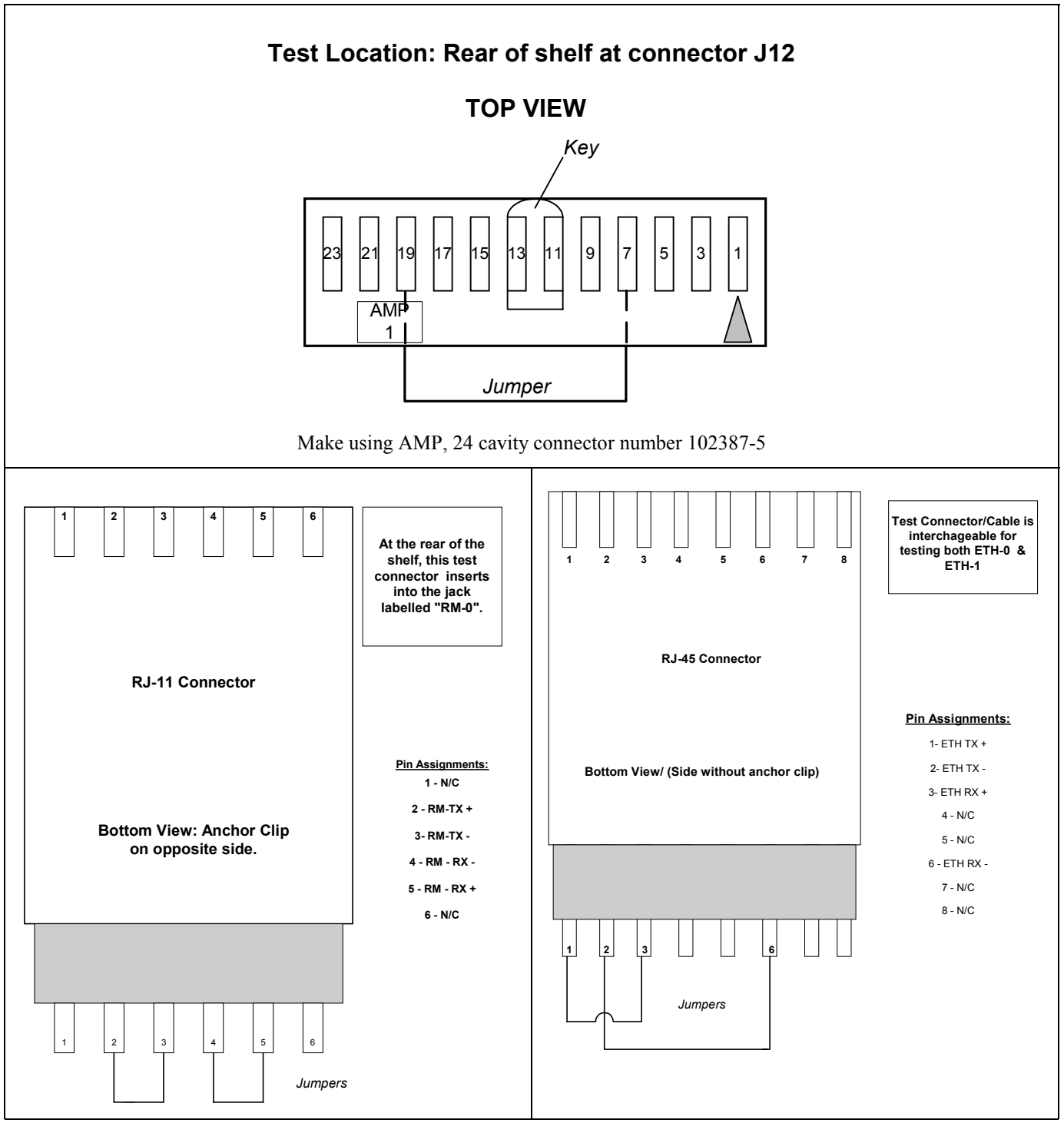


Figure 16 - Loopback Test Connectors

9.4 FIELD TROUBLESHOOTING GUIDE

9.4.1 SitePro Controller Board

This guide assumes the Controller board is in a SitePro shelf on a bench, not connected to a station, but with 13.8V power applied to J7 of the shelf. It is also assumed that 'FactoryTest' software resides on the Controller. Modem board test program 'SIMON' is also needed for some of the tests. In most cases, the shelf top cover must be removed.

See the Shelf Test Procedure for setup information and some information on FactoryTest. Set up two terminal emulators as described in the Shelf test.

This is not a detailed test procedure. It is intended for use in service shops by technicians having a high degree of expertise in troubleshooting electronic circuitry. Some circuits cannot be tested at the shelf level.

9.4.1.1 REFERENCE DOCUMENTS

WD-CB101069V1 - Schematic Diagram

TS-CB101069V1 - Test Spec

AD-CB101069V1 - Assembly Drawing

Block Diagrams of Controller Board and SitePro Modem Board

9.4.1.2 BOARD WILL NOT RUN i.e. FACTORY TEST DOESN'T COME UP

Procedure:

After 3 PNGs appear on the terminal, wait about 10 seconds or until 'F R1A01' or later version number appears on the display.

ENTER should put the FactoryTest software into Command mode. 'q' then ENTER takes it to Non-menu mode, then 'm' followed by ENTER should produce the test menu. If no response, turn power off then on and retry. If Boot/Loader comes up (> prompt), serially load Factory Test.

Troubleshooting information:

Check 5V at TP6 and 3.3V at TP5.

If no voltage, check hot swap controller U37. U32-2 (ON) should be 5V, Mate-detect A and B should both be grounded. U37-5 (FB) should be 1.3V. U37-6 (GATE) should be about 16V.

If 5V is not seen on U42-2, then 555 timer U40 may be holding the ON pin low except for momentary intervals every second or so.

There may be a problem in the serial port SMC1, which is used to interface to the test system through the diagnostic connector J8 on the front of the board. This is a normal serial port of the 860 processor. The J8 interface is RS232, which is converted to 3.3V levels to the processor. SMC1TX originates from U1 (not accessible) at 3.3V level and drives RS232 converter U36-17. U36-12 drives J8-2 at RS232 levels. Input from the terminal comes in at RS232 levels to J8-1, which is fed to U24-5 where it is converted to 3.3V levels at U24-18 and goes to SMC1RX on U1 (not accessible).

Check 29.4912 MHz oscillator Y2.

Check for wrong parts or misoriented parts.

Has PLD been programmed? Use FactoryTest Command mode command 'R PLD_ID ALL' to check PLD version.

9.4.2 SitePro Modem Board Tests From The 860

9.4.2.1 CODE RAM TEST

Procedure:

Execute FactoryTest test 4, subtest 2.

Troubleshooting information:

Failure indicates problem is with U2 on the Modem board or associated circuitry U17 and U18.

If Code RAM and DUAL PORT RAM test fail, there may be a bus problem. Test with a known good Modem board to isolate the problem to the Controller or the Modem.

9.4.2.2 DUAL PORT RAM TEST

Procedure:

Execute Factory Test test 4, subtest 3.

Troubleshooting information:

Failure indicates a problem communicating with U3 on the Modem Board.

IF MODEM BOARD IS BAD

Check the Dual Port RAM U3 and Code RAM U2

The processor should be held reset during these tests. U1-10 should be HI (3.3V) to reset.

IF CONTROLLER IS BAD

Check 14.7456MHz on J9-19.

Check Data bus activity on J9-1,2,3,4,33,34,35,36

Check address bus activity on J9-5 thru12, and 25 thru 32.

Check that DPR Chip Select is occurring on J9-15 during DPR test.

Check that Code RAM Chip Select is occurring on J9-14 during Code RAM test.

Check that RESET is HI (3.3V) on U1-10 during Code RAM test.

9.4.2.3 INTERRUPT FEATURE

Procedure:

Use FactoryTest test 4, subtest 1 to load 'DCTEST.HEX'. Then execute FactoryTest test 4, subtests 4 and 5.

Troubleshooting information:

Was 'DCTEST' loaded into the Modem daughter board?

Check DPR U3 on Modem Daughter Board. Pin 38 Interrupts the 80C323 on the Modem Board. Pin 43 interrupts the 860. This test is an interaction between the Modem Board and the Controller Board so testing with one known good board can isolate the problem.

9.4.3 Modem Board Tests Using Simon

9.4.3.1 LOAD SIMON

Procedure:

Use FactoryTest test 4, subtest 1 to load 'SIMON.HEX'.

Troubleshooting information:

If SIMON loads properly, you will hear a beep or see the SIMON turn-on banner appear on the terminal connected to 80C323 Port 0.

Failure to load code in the Modem board (applies to DCTEST also) could be due to problems with Code RAM U2 and associated logic U17 and U18. Processor U1 must be held reset (U1-10=3.3V) during a code load. It is unreset when ENTER is sent to Factory Test after a download.

9.4.3.2 TEST DPR FROM THE MODEM SIDE

Procedure:

Execute SIMON Command 'TMX 0-1FFD'.

Troubleshooting information:

Assuming SIMON loaded and is running, there must be a problem with DPR U3 or the Microprocessor (U1)interface to it. Note: Use terminal 2 for SIMON commands.

9.4.3.3 TEST MODEM DATA SRAM

Procedure:

Execute SIMON Command 'TMX 8000-FFFF'.

Troubleshooting information:

If SIMON is running, U4 is indicated.

9.4.3.4 MODEM BER TEST ON RF MODEM

Procedure:

This is the same test as the shelf RF loopback test. Execute SIMON Command BERDE-02=1. Correct result is no errors and checksum=027C11.

Troubleshooting information:

SIMON causes a data stream to be generated in RF Modem U9 at U9-21 (RFTXDAT). This data goes to the Controller Board on J2-30 where it enters the PLD at U27-122

(RFTXD). It exits on U27-38 (RFTXDAT), is buffered and inverted by U29F, entering on U29-13, exiting on U29-12. It exits the Board on J7-C23.

At the rear of the shelf, RFTXDAT is looped back into the Controller board on J7-C26 (RFRXDAT_FROM_SLICER). This signal is buffered and inverted by U29D, entering on U29-9, exiting on U29-8, which drives into the PLD U27-53. It exits the PLD on U27-99 (RFRXD). This goes to the Modem Board on J2-7. On the Modem Board, it goes to U9-19 completing the loop.

Refer to RF Loop Test Block Diagram in the instruction book.

This test may fail due to problems in the microprocessor U1 interface to the Modem IC U9. This includes 3V/5V converter U6, U21, U23, U16C and perhaps address decoder U5 or U16A. Many negative going interrupt pulses should be seen on U9-24. Check R11.

9.4.3.5 MODEM BER TEST ON PL MODEM

Procedure:

This is the same as the shelf PL loopback test. Reset the Modem Board. SIMON Commands are MDS1 then BERDE-01=1. Correct result is no errors and checksum=027C11.

Troubleshooting information:

After running the BER test on the RF Modem (above), SIMON code requires a reset before running the BER test on the Phone Line Modem. This can be accomplished by using FactoryTest to execute test 4, subtest 3 (Dual Port RAM test). This will reset the Processor then unreset it without affecting loaded code.

SIMON causes a data stream to be generated in PL Modem U10 at U10-21 (PLTXDAT). This data goes to the Controller Board on J2-9 where it enters the PLD at U27-31 (PLTXD). It exits on U27-23 (PLTXDAT), is buffered, inverted and converted to RS232 levels by U30, entering on U30-7, exiting on U30-2. It exits the Board on J7-B19.

Data is passed through the Rockwell Modem then, at the rear of the shelf, PLTXDAT is looped back through the Rockwell Modem and into the Controller board on J7-B21 (PLRXDAT). This signal is buffered, inverted and converted back to TTL levels by U30, entering on U30-9, exiting on U30-8, which drives into the PLD U27-25. It exits the PLD on U27-34 (PLRXD). This goes to the Modem Board on J2-29. On the Modem Board, it goes to U10-19 completing the loop.

Refer to PL Loop Test Block Diagram in the instruction book.

This test may fail due to problems in the microprocessor U1 interface to the Modem IC U10. This includes 3V/5V converter U6, U21, U23, U16C and perhaps address decoder U5 or U16A. Many negative going interrupt pulses should be seen on U10-24. Check R12

9.4.3.6 TEST LSDIN

Procedure:

Apply 100Hz 1VPP sine wave to J12-7. This should produce a 0 to 5V 100Hz square wave at Controller Board connector J7-C10. Observe 3VPP 100Hz square wave at U1-2 on the Modem Board.

Troubleshooting information:

LSDIN is input on J7-C10. It is buffered and inverted by U18D, entering on U18-9, exiting on U18-8. It enters the PLD on U27-106 and exits on U27-98 (LSIN). It goes to the Modem Board on J2-23. On the Modem board it is called LSRX and goes directly to the processor U1-2 which is Port 1.0.

9.4.3.7 I/O OUTPUTS TEST - GROUP D

Procedure:

The table below gives the required SIMON commands to exercise each of these 3 outputs. It also lists the point to monitor. Use small size easy ball clips to reach the B row of J7.

Table 22 - SIMON Commands

NAME	SIMON COMMAND LO	SIMON COMMAND HI	MONITOR POINT
WAL1	POR3=FF	POR3=CF	J7-B15
WAL2	POR3=FF	POR3=CF	J7-B16
HSACQCTL	POR1=FF	POR1=ED	J7-C8

Troubleshooting information:

This test checks the paths of 3 I/O signals which originate at the 80C323 Microprocessor on the Modem Board, go down to the Controller Board, then through the PLD, then through inverting buffers to the card edge. The paths are tabularized below.

Table 23 - I/O Signal Paths

NAME	ORIG	EXIT MODEM	ENTER PLD	EXIT PLD	ENTER BUF	EXIT BUF	J7 PIN	EXIT NAME
WAL1	U1-16	J2-16	U27-91	U27-81	U29-3	U29-4	J7-B15	WALSH1
WAL2	U1-17	J2-21	U27-90	U27-80	U29-5	U29-6	J7-B16	WALSH2
HSACQCTL	U1-6	J2-15	U27-86	U27-45	U34-13	U34-12	J7-C8	HSACQ

9.4.3.8 TEST LSDOUT

Procedure:

Issue FactoryTest Command Mode command ’w pld_ctrl 0x00’.

Monitor Controller Board pin J7-C9.

Issue SIMON command POR3=FF to make the pin go LO.

Issue SIMON command POR3=EF to make the pin go HI.

Troubleshooting information:

This test checks the path of signal LSDOUT. It uses the WAL1 signal tested above to generate a signal into the PLD. The signal exits the PLD at U27-110. It is buffered and inverted by U32C, entering on U32-5, exiting U32-6 which drives off the board at J7-C9.

9.4.3.9 ETHERNET TEST

Procedure:

Execute FactoryTest test 5, subtests 1 and 2.

Troubleshooting information:

The FEC is the 10/100 Base-T Ethernet port originating in the 860 MII port which interfaces to Network PHY device U5. U5 drives transformer T1 which drives off the board to Ethernet Port 0. Tx+ and Tx- are on pins J7-A2 and J7-A3. Rx+ and Rx- are on pins J7-A5 and J7-A6.

SCC1 is the 10 Base-T Ethernet port originating in the 860 SCC1 port which interfaces to Network PHY device U12. U12 drives transformer T2, which drives off the board to Ethernet Port 1. Tx+ and Tx- are on pins J7-A8 and J7-A9. Rx+ and Rx- are on pins J7-A11 and J7-A12.

Three tests are run on each Ethernet port.

The first test performs a loopback test entirely inside the 860 processor. It should never fail.

The second test performs a loopback test inside the PHY chip. Failure indicates a problem with the PHY chip or the connections from the 860 to the PHY.

The third test performs an external loopback test with the TX (+ and -) looped back to RX (+ and -) using a loopback plug on the rear of the shelf. These connections must be very short. If the first 2 tests pass, failure indicates problems with the transformer or the connections from the PHY to the transformer, or the loopback plug.

9.4.3.10 LED TEST

Procedure:

Execute FactoryTest test 6.

Troubleshooting information:

I2C bus may be shorted. Check that SDA and SDL are normally 5V and bursts of data and clock are seen when the test is run. Clock and data should show no appreciable rise or fall times at a sweep rate of 100us per division. If other I2C devices are working, then U15 is indicated.

9.4.3.11 DIPSWITCH TEST

Procedure:

Execute FactoryTest test 7.

Troubleshooting information:

If other I2C devices are working, then U26 is indicated, possibly pullup resistor pack RN12 or bad switch S2.

9.4.3.12 EEPROM LOAD TEST

Procedure:

Execute FactoryTest test 6, subtest 1.

Troubleshooting information:

If other I2C devices are working, then U14 is indicated.

9.4.3.13 DRAM TEST

Procedure:

Execute FactoryTest test 9.

Troubleshooting information:

Software is actually running out of DRAM. The test only checks that portion not being used by the program. This is a test of U2 and U7.

9.4.3.14 FLASH TEST

Procedure:

Execute FactoryTest test 10.

Troubleshooting information:

Test software is stored in the Flash memory so the test only checks that portion not holding code. This is a check of U10 and U11.

9.4.3.15 TEST SERIAL PORT QUART C

Procedure:

Connect terminal to J14C on the rear of the shelf. Set terminal for 9600 baud, N81. Type a few characters and observe characters echoed to terminal.

Troubleshooting information:

The QUART is U28. Its four serial ports are used for BSL0, BSL1, QUART PORT C, and QUART PORT D. If the other ports are working, the problem may be in the RS232 converter U36. RS232 level input comes on the Controller board at J7-A25, is fed to U36-8, converted to 3.3V levels at U36-21, to the QUART U28-25. The QUART should echo the characters out of TXC, U28-26, to U36-24, and it should appear at RS232 levels at U36-5 and J7-A26.

9.4.3.16 TEST SERIAL PORT QUART D

Procedure:

Connect terminal to J14D on the rear of the shelf. Set terminal for 9600 baud, N81. Type a few characters and observe characters echoed to terminal.

Troubleshooting information:

The receive path is J7-A27 to U36-9 at RS232 level, out U36-20 at 3.3V level, to QUART U28-27, echoed out U28-28 to U36-23, and out U36-6 to J7-A28 at RS232 level.

9.4.3.17 BSL TEST

Procedure:

Loop BSL0 to BSL1 and run FactoryTest test 11, subtest 1.

Troubleshooting information:

+12V must be present for the BSL circuits. Two separate tests are run; first BSL0 to BSL1 then BSL1 to BSL0.

Two ports of QUART U28 are used. Port A receives and transmits on BSL0. Port B receives and transmits on BSL1.

The path for the first test begins at QUART TXDA U28-6. This is inverted in U35A which drives FET driver Q4. BSL0 is looped to BSL1 at J4C and J4D on the rear of the shelf, so that signal appears at BSL1 input U23-3. This is inverted twice and converted to a 3.3V level by U23B and Q10, which drives QUART PORT B input U28-14.

The path for the second test begins at QUART TXDB U28-15. This is inverted in U35B, which drives FET driver Q3. BSL1 is looped to BSL0 at J4C and J4D on the rear of the shelf, so that signal appears at BSL0 input U23-1. This is inverted twice and converted to a 3.3V level by U23A and Q9, which drives QUART PORT A input U28-5.

9.4.3.18 TEST SCC2

Procedure:

Connect terminal to J14F on rear of shelf. Set terminal for 38.4kbd, N81. Type a few characters and observe characters echoed to terminal.

Troubleshooting information:

This is a normal serial port of the 860 processor. The card edge interface is RS232, which is converted to 3.3V levels to the processor. SCC2RX comes in to the Controller Board on J7-A19. This RS232 signal comes in to U24-7, gets converted to 3.3V levels at U24-16 and goes to SCC2RX on U1 (not accessible).

The 860 processor U1 (not accessible) echoes characters out SCC2TX at 3.3V level and drives RS232 converter U24-13. U24-10 drives out to the card edge (J7-A20) at RS232 levels.

9.4.3.19 TEST SCC3

Procedure:

Connect terminal to J14G on rear of shelf. Set terminal for 38.4kbd, N81. Type a few characters and observe characters echoed to terminal.

Troubleshooting information:

This is a normal serial port of the 860 processor. The card edge interface is RS232, which is converted to 3.3V levels to the processor. SCC3RX comes in to the Controller Board

on J7-A21. This RS232 signal comes in to U24-6, gets converted to 3.3V levels at U24-17 and goes to SCC3RX on U1 (not accessible).

The 860 processor U1 (not accessible) echoes characters out SCC3TX at 3.3V level and drives RS232 converter U24-14. U24-9 drives out to the card edge (J7-A22) at RS232 levels.

9.4.3.20 TEST SMC2

Procedure:

Connect terminal to J14H on rear of shelf. Set terminal for 38.4kbd, N81. Type a few characters and observe characters echoed to terminal.

Troubleshooting information:

This is a normal serial port of the 860 processor. The card edge interface is RS232, which is converted to 3.3V levels to the processor. SMC2TX originates from U1 (not accessible) at 3.3V level and drives RS232 converter U24-12. U24-11 drives out to the card edge at RS232 levels. The fixture loops TX to RX so the RS232 signal comes back into U24-8, gets converted to 3.3V levels at U24-15 and goes to SCC3RX on U1 (not accessible).

This is a normal serial port of the 860 processor. The card edge interface is RS232, which is converted to 3.3V levels to the processor. SMC2RX comes in to the Controller Board on J7-A17. This RS232 signal comes in to U24-8, gets converted to 3.3V levels at U24-15 and goes to SMC2RX on U1 (not accessible).

The 860 processor U1 (not accessible) echoes characters out SMC2TX at 3.3V level and drives RS232 converter U24-12. U24-11 drives out to the card edge (J7-A18) at RS232 levels.

9.4.3.21 I/O OUTPUTS TEST - GROUP A

Procedure:

To test each output, the FactoryTest Manual Mode Command is given to cause the monitor point to go high or low. Connect a 10K pullup resistor from the monitor point to 5V in order to see the result. J11 is on the rear of the shelf.

Table 24 - FactoryTest Manual Mode Commands

SIGNAL NAME	10K PULLUP REQUIRED	COMMAND HIGH	COMMAND LOW	MONITOR POINT
CPPTOUT	yes	W stn_ctrl 0x00	W stn_ctrl 0xFF	J11-6
TXCGDIS	yes	W stn_ctrl 0x00	W stn_ctrl 0xFF	J11-7
RPT_INH	yes	W stn_ctrl 0x00	W stn_ctrl 0xFF	J11-3
RPTKEY	yes	W stn_ctrl 0x00	W stn_ctrl 0xFF	J11-5
SPARE1	yes	W stn_ctrl 0x00	W stn_ctrl 0xFF	J11-1
SPARE2	yes	W stn_ctrl 0x00	W stn_ctrl 0xFF	J11-2

Troubleshooting information:

Each output in Group A is written to a PLD register by the 860 processor. Its path to the card edge is shown below. They all come out of the PLD, are buffered and go to a pin on J7.

Table 25 - I/O Output Group A Paths

I/O OUTPUTS GROUP A PATHS				
SIGNAL NAME	**PLD PIN**	**BUFFER IN**	**BUFFER OUT**	**J7 PIN**
CPPTOUT	28	U34-1	U34-2	J7-B13
TXCGDIS	70	U34-11	U34-10	J7-B2
RPT_INH	103	U34-9	U34-8	J7-A13
RPTKEY	111	U33-11	U33-10	J7-B10
SPARE1	100	U34-3	U34-4	J7-A7
SPARE2	101	U33-13	U33-12	J7-A10

9.4.3.22 I/O OUTPUTS TEST - GROUP B

Procedure:

To test each output, the FactoryTest Manual Mode Command is given to cause the monitor point to go high or low. Some outputs will require a 10K pullup resistor to 5V to be seen.

Table 26 - FactoryTest Manual Mode Commands (Group B)

SIGNAL NAME	10K PULLUP REQUIRED	COMMAND HIGH	COMMAND LOW	MONITOR POINT
SYNTH_CLK	yes	W synth_ctrl 0x00	W synth_ctrl 0xFF	J12-13
SYNTH_DATA	no	W synth_ctrl 0x00	W synth_ctrl 0xFF	J12-14
SYNTH_LD_EN	yes	W synth_ctrl 0x00	W synth_ctrl 0xFF	J12-15
EMSQTOAV	no	W voter_ctrl 0xFF	W voter_ctrl 0x00	J12-17
RX_MUTE	no	W rx_ctrl 0x00	W rx_ctrl 0xFF	J12-11
REMRPT	yes	W rx_ctrl 0x00	W rx_ctrl 0xFF	J12-3

SYNTH_DATA is internally pulled to +12V.

With no load, EMSQTOAV will pull up to +12V.

RX_MUTE will pull to +8V.

Troubleshooting information:

Each output in Group B is written to a PLD register by the 860 processor. Its path to the card edge is shown below. They all come out of the PLD, are buffered and inverted and go to a pin on J7.

Table 27 - I/O Outputs Group B Paths

I/O OUTPUTS GROUP B PATHS				
SIGNAL NAME	PLD PIN	BUFFER IN	BUFFER OUT	J7 PIN
SYNTH_CLK	87	U33-5	U33-6	J7-C4
SYNTH_DATA	88	U33-3	U33-4	J7-C5
SYNTH_LD_EN	102	U35-13	U35-12	J7-C6
EMSQTOAV	97	U35-5	U35-6	J7-C3
RX_MUTE	112	U33-9	U33-8	J7-B9
REMRPT	96	U35-11	U35-10	J7-B6

Note that EMSQTOAV goes through an additional transistor Q8.

Note that RX_MUTE goes through an additional transistor Q1.

9.4.3.23 I/O OUTPUTS TEST - GROUP C

Procedure:

To test each output, the FactoryTest Manual Mode Command is given to cause the monitor point to go high or low. Some outputs will require a 10K pullup resistor to 5V to be seen.

Table 28 - FactoryTest Manual Mode Commands (Group C)

SIGNAL NAME	10K PULLUP REQUIRED	COMMAND HIGH	COMMAND LOW	MONITOR POINT
STNPTT	Yes	W rx_ctrl 0x00	W rx_ctrl 0x0C	J12-2
A/DMODCTL	No	W rx_ctrl 0x00	W rx_ctrl 0x0C	J12-4

Troubleshooting information:

Each output in Group C is written to a PLD register by the 860 processor. Its path to the card edge is shown below. They both come out of the PLD, are buffered and inverted and go to a pin on J7.

Table 29 - I/O Outputs Group C Paths

I/O OUTPUTS GROUP C PATHS				
SIGNAL NAME	PLD PIN	BUFFER IN	BUFFER OUT	J7 PIN
STNPTT	71	U34-5	U34-6	J7-A14
A/DMODCTL	72	U29-11	U29-10	J7-A16

9.4.3.24 I/O INPUTS TEST - GROUP A

Procedure:

To test inputs, it is necessary to apply 5V (through a 10K resistor) or ground to the input point. Then execute a FactoryTest Command Mode READ command. The table shows the command and expected result for both 5V input and ground input. The READ command presents values in hex. Convert the hex to binary to see the individual bits. 'x' means 'don't care'

Table 30 - FactoryTest Command Mode READ Commands

SIGNAL NAME	INPUT POINT	COMMAND	5V RESULT	GROUND RESULT
SYNTH_LOCK_DET	J12-12	R portb all	xxxxxxx0	xxxxxxx1
SIMULCAST_INH	J12-18	R portb all	xxxxxx0x	xxxxxx1x
REM_AUDIO_PRESENT	J12-10	R portb all	xxxxx0xx	xxxxx1xx
PAFAIL	J12-6	R portb all	xxxx0xxx	xxxx1xxx
RUSIN	J12-9	R portb all	xxx0xxxx	xxx1xxxx
BYPASS	J13-20	R portb all	0xxxxxxx	1xxxxxxx

The relays on the Analog board will operate when BYPASS is grounded.

Troubleshooting information:

Each of the signals in Inputs Group A originates off board as a TTL level signal, then goes through a buffer and then to the PLD U27. The PLD interfaces to the 860 via the processor bus. Levels into the PLD are 0 and 5V.

Table 31 - Group A I/O Input Paths

I/O INPUTS GROUP A PATHS				
SIGNAL NAME	J7 PIN	BUFFER IN	BUFFER OUT	PLD PIN
SYNTH_LOCK_DET	J7-C7	U23-9	U23-8	118
SIMULCAST_INH	J7-B12	U23-11	U23-10	117
REM_AUDIO_PRESENT	J7-B14	U18-1	U18-2	109
PAFAIL	J7-B4	U18-11	U18-10	78
RUSIN	J7-B8	U29-1	U29-2	75
BYPASS	J7-B5	U23-13	U23-12	116

9.4.3.25 I/O INPUTS TEST - GROUP B

Procedure:

To test inputs, it is necessary to apply 5V (in some cases, open) then ground to the input point and then execute some FactoryTest manual mode commands. Results for EXTPTTIN, EXTADIN, and EXT150IN are voltages measured on the given pin. Results

for the other 3 inputs are read by the software by executing a FactoryTest Command Mode READ command. The table shows the commands and expected result for both 5V input and ground input.

Table 32 - READ Commands and Expected Results

SIGNAL NAME	INPUT POINT	COMMAND	MONITOR POINT	5V RESULT	GROUND RESULT
EXTPTTIN	J13-6	W pld_ctrl 0x00 W rx_ctrl 0x80	J12-2 Requires pullup	5V see note 1	0V
EXTADIN	J13-5	W pld_ctrl 0x00 W rx_ctrl 0x80	J12-4	5V see note 1	0V
EXT150IN	See note 2	W pld_ctrl 0x00 W rx_ctrl 0x80	J7-C9 (Lsdout)	5V	0V
RCVNG_FROM_AV	J7-C2	R voter_input all	-	Xxxxxxx0	Xxxxxxx1
CAS	J11-8	R voter_input all	-	Xxx0xxxx	Xxx1xxxx
CGMON	J11-4	R voter_input all	-	Xx0xxxxx	Xx1xxxxx

1. For EXTPTTIN and EXTADIN, just leave input open for'5V' result.
2. For EXT150IN, for '5V result', apply ground to J13-15 and 5V through a 10K resistor to J13-16. For 'Ground Result', swap inputs.
3. RCVNG_FROM_AV is not used in the shelf. Apply inputs to the card connector J7.

Troubleshooting information:

Each input in Group B originates externally as a TTL level signal. It is buffered and inverted and fed into the PLD. There, it can be read by the 860 processor. Its path from the card edge to the PLD is shown below.

Table 33 - I/O Input Group B Paths

I/O INPUTS GROUP B PATHS				
SIGNAL NAME	ORIGIN	BUFFER IN	BUFFER OUT	PLD PIN
EXTPTTIN	J7-C11	U22-3	U22-4	67
EXTADIN	J7-C12	U22-5	U22-6	60
EXT150IN	J7-C13	U22-9	U22-8	68
RCVNG_FROM_AV	J7-C2	U23-5	U23-6	119
CAS	J7-B7	U18-3	U18-4	108
CGMON	J7-B3	U18-5	U18-6	107

9.4.3.26 TEST PLRTS AND PLCTS, VDIRTS AND VDICTS

Procedure:

Jumper PLRTS to PLCTS, J14A-6 to J14A-7 on the shelf rear.

Jumper VDIRTS to VDICTS, J14B-6 to J14B-7 on the shelf rear.

Then execute FactoryTest test 16.

Troubleshooting information:

Upon command of the 860 processor, PLRTS is generated in the PLD and exits U27-65. It is buffered, inverted and converted to RS232 levels by U13, entering U13-11, exiting U13-14. It exits the board on J7-B18.

PLRTS is looped back to the Controller board into PLCTS on J7-B17. It is converted to TTL, buffered and inverted by U13, entering U13-13 and exiting U13-12. It enters the PLD on U27-83 where it can be read by the 860 processor.

Upon command of the 860 processor, VDIRTS is generated in the PLD and exits U27-63. It is buffered, inverted and converted to RS232 levels by U13, entering U13-10, exiting U13-7. It exits the board on J7-C18.

VDIRTS is looped back to the Controller board into VDICTS on J7-C17. It is converted to TTL, buffered and inverted by U13, entering U13-8 and exiting U13-9. It enters the PLD on U27-82 where it can be read by the 860 processor.

9.4.3.27 PHASE LOCKED LOOP TEST AND TXC_MISSING_ALARM TEST

Procedure:

Use a Function Generator to produce a 0V to 5V 9600Hz square wave. Apply this across J13-13 & 14 (9.6REF+ and -), with the ground side connected to J13-14.

Execute FactoryTest test 14, subtest 1. Ignore the first line of the on screen instructions since the input is applied differently. Use a dual trace scope as described to check for two signals in phase. RFTXCLK is also seen at J11-14.

Troubleshooting information:

This test uses PLL IC U16 to phase lock the RFTXCLK used by the RF Modem U9 on the SitePro Modem Board to an external reference signal 9.6REFIN. The PLL chip generates an 11.0592 MHz clock slaved to the external reference. In the PLD, this clock is switched to the Modem board instead of the 11.0592 MHz. oscillator clock. Modem Board IC U9 divides the 11.0592 MHz back down to 9.6kHz (RFTXCLK) which is phased locked by the PLL U16. Both the reference and the feedback signals are switched to the PLL inside the PLD.

A Modem board must be present for this test and it must not be held reset. The Modem board is normally held reset by the Controller until it is explicitly unreset. It can be unreset by loading code such as SIMON to it. It can also be unreset by executing Factory Test 4, subtest 3, (Test Dual Port RAM).

9.6REFIN enters the Controller board at TTL levels on J7-C15. It is buffered and inverted by U22F, entering in U22-13, exiting on U22-12. It enters the PLD on U27-69.

RFTXCLK is derived from the 11.0592 MHz clock on the Modem Board by U9, exiting on U9-27. It is routed to the Controller board through J2-8 (Modem board) which connects to Controller Board J2-8. It enters the PLD on U27-128.

If the loop fails to lock, one or both signals 9.6REFIN or RFTXCLK may not be getting to the PLL U16. U16 or some of the associated components may be wrong, misoriented

or missing. Use a known good Modem board. Check for 11.0592 MHz clock at Modem Board U9-16.

Procedure:

Instead of following the on screen directions, observe TXC_MISSING_ALARM at J13-18. The test requires an external pullup resistor.

Remove the 9.6REF signal. TXC_MISSING_ALARM should go high.

Troubleshooting information:

TXC_MISSING_ALARM is generated inside the PLD if 9.6REFIN is missing. 9.6REFIN must get to the PLD via the path described above. The TXC_MISSING_ALARM signal exits the PLD on U27-62. It is buffered and inverted by U35D, entering on U35-9, exiting U35-8.

9.4.3.28 TEST PLTXCLK

Procedure:

Observe PLTXCLK (9600Hz, RS232) at J14A-4 on the rear of the shelf.

Troubleshooting information:

PLTXCLK is generated on the Modem Board at U10-27, and is inverted by U24 before exiting the Modem Board on J2-28. It enters the PLD on U27-32. It is also buffered, inverted, and converted to RS232 levels by U30, entering at U30-6, exiting U30-3. It exits the Controller Board on J7-B20.

A working Modem board must be present and not reset for this test.

9.4.3.29 TEST VDITXCLK

Procedure:

Observe VDITXCLK (9600Hz, RS232) at J14B-4 on the rear of the shelf.

Troubleshooting information:

This test checks the path of VDITXCLK. It is generated on the Modem Board at U11-27, and is inverted by U25 before exiting the Modem Board on J2-11. It is buffered, inverted, and converted to RS232 levels by U30, entering at U30-21, exiting U30-28. It exits the Controller Board on J7-C20.

A working Modem board must be present and not reset for this test.

9.4.3.30 FSL OUTPUT TEST

Procedure:

Execute FactoryTest test 15

Observe the FSL output at J4C-4 on the rear of the shelf.

Troubleshooting information:

The FSL signal is a series of negative going 12V to 0V pulses occurring every 30ms and 2.5ms wide.

The FSL output signal is generated in the PLD using RFTXCLK (tested above) from the

Modem Board. A working Modem board must be present and not reset for this test.

The FSL signal exits the PLD at U27-113. It is buffered and inverted by U33, entering at U33-1, exiting U33-2 which drives FET driver Q2. The FET drives a +12V to 0V signal to J7-C30. The FSL output is capable of driving a 50 ohm load resistor pulled to +12V.

9.4.3.31 EEPROM VERIFY TEST

Procedure:

After turning power off for a few seconds, then back on, execute FactoryTest test 8, subtest 2.

Troubleshooting information:

If other I2C devices (LEDs, dipswitch) are working, failure of this test indicates a problem with U14. This test is run after power is turned off and back on. FactoryTest test 8, subtest 1 must have been run previously. The EEPROM should retain its data with power off.

9.4.4 Analog Board

This guide assumes the Analog board is in a SitePro shelf on a bench, not connected to a station, but with +13.8VDC power applied to J7 of the shelf. It is also assumed that 'FactoryTest' software resides on the Controller board to provide control of the Analog board. Modem board test program 'SIMON' is also needed for some of the tests. Two Terminal emulators are needed. See shelf test.

This is **not** a detailed test procedure. It is intended for use in service shops by technicians having a high degree of expertise in troubleshooting electronic circuitry.

9.4.4.1 REFERENCE DOCUMENTS

WD-CB101070V1 - Schematic Diagram

TS-CB101070V1 - Test Spec

AD-CB101070V1 - Assembly Drawing

Block diagram of Analog Board (Figure 11 - Analog Board Block Diagram)

9.4.4.2 TEST 2 - VOLTAGES

Measure +5V at C54(+). Measure +12V at C57(+). Measure –12V at C59(-). Measure –5V at TP31.

If -5V is wrong voltage or missing, check U2.

9.4.4.3 TEST 3 - CLOCK FREQUENCY

Clocks are derived from a 400kHz oscillator Y1, U32C and U32D. Check for 400 kHz at TP10. U3 divides the 400 kHz down to 25 kHz at TP11 and 3.125 kHz at TP12.

9.4.4.4 TEST 4 - SLICER

Input signal, 1000Hz sine wave at 1VPP, is applied to VOLSQHI and is buffered by U15A. The same signal should be seen at TP13. The signal is then sliced by comparator U33A and a squared wave (0 to 5V) should be seen at RFRXDAT. Bias on U33-2 is around 2.5V. Problems with U31 can affect the bias.

9.4.4.5 TEST 5 - LOW SPEED DECODE FILTER

Sine wave input 100Hz at 1VPP at VOLSQHI is buffered by U15A (seen at TP13), amplified about 2:1 in U15B (seen at TP15), passes through high pass filter U16 (seen at TP16), then through low pass filter U14 (seen at TP17), through amplifier (gain = 2) U28A (seen at TP18). The frequency response is measured at TP18 before going to nonlinear circuits. U12B is a slicer, which converts the waveform to a square signal at TP14. Q1 interfaces the squared waveform to a microprocessor on another board. Note that a 10K pullup to +5V is needed on LSIN to see the 0 to 5V output. This resistor is on the Controller board.

The LS Decode filter frequency response (shown below) is entirely determined by U16 (rolloff below 50Hz) and U14 (rolloff above 250Hz).

Frequency	Output
100 Hz	0 db (ref)
50 Hz	-3 db ± 1db
18 Hz	-35 db ±- 3db
250 Hz	-0 db ±- 1db
300 Hz	<-40db

With 1V P-P 100Hz in to VOLSQHI, the levels at various test points are shown in the table below.

Table 34 - Test Point Levels

TEST POINT	VOLTAGE	SIGNAL TYPE
TP13	1 V P-P (2.5VDC bias)	Sine
TP15	2.2V P-P	Sine
TP16	2.2V P-P	Sine
TP17	2.2V P-P	Sine
TP18	4.4V P-P	Sine
TP14	12.6 V P-P (+0.6 to –12V)	Squared
LSIN w 10K pullup	5V P-P (0 to 5V)	Squared

9.4.4.6 TEST 6 - LOW SPEED ENCODE FILTER

In the shelf, signals cannot be injected directly to the encode filter. One method of driving the filter is to use the shelf EXT 150HZ input. Connect a 100Hz 1Vp-p square wave signal **across** 150HZ+ to 150HZ- (J13-15 to 16). Make necessary PLD connections with the commands:

W PLD_CTRL 0X00

W RX_CTRL 0X80

Configure the Analog board to use the 150HZ input with the commands

SI2C 4C 01 02

WI2C 10 00

150Hz input is selected by mux U22 which is controlled by LSCTL. This signal is derived from I2C I/O expander U4 (TP30) and must be logic 1 (5V) to select the 150HZ input.

The signal then passes through amplifier U19A where it is reduced in level by about a factor of 4 as seen at TP23. It then goes through buffer U19B (seen at TP22). Then through low pass filter U20 (seen at TP21) then through final amplifier/buffer U17A. Filtered output is seen at LSDTX.

Frequency response at LSDTX is entirely determined by U20 and associated components and by the 25kHz clock.

Table 35 - Frequency Response at LSDTX

FREQUENCY	RESPONSE
100 Hz (ref)	0 dB
200 Hz	-3 dB
250 Hz	-4 dB
300 Hz	< -40 dB

With 100Hz 5Vp-p square wave into 150HZ input (J1-B19), levels through the circuit are shown in the table below.

Table 36 - Circuit Levels

TEST POINT	VOLTAGE	SIGNAL TYPE
TP23	1 VP-P	Square
TP22	1 VP_P	Rounded Square
TP21	1.25VP-P	Sine
LSDTX	4.4VP-P (bias may vary)	Sine

9.4.4.7 TEST 8 - A/D CONVERTER

The A/D converter U23 is an I2C device with slave address 9E hex. If other I2C devices are working, then U23 is the only IC involved in this test. Apply DC levels between 0V and 5V to J12-1 (PA_SENSE) and read appropriate digitized results.

SI2C 9E 02 01

WI2C 00 01

RI2C 00 01 (second byte is the result)

9.4.4.8 TEST 10 - 9600 BAUD WIDE BAND HS FILTER

With the Analog board in the shelf, external signals cannot be applied directly to the High Speed filter sections. Data can be generated by the RF Modem to produce a signal through the filters. If response problems are suspected, inspect for broken, wrong, or unsoldered components around the appropriate section of the ‘Quad Op Amp’ circuitry. The response is entirely determined by this section.

Two terminal emulators are required. Refer to the Shelf test. Load SIMON into the Modem Board.

Select the filter with I^2C commands

SI2C 4C 01 02

WI2C 00 00 (for filter 0)

WI2C 01 00 (for filter 1) Etc.

Set digital pot level with I^2C commands

SI2C 50 01 00

WI2C A9 50 (for pot level of 50 hex)

The command 'W RX_CTRL 0X00' may also be needed to set up connections in the PLD.

Run the RF BER test as described in the shelf test to produce data through the High Speed filters.

Data is coupled to RFTXDAT (J1-A10), is buffered by U6A (seen at TP1) then is fed to five separate filters.

One of the filters is selected by mux U7, which is controlled by three I2C select lines HS_FILTER_SEL0, 1, and 2. These three select lines are outputs of I2C I/O expander U4. The three filter select lines can be seen at TP19, TP24, and TP25. Note that if input 6, 7, or 8 is selected, no output will be present.

If all three select lines are logic 0, then filter 0 (9600 Baud Wide Band) is selected.

The mux output goes to digital pot U8, which is also an I2C device and is set to a value of 50 (hex) for this test. Signal then passes through amplifier U6B (seen at TP9), then through output mux U9 to output MOD (J1-A12). A scope will show the eye pattern at TP9 or MOD.

U9 is controlled by select line MODCTL which is derived from I2C I/O expander U4 (TP28). MODCTL = 0 selects the path from the filters. Control of this bit is included above in the filter selection command.

Typical signal levels are shown below for High Speed data input from the RF Modem. Levels are also shown at TP9 when each of the other four filters is selected.

Table 37 - High Speed Data Signal Levels

TEST POINT	VOLTAGE
TP1	5V pp
TP9 - filter 0	1.1vrms
MOD	1.1vrms
TP9 - filter 1	0.9vrms
TP9 - filter 2	0.95vrms
TP9 - filter 3	0.8vrms
TP9 - filter 4	0.9vrms
TP9 – filter 5, 6, 7	0

9.4.4.9 TEST 11 - 9600 BAUD WIDE BAND ETSI HS FILTER

Same as test 10 except filter 1 (9600 Baud Wide Band ETSI) is selected by mux U7. HS_FILTER_SEL0 is logic 1 and the other two are logic 0. See test 10 for levels.

9.4.4.10 TEST 12 - 4800 BAUD NARROW BAND HS FILTER

Same as test 10 except filter 2 (4800 Baud Narrow Band) is selected by mux U7. HS_FILTER_SEL1 is logic 1 and the other two are logic 0. See test 10 for levels.

9.4.4.11 TEST 13 - 4800 BAUD NARROW BAND ETSI HS FILTER

Same as test 10 except filter 3 (4800 Baud Narrow Band ETSI) is selected by mux U7. HS_FILTER_SEL2 is logic 0 and the other two are logic 1. See test 10 for levels.

9.4.4.12 TEST 14 - 9600 BAUD NARROW BAND HS FILTER

Same as test 10 except filter 4 (9600 Baud Narrow Band) is selected by mux U7. HS_FILTER_SEL2 is logic 1 and the other two are logic 0. See test 10 for levels.

9.4.4.13 TEST 15 - I^2C POT

This test checks I^2C pot U8 at various settings. If High Speed filter tests have passed, then U8 is the only IC involved in this test. The path is set up just as in test 10 and several pot settings are checked at the output MOD. Failure means U8 is not responding to I2C commands.

I^2C commands:

SI2C 50 01 00

WI2C A9 XX (XX can be from 00 to FF hex)

9.4.4.14 TEST 16 - ANALOG AUDIO PATH

This test is similar to test 10 in that the path is set up exactly like test 10 with the same input and output. The output mux is then switched to the ANALOG_AUDIO input.

SI2C 4C 02 01

WI2C 40 00

Output at MOD should drop to 0V since it is unconnected. Applying a signal to ANALOG_AUDIO (J12-20) should then produce an output at MOD.

If tests 10-14 have passed and this test fails, U9 is suspected.

9.4.4.15 TEST 17 - RS232 TO RS485 CONVERSION OF PLTXDAT

Note: The remaining Analog board tests check circuitry that is only used in Simulcast Systems.

A 9600 baud RS232 level signal is connected to PLTXDAT in the shelf. U24 converts it to TTL at U24-12. This signal is fed to RS485 converter U25 at U25-1. Connect a 100 ohm load across PLTXDAT+ to PLTXDAT-. A differential signal of several volts should be seen across PLTXDAT- to PLTXDAT+ (J13-7 to 8).

Generate the data signal with the SIMON commands below after resetting the Modem board.

MDS1

BERDE-0=10

9.4.4.16 TEST 18 - RS232 TO RS485 CONVERSION OF PLTXCLK

In the shelf, a 9600Hz RS232 level clock is always present at PLTXCLK. U24 converts it to TTL at U24-9. This signal is fed to RS485 converter U25 at U25-7. Connect a 100 ohm load across PLTXCLK+ to PLTXCLK-.A differential signal of several volts should be seen across PLTXCLK- to PLTXCLK+ (J13-9 to 10).

9.4.4.17 TEST 19 - RS485 TO TTL CONVERSION OF 150HZ

A 9600Hz differential signal is fed into converter U26 across inputs 150HZ+ and 150Hz-. A single ended TTL level signal should appear at EXT 150 HZ (J1-C20). The differential output of Test 18 is an appropriate input for this test.

9.4.4.18 TEST 20 - RS485 TO TTL CONVERSION OF 9.6_DATA

A 9600Hz differential signal is fed into converter U26 across inputs 9.6 DATA+ and 9.6 DATA-. A single ended TTL level signal should appear at EXT 9.6 DATA (J1-C16). The differential output of Test 18 is an appropriate input for this test.

9.4.4.19 TEST 21 - RS485 TO TTL CONVERSION OF 9.6_REF

A 9600Hz differential signal is fed into converter U26 across inputs 9.6 REF+ and 9.6 REF-. A single ended TTL level signal should appear at EXT 9.6 REF (J1-C12). The differential output of Test 18 is an appropriate input for this test.

9.4.4.20 TEST 22 - RELAY CONTINUITY

Relay K1 and K2 contacts are checked for continuity in the rest state. Then signal BYPASS is grounded to switch the relays ON and continuity is checked in the ON state. U27 is the driver that switches voltage to the relay coils.

With no input connected to BYPASS (J1-C29), continuity should exist between the listed pins. Pins listed are at the Analog Board edge J1. These signals are also present on J13.

RX_AUDIO_L to RXV_R (C22 to C23)

TX_AUDIO_L to TXV_R (C21 to C24)

RX_AUDIO_H to RXV_T (C28 to C25)

TX_AUDIO_H to TXV_T (C27 to C26)

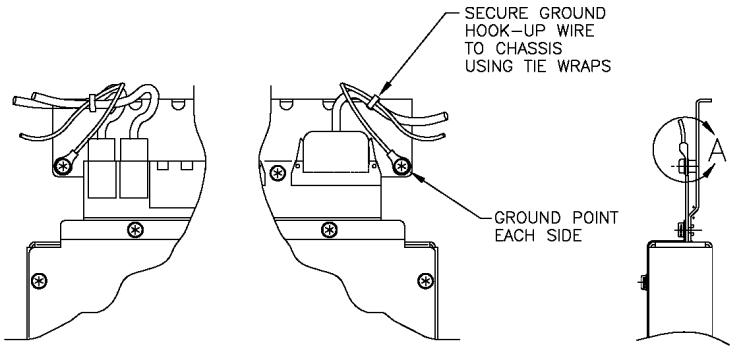
Ground BYPASS (J1-C29). Continuity should now exist between these listed pins.

RX_AUDIO_L to TX_AUDIO_L (C22 to C21)

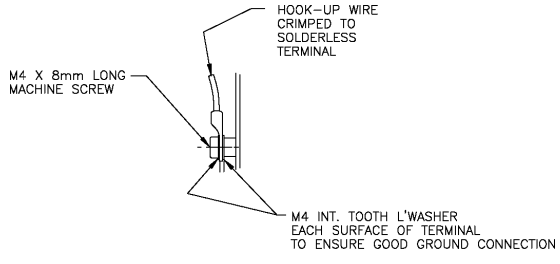
RX_AUDIO_H to TX_AUDIO_H (C28 to C27)

10.0 LIGHTNING PROTECTION GROUNDING

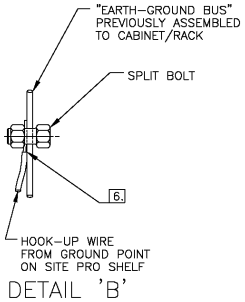
Maximum lightning protection is achieved when the SitePro Lightning-Protection Grounding Kit 344A4500G2 is installed. This kit is normally installed at the factory for all trunking applications. The following procedure summarizes the installation process.



TOP VIEW
OF SITE PRO SHELF



DETAIL 'A'



DETAIL 'B'

SHOWING TERMINATION OF HOOK–UP WIRE FROM GROUND POINTS ON THE SITE PRO SHELF TO THE "EARTH–GROUND BUS" PREVIOUSLY ASSEMBLED TO THE CABINET/RACK

(2) INSTRUCTIONS FOR INSTALLATING THE SITE PRO LIGHTNING PROTECTION KIT IN THE MASTR III 69in. 83in CABINET OR 86in OPEN RACK

OVERVIEW:
THIS DOCUMENT PROVIDES INSTRUCTIONS FOR INSTALLATION OF THE SITE PRO LIGHTNING PROTECTION OPTION BY ADHERING TO THE FOLLOWING STEPS USING MATERIAL LISTED IN HARDWARE KIT PL344A4500G2

STEPS:

1. CUT THE 4ft. LENGTH OF BLACK HOOK–UP WIRE INTO TWO 2ft. SECTIONS.
2. STRIP & TIN 1/2in. OF ONE END OF EACH OF THE 2ft. SECTIONS OF HOOK–UP WIRE.
3. CRIMP THE SOLDERLESS TERMINALS ON THE ENDS PREPARED IN STEPS 1 & 2
4. STRIP & TIN 1in. OF THE REMAINING END OF EACH OF THE TWO SECTIONS.
5. CONNECT THE SOLDERLESS TERMINALS TO THE PRESSED–IN SPACERS ON EACH SIDE OF THE SITE PRO SHELF. A LOCKWASHER IS REQUIRED ON BOTH SURFACES OF THE SOLDERLESS TERMINAL AS SHOWN IN DETAIL 'A'
6. WHEN THE SITE PRO SHELF IS ASSEMBLED IN THE CABINET/RACK, CONNECT THE OTHER END OF THE HOOK–UP WIRES TO A CONVENIENT PLACE ON THE "EARTH–GROUND BUS WIRE" PREVIOUSLY ASSEMBLED USING THE SPLIT BOLT. SEE DETAIL 'B'

Continued

NOTE

In order to be effective, the Cabinet Grounding Strap must be strapped to the building and/or earth ground.

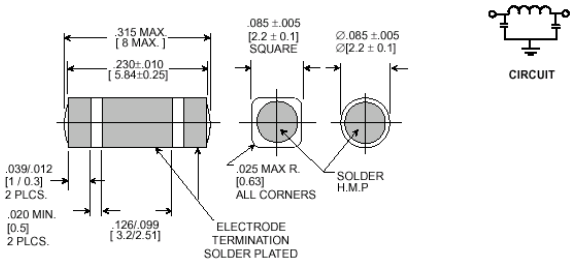
LIGHTING PROTECTION KIT 344A4500G2

ITEM NUMBER	PART NUMBER	DESCRIPTION
1		
2		
3	19B209260P1	Terminals: Solderless
4		
5	19A116850P10	Wire: Stranded
6	344A4060P1	Connector: Split Bolt
7		
8	19A700032P7	Washer: M4 Internal Tooth
9	19A702364P508	Screw, M4 x 8
10	19J706152P5	Strap: Retention

11.0 PARTS LIST

SitePro Controller SHELF ASSEMBLY
EA101209V1

SYMBOL	PART NUMBER	DESCRIPTION
1	MA101080V1	Chassis Assembly.
2	19A116552P3	Clamp, Cable.
3	FM101081V1	Cover.
4	19A702381P608	Screw, Thread Form, TORX, M4 x 8mm.
5	19A701312P6	Flat washer, M4.
6	19A702364P508	Screw, Machine, TORX, M4X8mm.
7	19A700032P7	Lock washer, Internal Tooth, M4.
8	FM101231V1	Spacer Plate, Shelf Door.
9	FM101232V1	Lens keeper, Door.
10	AG101229V22	EMI Shielding Gasket, 22 Fingers.
11	AG101229V5	EMI Shielding Gasket, 5 Fingers.
12	AG101230V1	Lens, EMI Shielding.
13	19A700032P3	Lock washer, Internal Tooth, M2.5.
14	19A700034P3	Nut, M2.5 X 0.45.
15	NP101233V1	Rear Label.
16	FM101083V1	Support, Front.
A1	**CB101073V1**	**INTERCONNECT BOARD**
		- - - - CAPACITORS - - - -
C1 and C2		470pF, 2KV: sim to Arco MC1808X471KN202.
		- - - - JACKS - - - -
J1 thru J3		DIN 96_ABC-P: sim to AMP 650895-4.
J4		RJ11_MULT (2 x 2): sim Stewart SS-7368H22-NF.
J5 thru J6		CON10: sim to Stewart SS-7188S-A-NF.
J7	19A116659P173	CONN PWR 4-R.
J8	19A116659P101	CONN PWR 3-P: sim to Molex 26-60-5030.
J9	19A116659P105	CONN RCPT 6: sim to Molex 26-60-5060.
J10	19A704852P30	CONN RCPT 4.
J11		HEADER 20: sim to AMP 102160-4.
J12		CON24: sim to AMP 102160-5.
J13		HEADER 26: sim to AMP 102160-6.
J14		RJ45_MULT ((2 x 6): sim to Stewart SS-73100-070.

SYMBOL	PART NUMBER	DESCRIPTION
		- - - - RESISTORS - - - -
R1 thru R4	REP_623_642/75	75 Ohms, 1%, 0.63W.
		- - - - TEST POINTS - - - -
TP3 thru TP7		Test Points: sim to Component Corp. TP-107-01.
		- - - - Pi FILTERS - - - -
U1 thru U29		Capacitor: 100pF, 100WVDC@125º C, +80%/-20%: sim to Tusonix 4700 006. **4700 SERIES** 
A2	**CB101069V1**	**CONTROLLER BOARD**
		- - - - BATTERY - - - -
BT1		Coin: 3V. 165 mAh: Sim to Panasonic BR2325-1HM or RAYOVAC BR2325T2.
		- - - - CAPACITORS - - - -
C1	RJE584320/1	Tantalum: 1.0µF, 20V ±20%.
C2 thru C11	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C12	RJE584320/1	Tantalum: 1.0µF, 20V ±20%.
C13	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C14		Ceramic: 470pF, 2kV ±20%: sim to MURATA GRM432X7R471KAL.
C15 thru C30	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C31		Ceramic: 470pF, 2kV ±20%: sim to MURATA GRM432X7R471KAL.
C32 thru C38	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C39	RJE584320/1	Tantalum: 1.0µF, 20V ±20%.
C40 and C41	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C42	RJE584320/1	Tantalum: 1.0µF, 20V ±20%.

SYMBOL	PART NUMBER	DESCRIPTION
C43 thru C45	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C46	RJE584320/1	Tantalum: 1.0µF, 20V ±20%.
C47 and C48	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C49	19A702061P13	Ceramic: 10pF, 100V ±10%.
C50 thru C56	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C57	RJE5843208/1	Tantalum: 10µF, 16V±20%.
C58 thru C62	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C63	19A702061P13	Ceramic: 10pF, 100V ±10%.
C64	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C65	19A702061P61	Ceramic: 100pF, 100V±10%.
C66	19A702061P57	82pF
C67	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C68	RJC4643033/82	Ceramic: 820pF, 25V±10%.
C69 thru C73	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C74	RJE584320/1	Tantalum: 1.0µF, 20V ±20%.
C75 thru C92	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C93	RJC4643034/1	Ceramic: 0.001µF, 25V ±10%.
C94 thru C95	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C96 and C97	RJE5843208/1	Tantalum: 10µF, 16V±20%.
C98 and C99	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C100	RJE584320/1	Tantalum: 1.0µF, 20V ±20%.
C101 thru C105	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C106	RJC4643034/1	Ceramic: 0.001µF, 25V ±10%.

SYMBOL	PART NUMBER	DESCRIPTION
C107 thru C110	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C111	RJC4643034/1	Ceramic: 0.001µF, 25V ±10%.
C112 thru C114	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C115	19A702052P37	Ceramic: 0.033µF, 25V ±10%.
C116	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
C117		Tantalum: 10 µF, 16V, low profile, ±20%: sim to AVX TAJT106M010.
C118 thru C120	19A702052P33	Ceramic: 0.1µF, 25V ±10%.
		- - - - DIODES - - - -
D1 thru D4		LED: Red, Thru-hole, RT ANGLE: sim to HLMP1301-A1.
D5		LED: Green, Thru-hole, RT ANGLE: sim to HLMP1503-A1.
D6 and D7		LED: Yellow, sim to Citizen 1206: sim to Citizen CL-150Y.
D8		LED: Green, Thru-hole, RT ANGLE: sim to HLMP1503-A1.
D9 and D10		LED: Yellow, sim to Citizen 1206: sim to Citizen CL-150Y.
D11		Dual, High-Speed: sim to Philips, BAV99, SOT23.
D12		LED: Green, thru-hole: sim to Citizen CL-150G.
D13 thru D29		Dual, High-speed: sim to Philips, BAV99, SOT23.
D32 and D33		Dual, High-speed: sim to Philips, BAV99, SOT23.
		- - - - JACKS - - - -
J1		Header 5x2: sim to AMP 146130-4.
J2		Header 22x2: sim to Samtec ASP-67352-01.
J3		MICTOR-38 Pin: sim to AMP 2-767004-2 *(Not placed).*
J4		Header 4x2: sim to AMP 87227-4 *(Not placed).*
J5 and J6		MICTOR-38 Pin: sim to AMP 2-767004-2 *(Not placed).*

SYMBOL	PART NUMBER	DESCRIPTION
J7		DIN96, 32x3, 0.1x0.1 Header: sim to Burndy P196B80P00F0NN9.
J8		Telephone jack RJ-11, Rt Angle, non-shielded: sim to AMP 555163-1.
J9		Header 22x2: sim to Samtec ASP-67352-01.
J10		Header 5x2: sim to AMP 146130-4.
		- - - - INDUCTOR - - - -
L1		39µH ±15%: sim to Panasonic ELJ-FA390JF.
		- - - - RESISTORS - - - -
R1	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R2 thru R4	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R5	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R6 thru R8	19A149818P040	Metal Film: 0 Ohms.
R9 thru R13	19A149818P390	Metal Film: 39 Ohms.
R14 and R15	19A149818P750	Metal Film: 75 Ohms ±5%, 0.1W.
R16 and R17	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R18	19A149818P040	Metal Film: 0 Ohms.
R19	19A149818P222	Metal Film: 2.2k Ohms ±5%, 0.1W.
R20 and R21	19A149818P390	Metal Film: 39 Ohms
R22	REP623642/499	49.9 Ohms ±1%.
R23	19A149818P331	Metal Film: 330 Ohms ±5%, 0.1W.
R24	19A149818P152	Metal Film: 1.5k Ohms ±5%, 0.1W.
R25	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R26 and R27	19A149818P390	Metal Film: 39 Ohms.
R28 and R29	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R30 and R31	19A149818P390	Metal Film: 39 Ohms.

SYMBOL	PART NUMBER	DESCRIPTION
R32 thru R34	REP623642/499	49.9 Ohms ±1%.
R35	19A149818P331	Metal Film: 330 Ohms ±5%, 0.1W.
R36 and R37	19A149818P390	Metal Film: 39 Ohms.
R38	REP623645/1	10k Ohms ±1%
R39	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R40 and R41	19A149818P750	Metal Film: 75 Ohms ±5%, 0.1W.
R42	19A149818P331	Metal Film: 330 Ohms ±5%, 0.1W.
R43		*(Not Placed)*
R44	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R45		*(Not Placed)*
R46 thru R50	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R51	19A149818P390	Metal Film: 39 Ohms
R52 and R53	REP623642/499	49.9 Ohms ±1%.
R54	19A149818P331	Metal Film: 330 Ohms ±5%, 0.1W.
R55	19A149818P121	Metal Film: 120 Ohms ±5%, 0.1W.
R56 and R57	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R58	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R59	19A149818P121	Metal Film: 120 Ohms ±5%, 0.1W.
R60	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R61	19A149818P121	Metal Film: 120 Ohms ±5%, 0.1W.
R62 and R63	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R64 and R65	REP623642/499	49.9 Ohms ±1%.
R66	19A149818P121	Metal Film: 120 Ohms ±5%, 0.1W.
R67	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R68 and R70	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.

SYMBOL	PART NUMBER	DESCRIPTION
R71 and R72	19A149818P121	Metal Film: 120 Ohms ±5%, 0.1W.
R73 and R74	19A149818P105	Metal Film: 1 Meg Ohm ±5%, 0.1W.
R75		3.01k Ohms ±1%: sim to ROHM MZR03EZHF3101.
R76	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R77 thru R79	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R80	19A149818P333	Metal Film: 33k Ohms
R81	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R82	19A149818P390	Metal Film: 39 Ohms.
R83	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R84	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R85	REP623645/1	10.0k Ohms ±1%.
R86	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R87	19A149818P331	Metal Film: 330 Ohms ±5%, 0.1W.
R88	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R89	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R90	19A139818P106	Metal Film: 10 Meg Ohms ±5%, 1/16W.
R91 thru R94	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R95	REP623646/47	470k Ohms ±1%.
R96	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R97	19A149818P390	Metal Film: 39 Ohms.
R98	19A149818P204	Metal Film: 200k Ohms.
R99		*(Not Placed)*
R100 thru R110	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R111	19A149818P750	Metal Film: 75 Ohms ±5%, 0.1W.
R112 thru R122	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R123	19A149818P390	Metal Film: 39 Ohms.
R124 thru R135	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R136	19A149818P222	Metal Film: 2.2k Ohms ±5%, 0.1W

SYMBOL	PART NUMBER	DESCRIPTION
R137 thru R139	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R140 and R141	19A149818P511	Metal Film: 510 Ohms.
R142 and R143	19A149818P222	Metal Film: 2.2k Ohms ±5%, 0.1W.
R144	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R145	19A149818P511	Metal Film: 510 Ohms.
R146	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R147	19A149818P392	Metal Film: 3.9k Ohms.
R148	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R149	19A149818P101	Metal Film: 100 Ohms.
R150	19A149818P392	Metal Film: 3.9k Ohms.
R151 and R152	19A149818P511	Metal Film: 510 Ohms
R153		0.015 Ohms ±1%, 0.5W ±1%: sim to IRC-TT LRC-LRF1206-01-R015-F.
R154	19A149818P511	Metal Film: 510 Ohms
R155 thru R158	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R159	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R160	19A149818P392	Metal Film: 3.9k Ohms
R161	19A149818P100	Metal Film: 10 Ohms ±5%, 0.1W
R162	19A149818P101	Metal Film: 100 Ohms.
R163	19A149818P511	Metal Film: 510 Ohms.
R164 and R165	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R166	19A149818P511	Metal Film: 510 Ohms.
R167	REP623644/56	5.6k Ohms ±1%, 0.1W.
R168	REP623644/2	2.0k Ohms ±1%, 0.1W.
R169	19A149818P101	Metal Film: 100 Ohms.
R170	19A149818P392	Metal Film: 3.9k Ohms.
R171	19A149818P472	Metal Film: 4.7k Ohms ±5%. 0.1W.
R172	19A149818P273	Metal Film: 27k Ohms
R173	19A149818P222	Metal Film: 2.2k Ohms ±5%, 0.1W.
R174		*Not Used*

SYMBOL	PART NUMBER	DESCRIPTION
R175 and R176	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R177	19A149818P472	Metal Film: 4.7k Ohms ±5%. 0.1W.
R178	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R179	19A149818P472	Metal Film: 4.7k Ohms ±5%. 0.1W.
R180	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R181		100k Ohms ±5%, 0.1W.
R182		*Not Used*
R183	19A149818P040	Metal Film: 0 Ohms.
R184 thru R186	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R187	19A149818P040	Metal Film: 0 Ohms
R188	19A149818P152	Metal Film: 1.5k Ohms ±5%, 0.1W.
R189	19A149818P102	Metal Film: 1k Ohms ±5%, 0.1W.
R190 and R191	REP623644/56	5.6k Ohms ±1%, 0.1W.
R192	19A149818P333	Metal Film: 33k Ohms
R193	19A149818P390	Metal Film: 39 Ohms.
R194		*(Not placed)*
R195	19A149818P103	Metal Film: 10k Ohms ±5%, 0.1W.
R196 and R197	19A149818P040	Metal Film: 0 Ohms
		- - - - RESISTOR NETWORKS - - - -
RN1 thru RN15		10k Ohms, BUS8, ±5%, 0.063W: sim to CTC 745C101103JTR.
		- - - - SWITCHES - - - -
S1		PUSHBUTTON, SPST N.O./SPST N.C.: sim to Grayhill 32-01.
S2		DIPSWITCH, 8 position: sim to Grayhill 97S08SR.
		- - - - TEST POINTS - - - -
TP1 thru TP10		SM Test Point Loop – Surface Mount: sim to ADI/ SM-TESTPAD/Components-Corporation TP-107-01.
		- - - - TRANSFORMERS - - - -
T1 and T2		1:1, 10/100Mbps: sim to TG110-S05N2.

SYMBOL	PART NUMBER	DESCRIPTION
		- - - - TRANSISTORS - - - -
Q1		NPN: Switching: sim to Phillips PMBT3904, SOT23.
Q2 thru Q4		FET: Small-Signal, N-Channel: sim to INFINEON, BSP295.
Q5		MOSFET: N-Channel, 5A, 20V: sim to ON Semiconductor, MMSF5N02HD.
Q6 and Q7		NPN: Switching: sim to Phillips PMBT3904, SOT23.
Q8		PNP: sim to Motorola, MMBT3906LT1, SOT23.
Q9 and Q10		NPN: Switching: sim to Phillips PMBT3904, SOT23.
		- - - - INTEGRATED CIRCUITS - - - -
U1		Single Buffer with 3-State Output: sim to Fairchild NC7SZ125M5, SOT23-5.
U2		8M x 16 SDRAM, PC100: sim to Micron MT48LC8M16A2TG-8E, TSOP54.
U3		Silicon Serial Number: sim to Dallas, DS2401P, TSOC6.
U4		Clock Buffer: sim to Cypress Cy2305SC-1, SOIC8.
U5		10/100-TX/FX Ethernet Transceiver: sim to AMD AM79C874VC, TQFP80.
U6		Octal Buffer, 3.3V: sim to TI 74LVC244ADB, SSOP20.
U7		8M x 16 SDRAM, PC100: sim to Micron MT48LC8M16A2TG-8E, TSOP54.
U8		Octal Buffer, 3.3V: sim to TI 74LVC244ADB, SOP20.
U9		Microprocessor, 66MHz: sim to Motorola, XPC860PZP66D4, BGA357.
U10	SK101412V1	1M x 16/2M x 8 Flash, simultaneous Read/Write *(programmed):* sim to AMD, AM29DL163DB90E1, TSOP48 *(unprogrammed).*
U11	SK101412V2	1M x 16/2M x 8 Flash, simultaneous Read/Write (programmed): sim to AMD, AM29DL163DB90E1, TSOP48 (unprogrammed).
U12		10/100-TX/FX Ethernet Transceiver: sim to AMD AM79C874VC, TQFP80.
U13		RS232 Transceiver, 5V, 2-TX, 2-RX: sim to MAXIM, MAX202CSE, SOIC16.
U14		2-wire serial 128k (16k x 8) EEPROM, I^2C, 3.3V: sim to Atmel, AT24C128N-10SC-2.7, SOIC8.
U15		I^2C Bus 8-bit I/O: sim to Philips, PCF8574T, SOIC16.

SYMBOL	PART NUMBER	DESCRIPTION
U16		Phase-Lock-Loop (PLL): sim to TI, 74HCT4046ADB, SSOP20.
U17		Single Inverter: sim to Philips, 74HC1G04GW, SOT-353.
U18		HEX Buffer: sim to Philips, 74HC14PW, TSSOP14.
U19		Octal XCVR, BUS HOLD, 3.3V, sim to Philips, 74LVCH245APW, TSSOP20.
U20		Single Inverter: sim to Philips, 74HC1G04GW, SOT-353.
U21		RS485 Transceiver: sim to TI, 75176BD, SO8.
U22 and U23		HEX Buffer: sim to Philips, 74HC14PW, TSSOP14.
U24		RS232 Transceiver, 3V to 5.5V, 3-TX, 5-RX: sim to MAXIM, MAX3241CAI, SSOP28.
U25		+5V Regulator, 1.5A: sim to Linear Tech, LT1086CM-3.3, TO263.
U26		I^2C Bus 8-bit I/O: sim to Philips, PCF8574T, SOIC16.
U27		MAX3000A 144 PIN EPLD, sim to Altera, EPM3256ATC144-10, TQFP144.
U28		Quad UART (QUART): sim to SC28L194A1BE, TQFP80.
U29		HEX Buffer: sim to Philips, 74HCT14PW, TSSOP14.
U30		RS232 Transceiver, 5V, 4-TX, 5-RX: sim to MAXIM, MAX213CAI, SSOP28.
U31		Reset Supervisor: sim to Dallas, DS1818R-10, SOT23.
U32		HEX Buffer: sim to Philips, 74HCT14PW, TSSOP14.
U33 thru U35		HEX Open-Collector Output Drivers: sim to Philips, 7406AD, SOIC14.
U36		RS232 Transceiver, 3V to 5.5V, 5-TX, 3-RX: sim to MAXIM, MAX3237CAI, SSOP28.
U37		Hot Swap Controller: sim to Linear Tech, LTC1422, SOCI8.
U38		Single 2-Input NAND Gate: sim to Phillips, 74AHC1G00GW, SOT353.
U39		Not Used
U40		555 Timer: sim to National, LMC555CM, TO263.
U41 and U42		Single Inverter: sim to Phillips 74AC1G04GW.
U43		REAL TIME CLOCK, IND.: sim to Dallas DS1307ZN.

SYMBOL	PART NUMBER	DESCRIPTION
		- - - - OSCILLATORS - - - -
Y1		Crystal: 25MHz CLK ±50ppm, 40%/60% duty, 3.3V: sim to Raltron CO4305-25.0000-TR
Y2		Crystal: 29.4912 MHz CLK ±100ppm, 40%/60% duty, 3.3V: sim to Raltron CO4310-29.4912-TR.
Y3		Crystal: 32.786kHz CLK: sim to Raltron RSE-32.768-12.5-H2.
Y4		Crystal: 11.0592 MHz CLK ±50ppm, 40%/60% duty, 3.3V: sim to Raltron CO4305-11.0592-TR..
Y5		Crystal: 32.786kHz CLK: sim to Raltron RSE-32.768-12.5-H2.
A2-A1	**CB101074V1**	**SitePro MODEM BOARD**
		- - - - CAPACITORS - - - -
C1 thru C2	RJE 584 3208/1	Tantalum: 10µF
C3 thru C27	RJC 464 3046/1	Ceramic: 0.1µF
		- - - - CONNECTORS - - - -
J1 and J2		I/O: QUICC, Edge 22x2: sim to Samtec CLP-122-02-G-D-BE
J3		Diagnostic Connector: sim to Semtec FTSH-110-01-L-DV.
		- - - - RESISTORS - - - -
R1 thru R8	REP 622 455/1	10k Ohms ±5%, 0.06W.
R9		*Not Used.*
R10	REP 622 455/1	10k Ohms ±5%, 0.06W.
R11 thru R13	REP 622 454/1	1k Ohms ±5%, 0.06W.
R14	REP 622 453/27	270 Ohms ±5%, 0.06W.
R15 thru R20	REP 622 455/1	10k Ohms ±5%, 0.06W.
		- - - - INTEGRATED CIRCUITS - - - -
U1		Local Microprocessor (socketed): sim to Dallas DS80C323QCD.
U2		SRAM 64 x 8k: sim to Integrated Circuit Devices IDT71V124SA20PH.
U3		Dual Port RAM: sim to Integrated Circuit Devices IDT70V05L55PF.

SYMBOL	PART NUMBER	DESCRIPTION
U4		SRAM 64 x 8k: sim to Integrated Circuit Devices IDT71V124SA20PH.
U5		Address Decoder: sim to 74LVC138ADB.
U6		3.3V - 5V Converter: sim to Integrated Circuit Devices IDT74FCT164245TPA.
U7		8-Bit Latch: sim to Philips 74LVC373APWDH.
U8		*Not Used.*
U9 thru U11	ROP 101 688/4C	RF/PL/VDI Modem
U12		Adder Bus Buffer: sim to Integrated Circuit Devices IDT74FCT163245APF.
U13		Data Bus Buffer: sim to Integrated Circuit Devices IDT74FCT3245APG
U14 and U15		*Not Used.*
U16		Quad 3-Input NAND Gate: sim to Philips 74LVC10APWDH.
U17		Quad 2-Input NOR Gate: sim to Philips 74LVC02APWDH.
U18		Hex Inverter: sim to Philips 74LVC04APWDH.
U19		Quad 2-Input NAND Gate: sim to Philips 74HC1G00GW.
U20 thru U22		Single Inverter: sim to Philips 74HC1G04GW.
U23		Quad 2-Input NAND Gate: sim to Philips 74HC1G00GW.
U24 and U25		Single Inverter: sim to Philips 74HC1G04GW.
		- - - - SOCKET - - - -
XU1	RNK 860 12/044	PLCC44
		- - - - CABLES - - - -
W1	CA101211V1	Input To Power Supply.
W2	CA101212V1	Output From Power Supply.
C87 and C88		*Not Used.*
C89 thru C91		0.1µF: sim to Panasonic ECJ-1VB1C104K
C92		*Not Used*.

SYMBOL	PART NUMBER	DESCRIPTION
C93 thru C98		0.1µF: sim to Panasonic ECJ-1VB1C104K
C100 thru C104		0.1µF: sim to Panasonic ECJ-1VB1C104K
C106 thru C111		0.1µF: sim to Panasonic ECJ-1VB1C104K
C112		*Not Used*
C113 thru C121		0.1µF: sim to Panasonic ECJ-1VB1C104K
C123		4.7pF: sim to Kemet C0603C479K5GAC
C124 and C125		0.1µF: sim to Panasonic ECJ-1VB1C104K
		- - - - DIODES - - - -
D1 and D2		: sim to Motorola BAT54LT1
D3 and D4		*Not Used.*
D5		Dual High Speed: sim to Philips Semiconductors BAL99.
D6 thru D9		: sim to Motorola BAT54LT1.
D10		*Not Used.*
D11 and D12		Dual High Speed: sim to Philips Semiconductors BAL99.
D13 and D14		*Not Used.*
D15		: sim to Motorola BAT54LT1.
		- - - - JACK - - - -
J1		DIN96_ABC_R: sim to AMP 536366-5.
		- - - - RELAYS - - - -
K1 and K2		2FORMC: sim to NEC EB2-4.5S.
		- - - - TRANSISTOR - - - -
Q1		NPN: Switching: sim to Motorola MMBT3904LT1.

SYMBOL	PART NUMBER	DESCRIPTION
		- - - - RESISTORS - - - -
R1		124k Ohms: sim to Panasonic ERJ-3EKF1243V.
R2		Resistor network: SM/RP_EXB-D10C [EXB-D10C/SM]: sim to Panasonic EXB-D10C103J.
R3		*Not Used.*
R4		16k Ohms: sim to Panasonic ERJ-3EKF1602V.
R5		1.21k Ohms: sim to Panasonic ERJ-3EKF1211V.
R6		5.11k Ohms: sim to Panasonic ERJ-3EKF5111V.
R7		1k Ohms: sim to Panasonic ERJ-3EKF1001V.
R8		16k Ohms: sim to Panasonic ERJ-3EKF1602V.
R9		1.21k Ohms: sim to Panasonic ERJ-3EKF1211V.
R10		5.11k Ohms: sim to Panasonic ERJ-3EKF5111V.
R11		1k Ohms: sim to Panasonic ERJ-3EKF1001V.
R12 and R13		*Not Used.*
R14		31.6k Ohms: sim to Panasonic ERJ-3EKF3162V.
R15		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R16		150k Ohms: sim to Panasonic ERJ-3EKF1503V.
R17		100k Ohms: sim to Panasonic ERJ-3EKF1003V.
R18		1Meg Ohm: sim to Panasonic ERJ-3EKF1004V.
R19		*Not Used.*
R20		1Meg Ohms: sim to Panasonic ERJ-3EKF1004V.
R21		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R22		100k Ohms: sim to Panasonic ERJ-3EKF1003V.
R23 and R24		*Not Used.*
R25		46.4k Ohms: sim to Panasonic ERJ-3EKF4642V.
R26		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R27		100k Ohms: sim to Panasonic ERJ-3EKF1003V.
R28		11k Ohms: sim to Panasonic ERJ-3EKF1102V.
R29		1.96k Ohms: sim to Panasonic ERJ-3EKF1961V.
R30		5.11k Ohms: sim to Panasonic ERJ-3EKF5111V.
R31		1.1k Ohms: sim to Panasonic ERJ-3EKF1101V.
R32		11k Ohms: sim to Panasonic ERJ-3EKF1102V.
R33		1.96k Ohms: sim to Panasonic ERJ-3EKF1961V.
R34		5.11k Ohms: sim to Panasonic ERJ-3EKF5111V.
R35		1.1k Ohms: sim to Panasonic ERJ-3EKF1101V.
R36		470 Ohms: sim to Panasonic ERJ-3EKF4700V.

SYMBOL	PART NUMBER	DESCRIPTION
R37 and R38		1Meg Ohms: sim to Panasonic ERJ-3EKF1002V.
R39		22.1k Ohms: sim to Panasonic ERJ-3EKF2212V.
R40		20K Ohms: sim to Panasonic ERJ-3EKF2002V.
R41		22.1k Ohms: sim to Panasonic ERJ-3EKF2212V.
R42		*Not Used.*
R43		294k Ohms: sim to Panasonic ERJ-3EKF2943V.
R44 and R45		22.1k Ohms: sim to Panasonic ERJ-3EKF2212V.
R46		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R47		10Meg Ohms: sim to Panasonic ERJ-3EKF1005V.
R48		*Not Used.*
R49		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R50		68k Ohms: sim to Panasonic ERJ-3EKF6802V.
R51		*Not Used.*
R52		100k Ohms: sim to Panasonic ERJ-3EKF1003V.
R53		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R54		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R55		23.7k Ohms: sim to Panasonic ERJ-3EKF2372V.
R56 and R57		*Not Used.*
R58		47k Ohms: sim to Panasonic ERJ-3EKF4702V.
R59 and R60		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R61 and R62		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R63		20k Ohms: sim to Panasonic ERJ-3EKF2002V.
R64		*Not Used.*
R65		60.4k Ohms: sim to Panasonic ERJ-3EKF6042V
R66		*Not Used.*
R67		1k Ohms: sim to Panasonic ERJ-3EKF1001V.
R68		4.7k Ohms: sim to Panasonic ERJ-3EKF4701V.
R69		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R70		60.4k Ohms: sim to Panasonic ERJ-3EKF6042V.
R71		*Not Used.*
R72 thru R74		22.1k Ohms: sim to Panasonic ERJ-3EKF2212V.

SYMBOL	PART NUMBER	DESCRIPTION
R75 thru R77		*Not Used.*
R78 and R79		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R80 thru R83		*Not Used.*
R84		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R85		*Not Used.*
R86		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R87		18k Ohms: sim to Panasonic ERJ-3EKF1802V.
R88		0 Ohms: sim to Panasonic ERJ-3EKF0.0V
R89		32.4k Ohms: sim to Panasonic ERJ-3EKF3242V.
R90		*Not Used.*
R91		82.5k Ohms: sim to Panasonic ERJ-3EKF8252V.
R92		*Not Used.*
R93 and R94		*Not Used.*
R95		221k Ohms: sim to Panasonic ERJ-3EKF2213V.
R96		*Not Used.*
R97		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R98		82.5k Ohms: sim to Panasonic ERJ-3EKF8252V.
R99		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
R100 thru R102		*Not Used.*
R103 and R104		4.7k Ohms: sim to Panasonic ERJ-3EKF4701V.
R105 thru R108		470 Ohms: sim to Panasonic ERJ-3EKF4700V.
R109 and R111		*Not Used.*
R112		4.7k Ohms: sim to Panasonic ERJ-3EKF4701V.
R113		10 Ohms ERJ-3EKF10R0V.
R114		0 Ohms ERJ-3EKF0.0V
R115 thru R118		*Not Used.*

SYMBOL	PART NUMBER	DESCRIPTION
R119 and R120		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R121		20k Ohms: sim to Panasonic ERJ-3EKF2002V.
R122		39.2k Ohms: sim to Panasonic ERJ-3EKF3922V.
R123 and R124		51.1K Ohms: sim to Panasonic ERJ-3EKF5112V.
R125		39.2k Ohms: sim to Panasonic ERJ-3EKF3922V.
R126		332k Ohms: sim to Panasonic ERJ-3EKF3323V.
R127		Resistor network: sim to Panasonic EXB-D10C103J.
R128 thru R130		0 Ohms: sim to Panasonic ERJ-3EKF0.0V.
R131		10Meg Ohms: sim to Panasonic ERJ-3EKF1005V.
R132 thru R151		*Not Used.*
R152		100k Ohms: sim to Panasonic ERJ-3EKF1003V.
R153		10k Ohms: sim to Panasonic ERJ-3EKF1002V.
		- - - - TEST POINTS - - - -
TP32 and TP33		T POINT R: sim to Components Corp. TP-107-01.
		- - - - INTEGRATED CIRCUITS - - - -
U2		Three-terminal negative fixed voltage (-5V) regulator: sim to Motorola/On Semiconductors, MC79M05BT.
U3		Dual 4-Stage Binary Ripple Counter: sim to Motorola, MC74HC393AD.
U4		Remote 16-bit I/O Expander: sim to Philips, PCF8575CTS.
U5		High slew rate, wide bandwidth, single supply operational amplifier: sim to Motorola/On Semiconductors, MC33074D.
U6		High slew rate, wide bandwidth, single supply operational amplifier: sim to Motorola/On Semiconductors: sim to Motorola, MC33072D.
U7		Fault-Protected, High-Voltage Single 8-to-1/Dual 4-to-1 Multiplexers: sim to Maxim, MAX4508ESE.
U8		Addressable dual digital potentiometer: sim to Dallas, DS1803Z-010.
U9		SPST/SPDT Analog Switches: sim to Maxim, DG419DY.

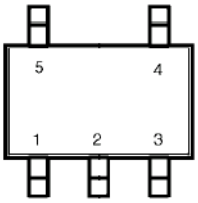
SYMBOL	PART NUMBER	DESCRIPTION
U10		High slew rate, wide bandwidth, single supply operational amplifier: sim to Motorola/On Semiconductors: sim to Motorola,: sim to Motorola, MC33074D
U11		8^{th}-Order, Low-pass, Switched-Capacitor Filters: sim to Maxim, MAX292ESA.
U12		Low power dual voltage comparator: sim to Motorola, LM393D.
U13		*Not Used.*
U14		8^{th}-Order, Lowpass, Elliptic, Switched-Capacitor Filters: sim to Maxim, MAX294EWE.
U15		High slew rate, wide bandwidth, single supply operational amplifier: sim to Motorola/On Semiconductors: sim to Motorola, MC33072D.
U16		Quad Low Power RS-232 Driver: sim to Linear Tech, LTC1067IS.
U17		High slew rate, wide bandwidth, single supply operational amplifier: sim to Motorola/On Semiconductors: sim to Motorola, MC33072D.
U18		SPST/SPDT Analog Switches: sim to Maxim, DG419DY.
U19		High slew rate, wide bandwidth, single supply operational amplifier: sim to Motorola/On Semiconductors: sim to Motorola, MC33072D.
U20		Low Pass Filter: sim to Maxim, MAX294EWE.
U21		*Not Used.*
U22		SPST/SPDT Analog Switches: sim to Maxim, DG419DY.
U23		8-Bit A/D and D/A Converter: sim to Philips, PCF8591TD.
U24		+5V-Powered, Multi-channel RS-232 Drivers/Receivers: sim to Maxim, MAX232AESE.
U25		Quad Low Power RS-232 Driver: sim to Linear Tech, LTC4861S.
U26		Quad RS-485 Line Receiver: sim to Linear Tech, LTC 489IS.
U27		Dual Peripheral Drivers: sim to TI, SN75451BD
U28		High slew rate, wide bandwidth, single supply operational amplifier: sim to Motorola/On Semiconductors: sim to Motorola, MC33072D.
U29 and U30		*Not Used*
U31		Fault-protected, high-voltage, Single 4-to-1/Dual 2-to-1 Multiplexers: sim to Maxim MAX4534ESD.

SYMBOL	PART NUMBER	DESCRIPTION
U32		Hex Inverter: sim to Motorola MC14069UBDR2
U33		Low offset voltage dual comparators: sim to Motorola LM393D.
U34		2-wire serial 128k (16k x 8) EEPROM, I^2C, 3.3V: sim to Atmel, AT24C128N-10SC-2.7, SOIC8.
		- - - - CRYSTAL - - - -
Y1		400 kHz: sim to STATEK_CX-3V-SM
A5	**PS-PS101328V1**	**POWER SUPPLY**
		+5.1V, +12V, -12V: sim to CONDOR DP1719
A6	**EA101227V1**	**DISPLAY MODULE**
1	FM101082V1	Display Cover
2	FM101082V2	Spacer Plate.
3	AG101230V1	Display Lens.
4	FM101082V3	Display Lens Keeper.
	AR-FM101082V1	Display Mkg Artwork.
A6-A1	CB101077V1	Display Board Assembly
		- - - - CAPACITORS - - - -
C1		0.1µF: sim to Panasonic ECJ-1VB1C104K.
C2		0.01µF: sim to Panasonic ECJ-1VB1C103K.
C3		22µF: sim to Sprague 293D226X9016D2T.
C4		0.01µF: sim to Panasonic ECJ-1VB1C103K.
C5		0.1µF: sim to Panasonic ECJ-1VB1C104K.
		- - - - DIODE - - - -
D1		POWER ON: sim to LUMEX SSS-LX5093GD-0.150”.
		- - - - RESISTORS - - - -
R1		300 Ohms: sim to Panasonic ERJ-6ENF3010.
R2 thru R17		10k Ohms: sim to Panasonic ERJ-3EKF1002.
R18		19.6k Ohms: sim to Panasonic 3EKF1962.
R19 thru R21		0 Ohms: sim to PHYCOMP 9C06031AOR00JLHFT.
R22		300 Ohms: sim to Panasonic ERJ-6ENF3010.
		- - - - INTEGRATED CIRCUITS - - - -
U1		8-Character smart display: sim to SIEMENS HDSP2112S.
U2		Remote 16-bit I/O expander for I^2C-bus: sim to Philips PCF8575TS.
A6-W1	CA101222V1	Cable
A7	**RYTUZ 921 01/1**	**ROCKWELL MODEM ASSEMBLY**

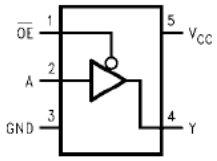
12.0 IC DATA

12.1 CONTROLLER BOARD (A2)

U1
Single Buffer with 3-State Output
Fairchild, NC7SZ125M5, SOT23-5



Connection Diagram



(Top View)

Pin Descriptions

Pin Names	Description
A, $\overline{OE}$	Inputs
Y	Output

Function Table

Inputs		Output
$\overline{OE}$	In A	Out Y
L	L	L
L	H	H
H	X	Z

H = HIGH Logic Level
L = LOW Logic Level
X = HIGH or LOW Logic Level
Z = HIGH Impedance State

U2, U7
8M x 16 SDRAM, PC100
Micron MT48LC8M16A2TG-8E

PIN ASSIGNMENT (Top View)

54-Pin TSOP

x16				x16
VDD	1	54		VSS
DQ0	2	53		DQ15
VDDQ	3	52		VSSQ
DQ1	4	51		DQ14
DQ2	5	50		DQ13
VSSQ	6	49		VDDQ
DQ3	7	48		DQ12
DQ4	8	47		DQ11
VDDQ	9	46		VSSQ
DQ5	10	45		DQ10
DQ6	11	44		DQ9
VSSQ	12	43		VDDQ
DQ7	13	42		DQ8
VDD	14	41		VSS
DQML	15	40		NC
WE#	16	39		DQMH
CAS#	17	38		CLK
RAS#	18	37		CKE
CS#	19	36		NC
BA0	20	35		A11
BA1	21	34		A9
A10	22	33		A8
A0	23	32		A7
A1	24	31		A6
A2	25	30		A5
A3	26	29		A4
VDD	27	28		VSS

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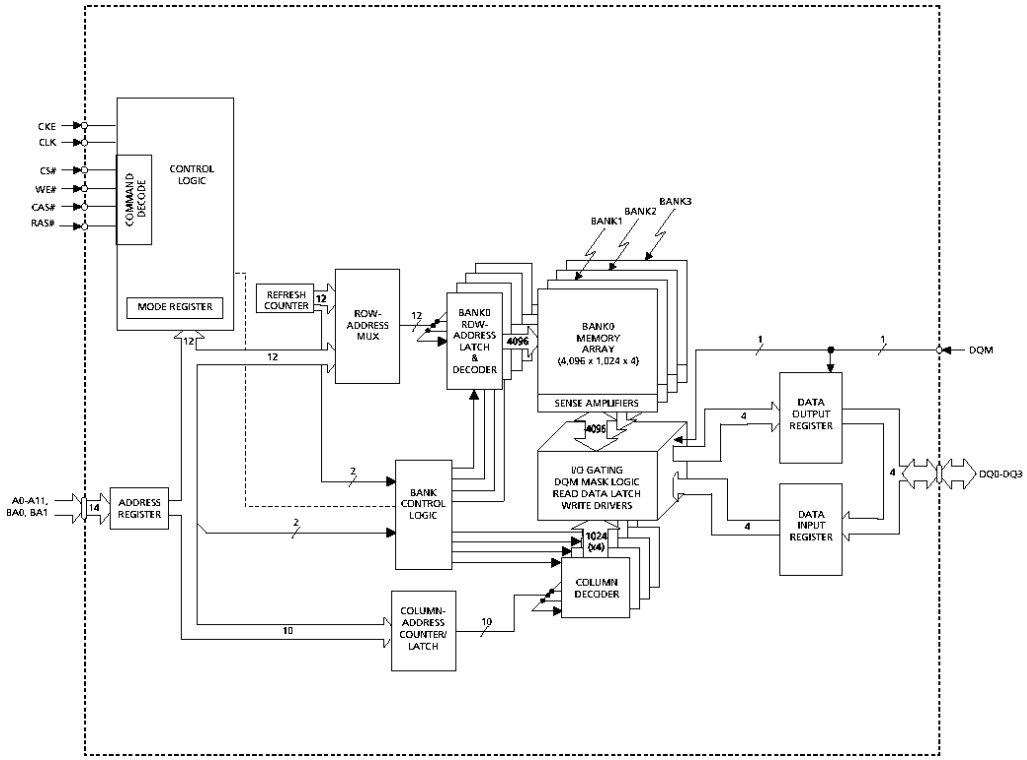
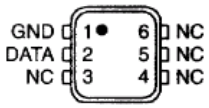
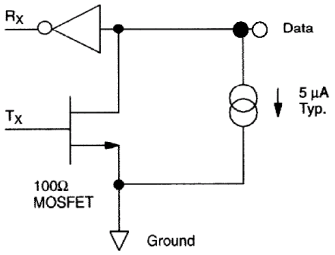


U3
Silicon Serial Number
DALLAS DS2401P

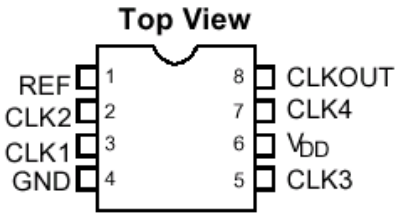
TSOC PACKAGE

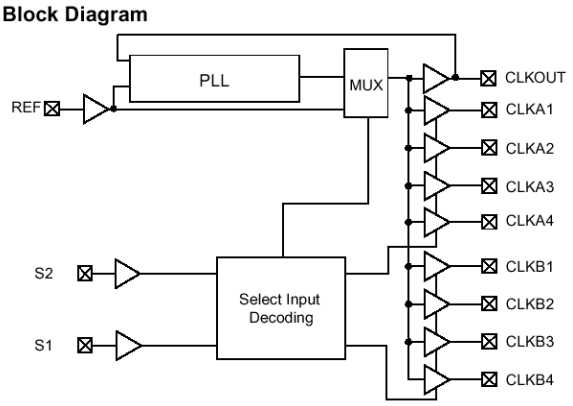


DS2401 EQUIVALENT CIRCUIT

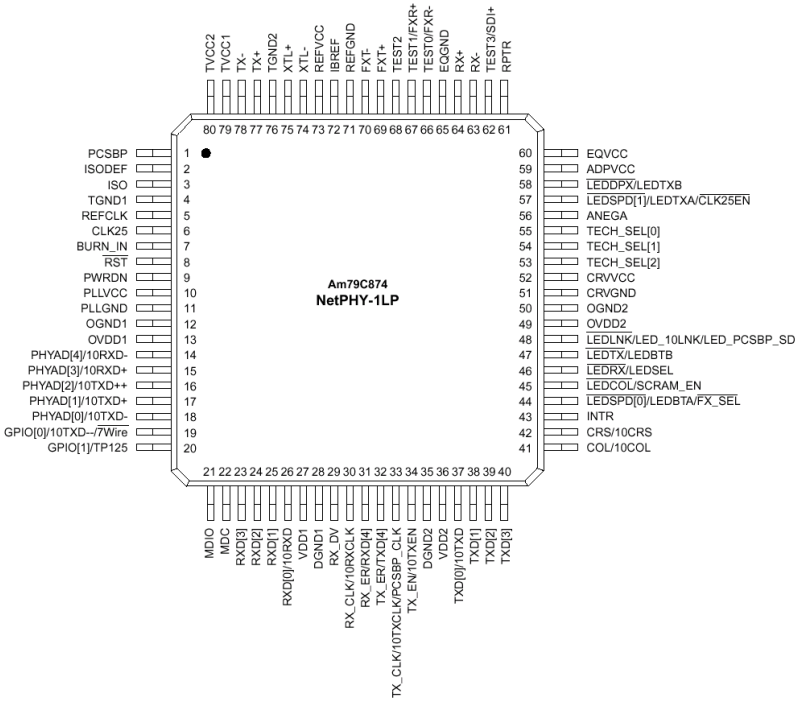


U4
Clock Buffer
Cypress CY2305SC-1





U5, U12
10/100-TX/RX Ethernet Transceiver
AMD AM79C874VC



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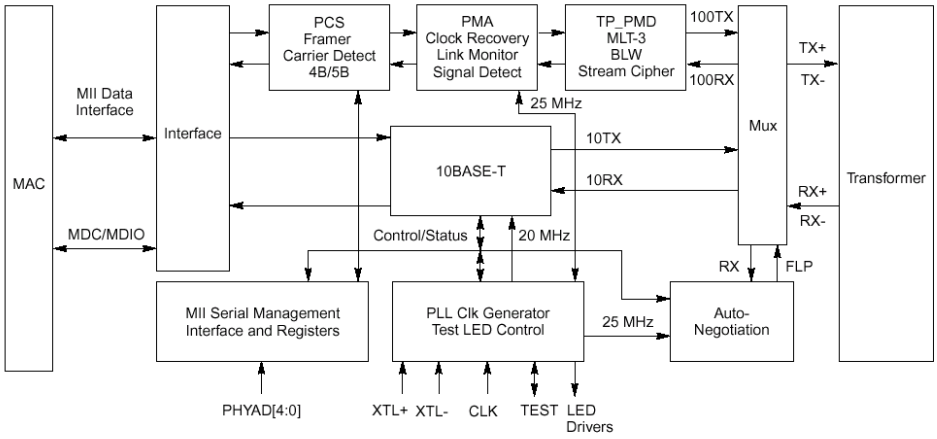
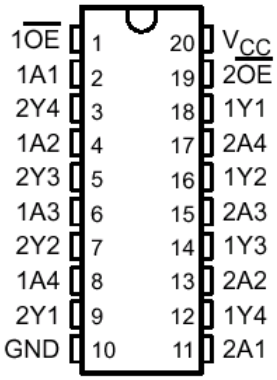
BLOCK DIAGRAM

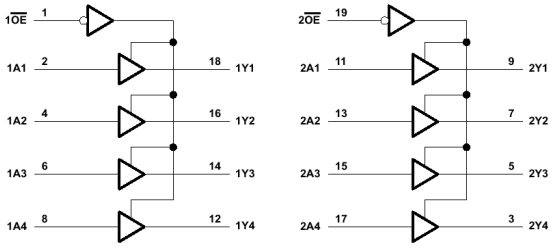


U6, U8
Octal Buffer, 3.3V
TI, 74LVC244ADB

(TOP VIEW)



logic diagram (positive logic)

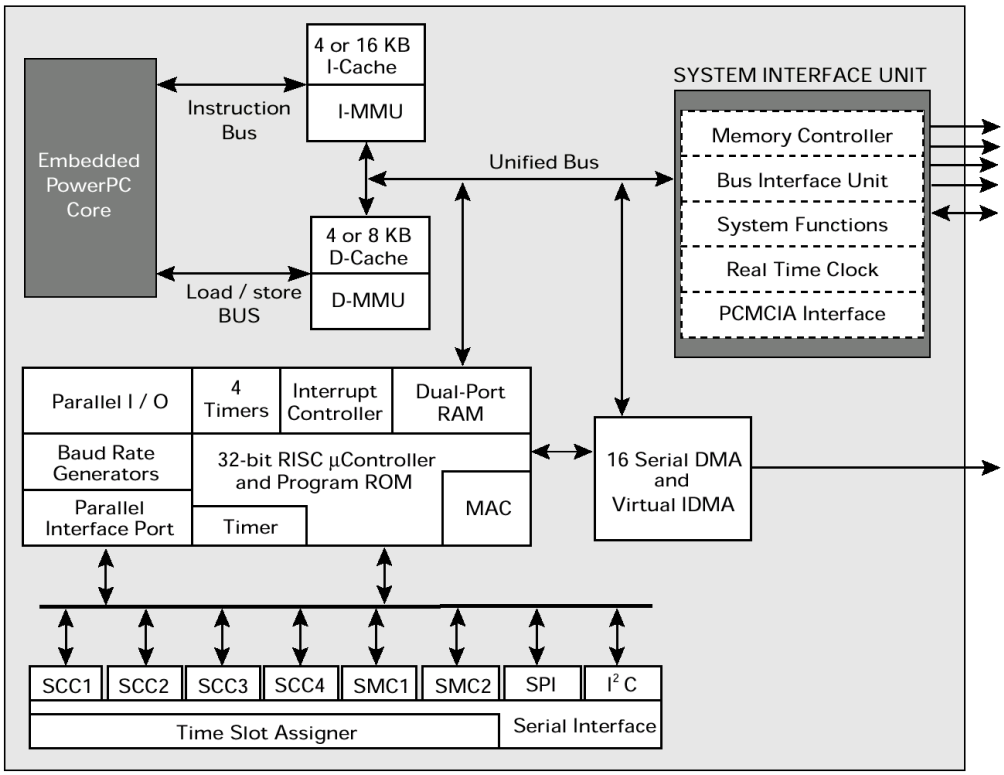


FUNCTION TABLE
(each buffer)

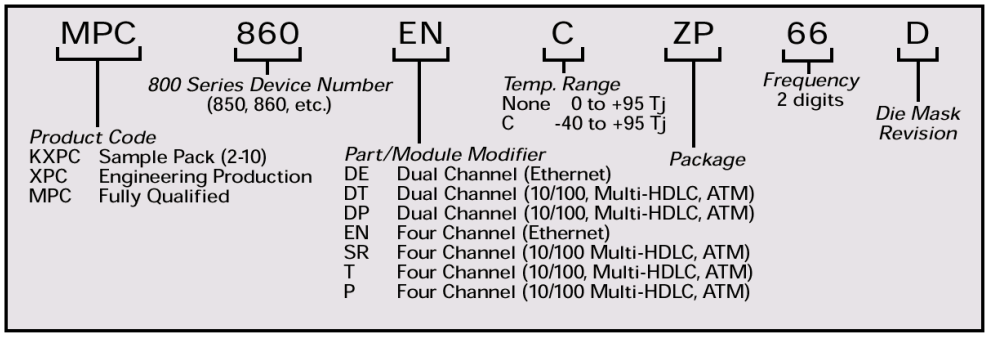
INPUTS		OUTPUT
$\overline{OE}$	A	Y
L	H	H
L	L	L
H	X	Z

U9
Microprocessor, 66MHz
Motorola, XPC860PZP66D4, BGA357

MPC860 Processor Block Diagram

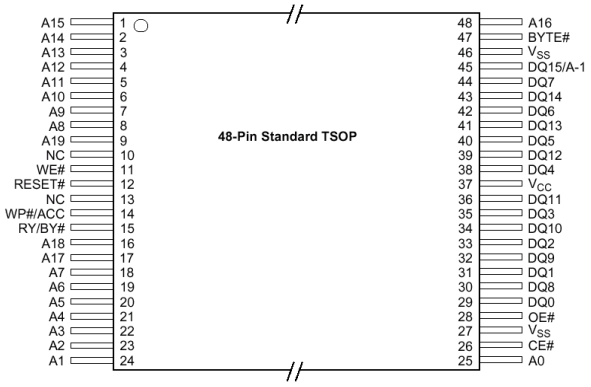


MPC860 Series Part Numbering Key

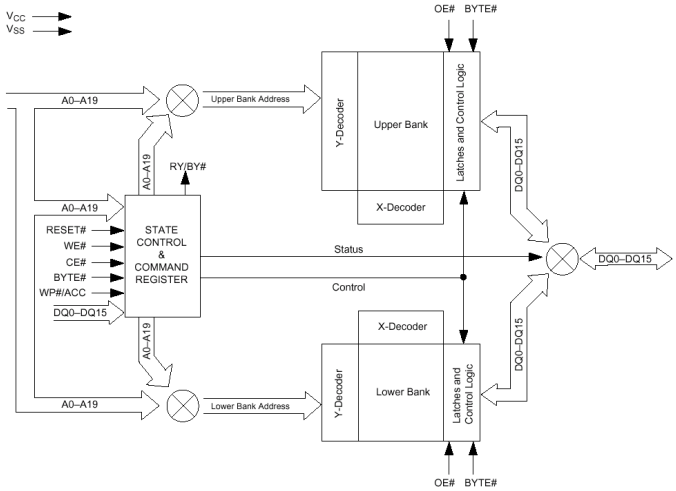


U10, U11
1M x 16/2M x 8 Flash, Simultaneous Read/Write
AMD, AM29DL163DB90E1

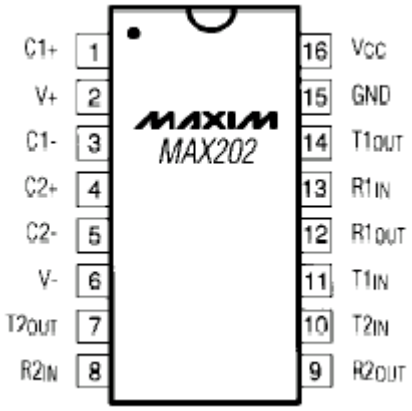
CONNECTION DIAGRAMS

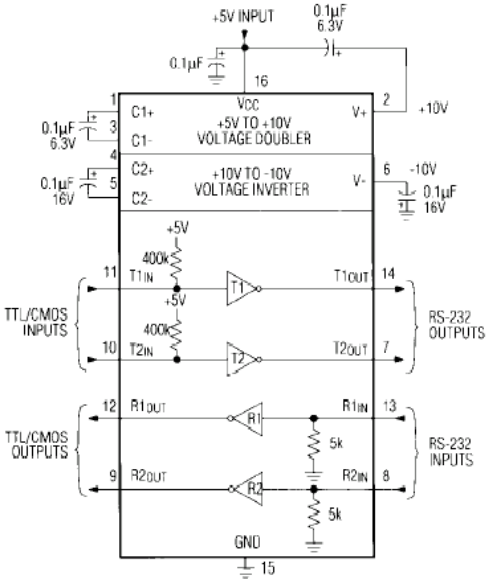


BLOCK DIAGRAM

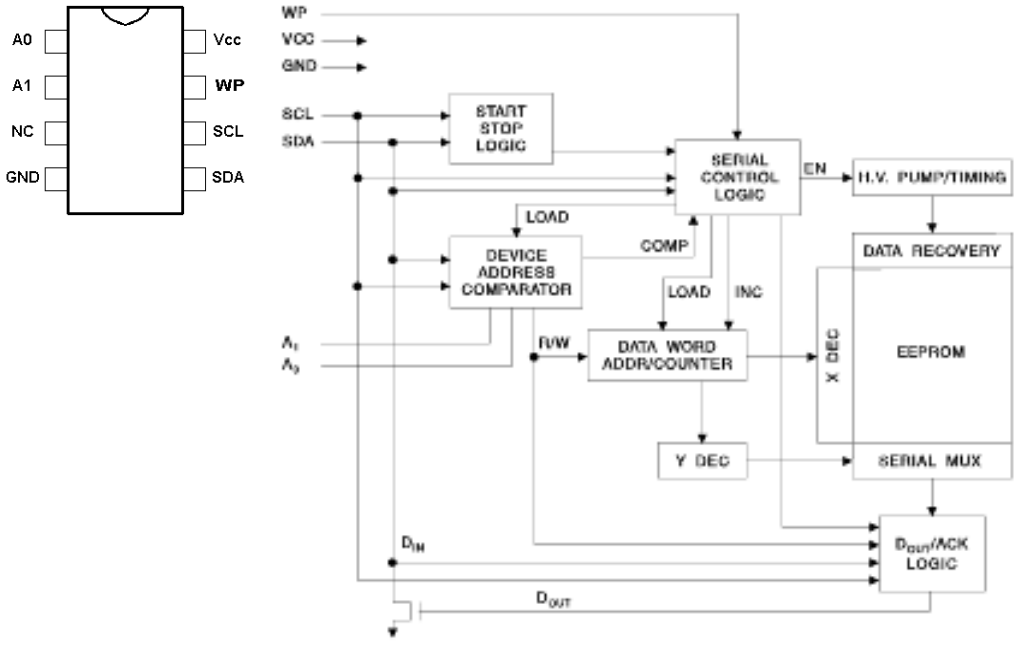


U13
RS232 Transceiver, 5V, 2-TX, 2-RX
MAXIM, MAX202CSE

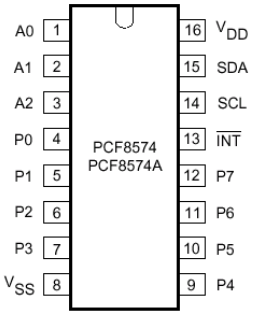


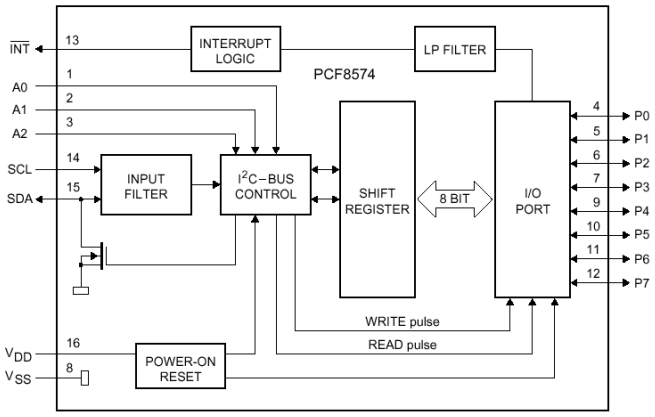


U14
EEPROM, I²C, 16k x 8, 3.3V
Atmel, AT24C128N, SOIC8



U15, U26
I²C Bus 8-Bit I/O
Philips, PCF8574A

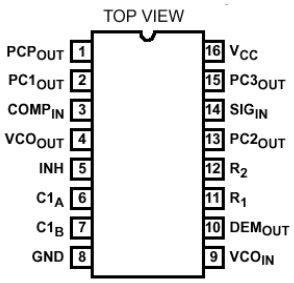


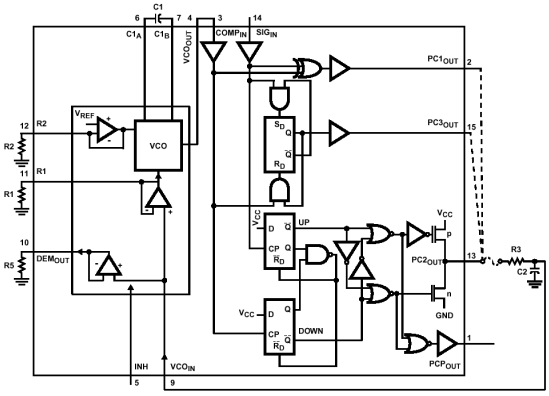


PIN IDENTIFICATION

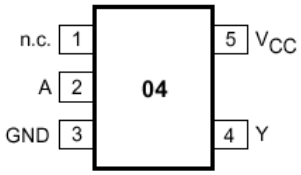
SYMBOL	PIN	DESCRIPTION
A0	1	Address Input 0
A1	2	Address Input 1
A2	3	Address Input 2
P0	4	Quasi-bidirectional I/O 0
P1	5	Quasi-bidirectional I/O 1
P2	6	Quasi-bidirectional I/O 2
P3	7	Quasi-bidirectional I/O 3
Vss	8	Supply Ground
P4	9	Quasi-bidirectional I/O 4
P5	10	Quasi-bidirectional I/O 5
P6	11	Quasi-bidirectional I/O 6
P7	12	Quasi-bidirectional I/O 7
INT	13	Interrupt Output (Active LOW)
SCL	14	Serial Clock Line
SDA	15	Serial Data Line
V_{DD}	16	Supply Voltage

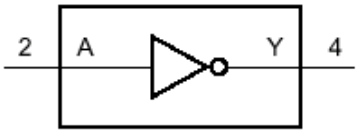
U16
Phase-Lock-Loop (PLL)
TI, 74HCT4046ADB





U17, U20
Single Inverter
Philips, 74HC1G04GW





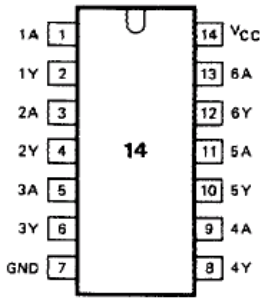
FUNCTION TABLE
See note 1.

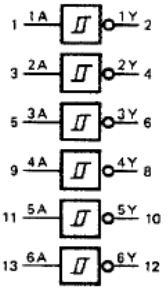
INPUT	OUTPUT
A	**Y**
L	H
H	L

Note

1. H = HIGH voltage level;
   L = LOW voltage level.

U18, U22, U23
HEX Buffer
Philips, 74HC14PW





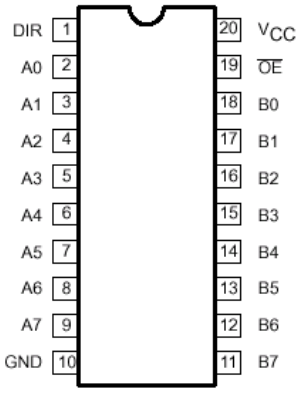
FUNCTION TABLE

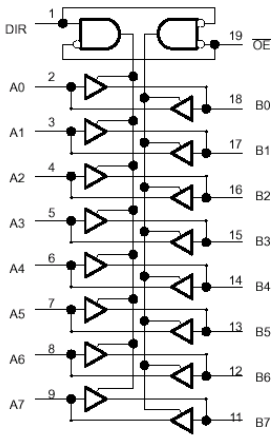
INPUT	OUTPUT
nA	nY
L	H
H	L

Notes

1. H = HIGH voltage level
   L = LOW voltage level

U19
Octal XCVR, BUS HOLD, 3.3V
Philips, 74LVCH245APW





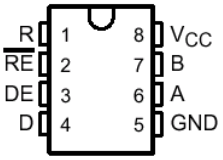
FUNCTION TABLE

INPUTS		INPUTS/OUTPUTS	
$\overline{OE}$	DIR	An	B_0
L	L	A = B	Inputs
L	H	Inputs	B = A
H	X	Z	Z

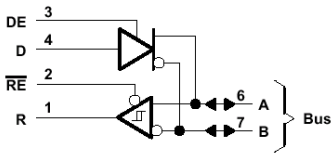
H = HIGH voltage level
L = LOW voltage level
X = Don't care
Z = High impedance OFF-state

U21
RS485 Transceiver
TI, 75176BD

(TOP VIEW)



logic diagram (positive logic)



Function Tables

DRIVER

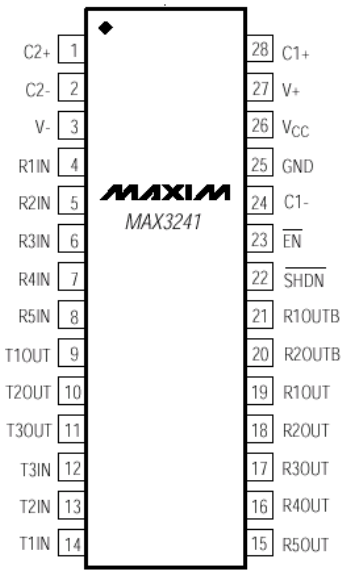
INPUT D	ENABLE DE	OUTPUTS A	OUTPUTS B
H	H	H	L
L	H	L	H
X	L	Z	Z

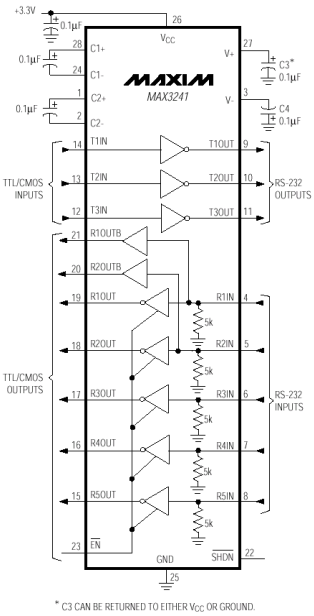
RECEIVER

DIFFERENTIAL INPUTS A–B	ENABLE $\overline{RE}$	OUTPUT R
$V_{ID} \geq 0.2$ V	L	H
-0.2 V < V_{ID} < 0.2 V	L	?
$V_{ID} \leq -0.2$ V	L	L
X	H	Z
Open	L	?

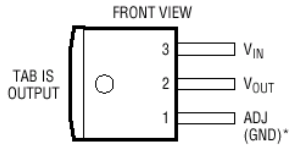
H = high level, L = low level, ? = indeterminate,
X = irrelevant, Z = high impedance (off)

U24
RS232 Transceiver, 3V to 5.5V, 3-TX, 5-RX
MAXIM, MAX3241CAI, SSOP28

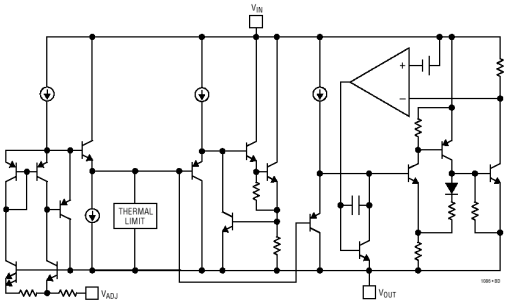




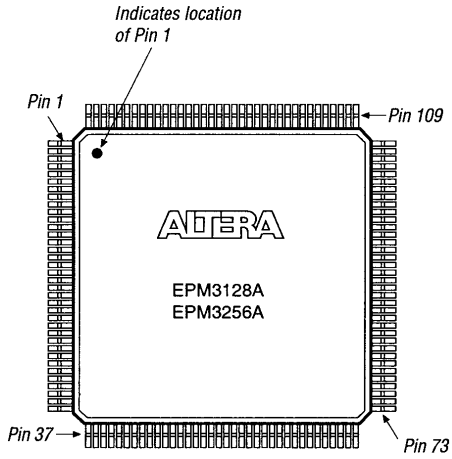
U25
+5V Regulator, 1.5A
LINEAR TECH, LT1086CM-3.3

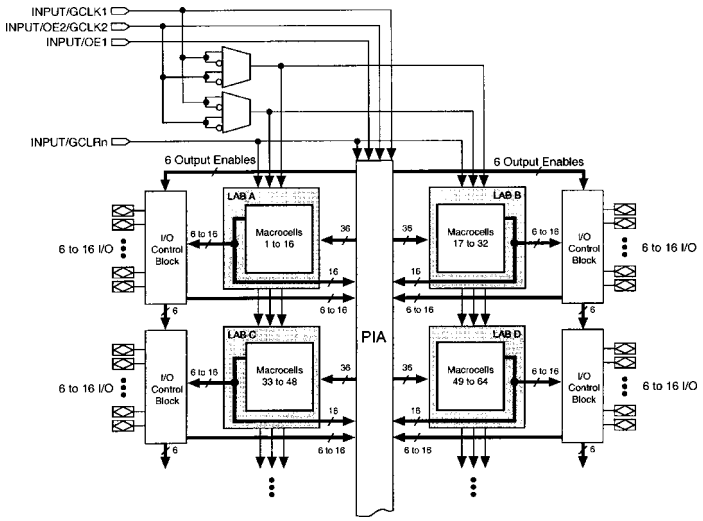


BLOCK DIAGRAM

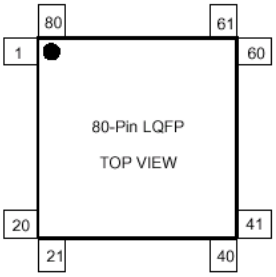


U27
144 PIN EPLD
ALTERA, EPM3256ATC144
(Refer to EPLD Drawings)



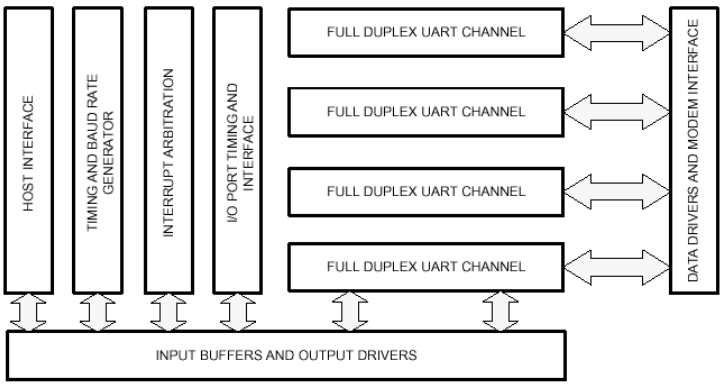


U28
QUAD UART (QUART)
Philips, SC28L194A1BE

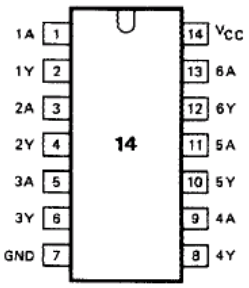


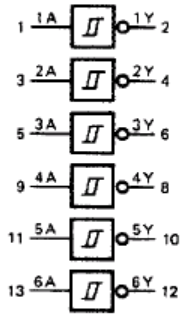
Pin Assignments
4 Vss_ic, 4 Vcc_i, 4 Vss_o, 2 Vcc_o, 2Vcc_c

1	I/O1a	28	TxDd	54	D6
2	I/O2a	29	Vcc_c	55	D7
3	I/O3a	30	Vcc_i	56	IRQN
4	Vss_o	31	Vss_ic	57	IACKN
5	RxDa	32	RESETN	58	Vss_o
6	TxDa	33	Gin0	59	X1
7	I/O0b	34	Gin1	60	X2
8	I/O1b	35	I/O0d	61-62	nc
9	Vcc_o	36	I/O1d	63	A7
10	Vcc_i	37	I/O2d	64	A5
11	Vss_ic	38	Gout0	65	A4
12	I/O2b	39-41	nc	66	A3
13	I/O3b	42	I/O3d	67	A2
14	RxDb	43	Gout1	68	A1
15	TxDb	44	Vss_o	69	SClk
16	I/O0c	45	D0	70	Vss_ic
17	I/O1c	46	D1	71	Vcc_c
18	Vss_o	47	D2	72	Vcc_i
19	I/O2c	48	D3	73	W_RN
20-23	nc	49	Vcc_o	74	A0
24	I/O3c	50	D4	75	CEN
25	RxDc	51	D5	76	DACKN
26	TxDc	52	Vss_ic	77	I/O0a
27	RxDd	53	Vcc_i	78-80	nc



U29, U32
HEX Buffer
(Philips, 74HCT14PW





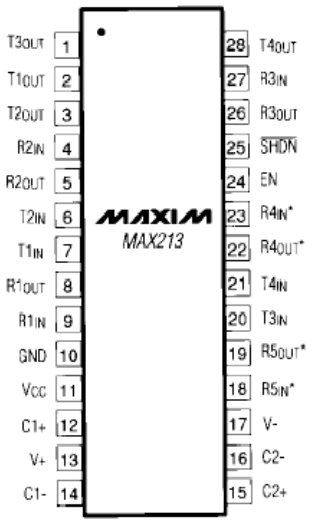
FUNCTION TABLE

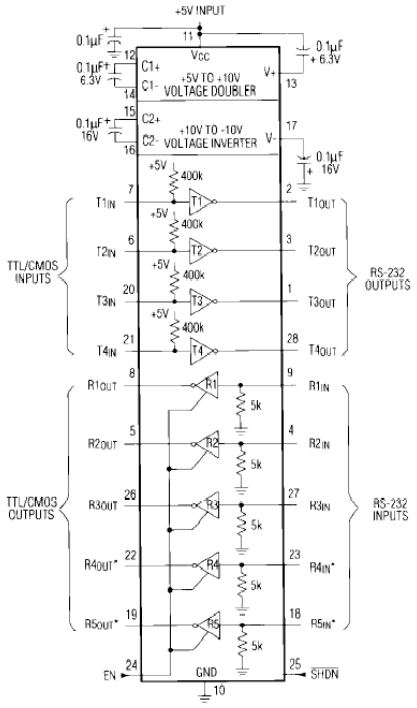
INPUT	OUTPUT
nA	nY
L	H
H	L

Notes

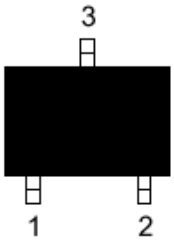
1. H = HIGH voltage level
   L = LOW voltage level

U30
RS-232 Transceiver, 5V, 4-TX, 5-TX
MAXIM, MAX213CAI

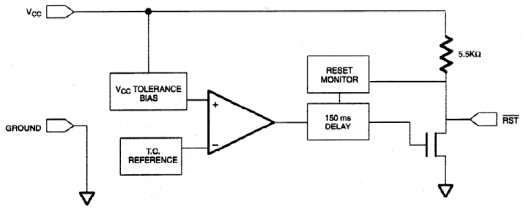




U31
Reset Supervisor
Dallas, DS1818R-10

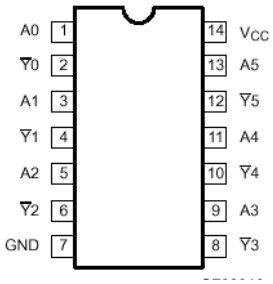


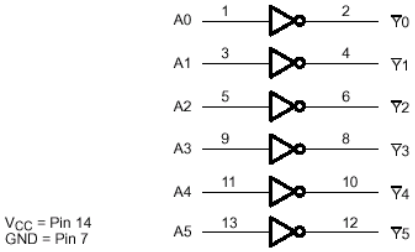
BLOCK DIAGRAM (OPEN-DRAIN OUTPUT)



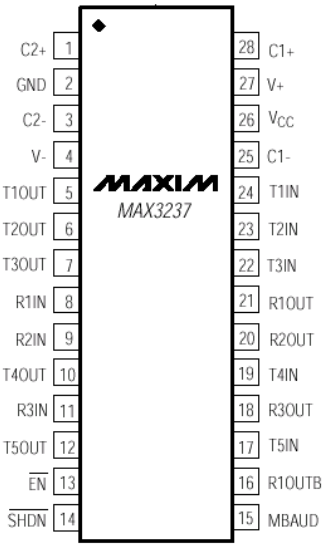
1	RST	Active Low Reset Output
2	V_{CC}	Power Supply
3	GND	Ground

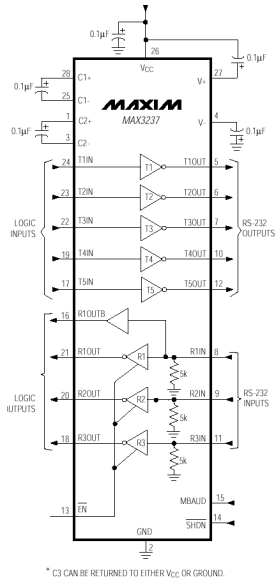
U33, U34, U35, U39
HEX Open-Collector Output Drivers
Philips, 74F06AD



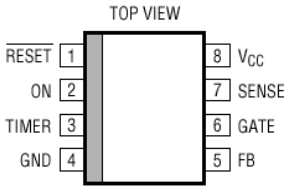


U36
RS232 Transceiver, 3V to 5.5V, 5-TX, 3-RX
MAXIM, MAX3237CAI

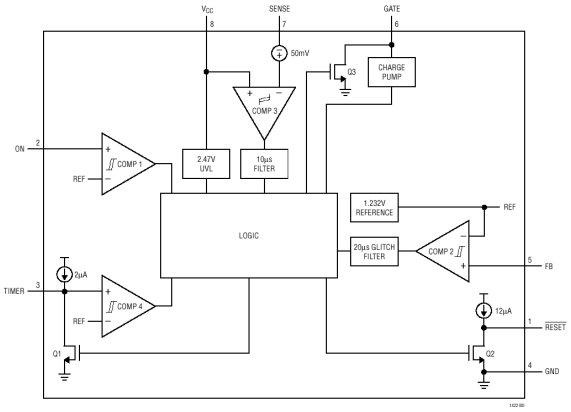




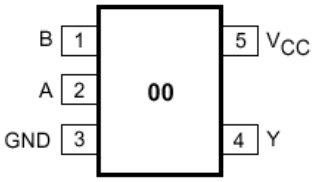
U37
Hot Swap Controller
Linear Tech, LTC1422

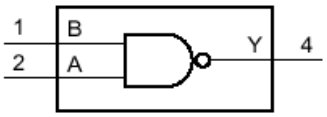


BLOCK DIAGRAM



U38
Single NAND Gate
Philips, 74AHC1G00GW





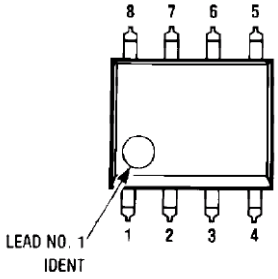
FUNCTION TABLE
See note 1.

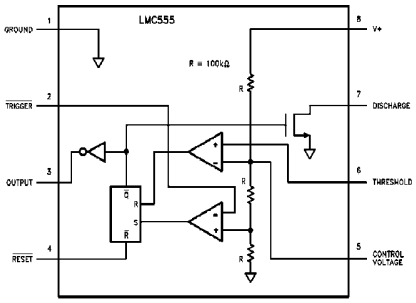
INPUTS		OUTPUT
A	**B**	**Y**
L	L	H
L	H	H
H	L	H
H	H	L

Note

1. H = HIGH voltage level;
   L = LOW voltage level.

U40
555 Timer
National, LMC555CM

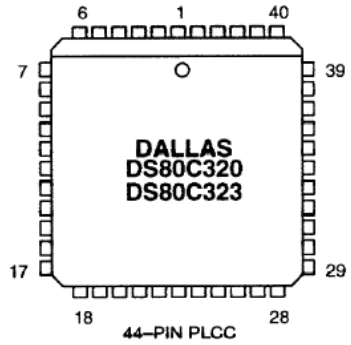


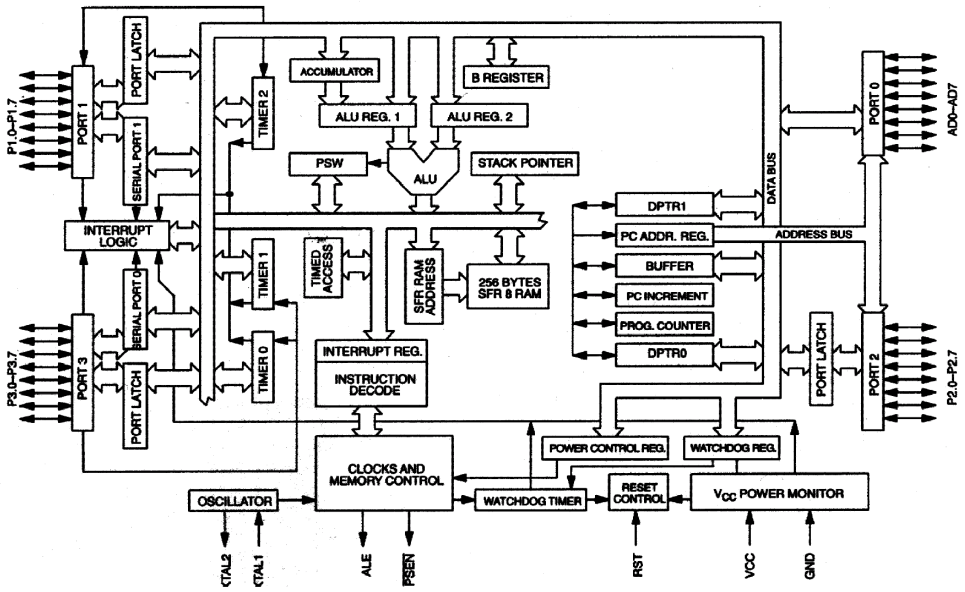


Top View

12.2 SitePro MODEM BOARD (A2-A1)

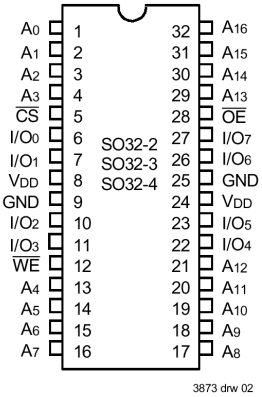
U1
Microprocessor
Dallas DS80C323-QCD



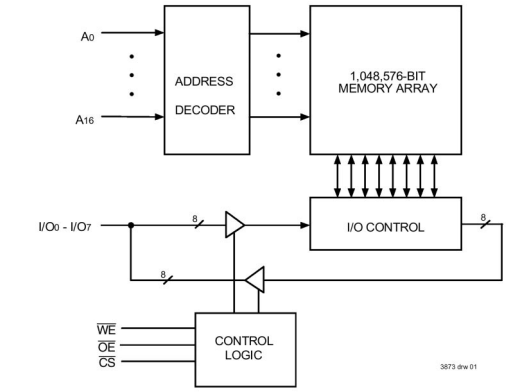


U2 & U4
64k x 8 SRAM
IDT71V124SA20PH

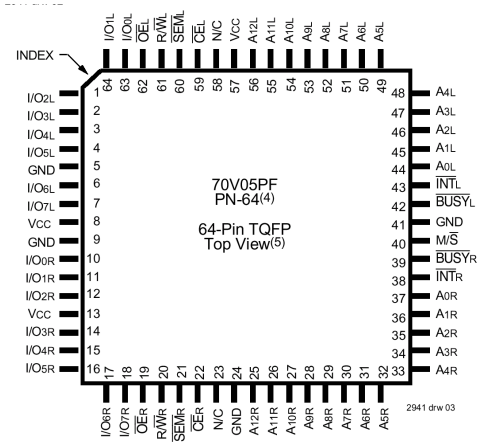
Pin Configuration



Functional Block Diagram



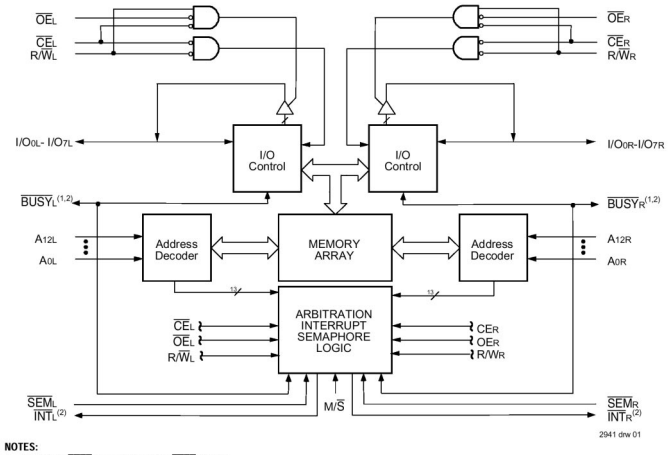
U3
Dual Port RAM
IDT70V05L55PF



Continued

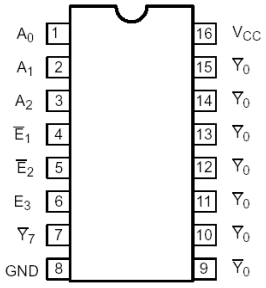
Continued

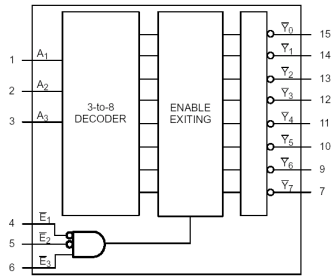
Functional Block Diagram



NOTES:
1. (MASTER): $\overline{BUSY}$ is output; (SLAVE): $\overline{BUSY}$ is input.
2. $\overline{BUSY}$ outputs and $\overline{INT}$ outputs are non-tri-stated push-pull.

U5
Address Decoder
Philips 74ALVC138ADB





PIN DESCRIPTION

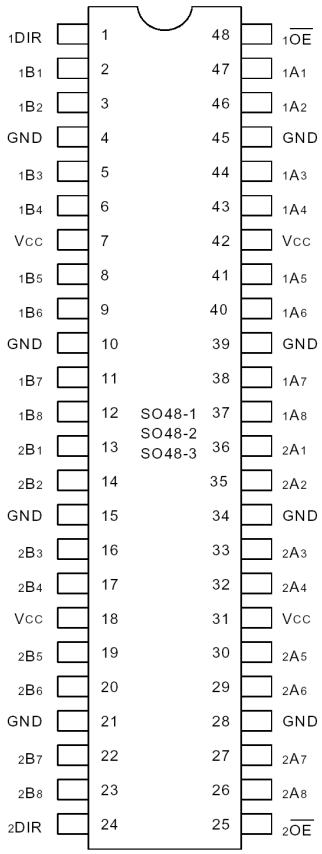
PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 2, 3	A_0 to A_2	Address inputs
4, 5	$\overline{E}_1$, $\overline{E}_2$	Enable inputs (active LOW)
6	E_3	Enable inputs (active HIGH)
15, 14, 13, 12, 11, 10, 9, 7	$\overline{Y}_0$ to $\overline{Y}_7$	Outputs
8	GND	Ground (0 V)
16	V_{CC}	Positive supply voltage

FUNCTION TABLE

INPUTS						OUTPUTS							
$\overline{E}_1$	$\overline{E}_2$	E_3	A_0	A_1	A_2	$\overline{Y}_0$	$\overline{Y}_1$	$\overline{Y}_2$	$\overline{Y}_3$	$\overline{Y}_4$	$\overline{Y}_5$	$\overline{Y}_6$	$\overline{Y}_7$
H	X	X	X	X	X	H	H	H	H	H	H	H	H
X	H	X	X	X	X	H	H	H	H	H	H	H	H
X	X	L	X	X	X	H	H	H	H	H	H	H	H
L	L	H	L	L	L	L	H	H	H	H	H	H	H
L	L	H	H	L	L	H	L	H	H	H	H	H	H
L	L	H	L	H	L	H	H	L	H	H	H	H	H
L	L	H	H	H	L	H	H	H	L	H	H	H	H
L	L	H	L	L	H	H	H	H	H	L	H	H	H
L	L	H	H	L	H	H	H	H	H	H	L	H	H
L	L	H	L	H	H	H	H	H	H	H	H	L	H
L	L	H	H	H	H	H	H	H	H	H	H	H	L

NOTES:
H = HIGH voltage level
L = LOW voltage level
X = don't care

U6
3.3V – 5V Converter
IDT74FCT164245TPA



SSOP/ TSSOP/ TVSOP
TOP VIEW

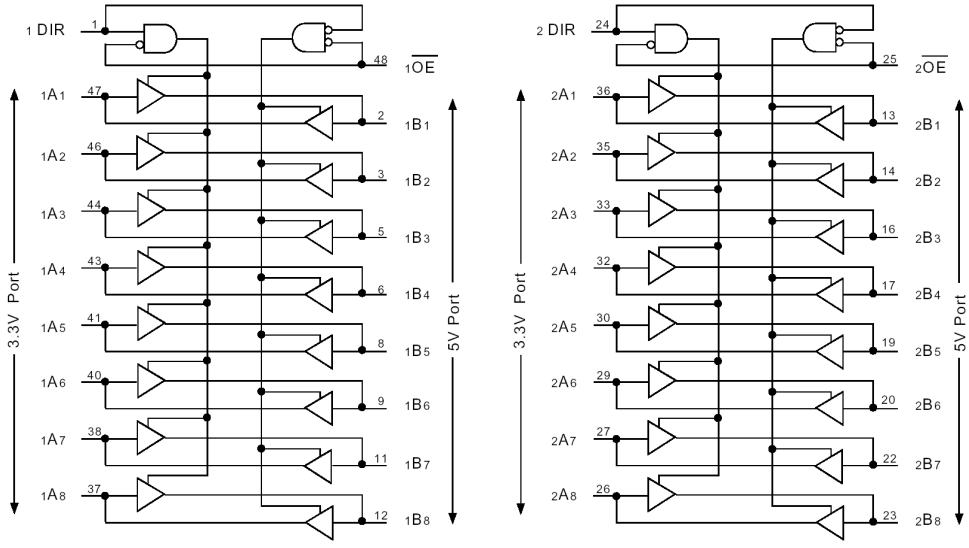
PIN DESCRIPTION

Pin Names	Description
x$\overline{OE}$	Output Enable Input (Active LOW)
xDIR	Direction Control Input
xAx	Side A Inputs or 3-State Outputs
xBx	Side B Inputs or 3-State Outputs

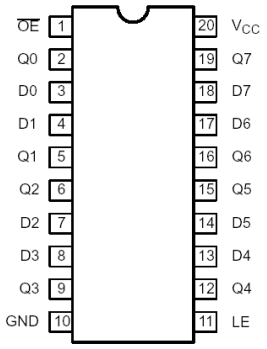
FUNCTION TABLE(1)

Inputs		Outputs
x$\overline{OE}$	xDIR	
L	L	Bus B Data to Bus A
L	H	Bus A Data to Bus B
H	X	High Z State

NOTE:
1. H = HIGH Voltage Level
   L = LOW Voltage Level
   X = Don't Care
   Z = High Impedance

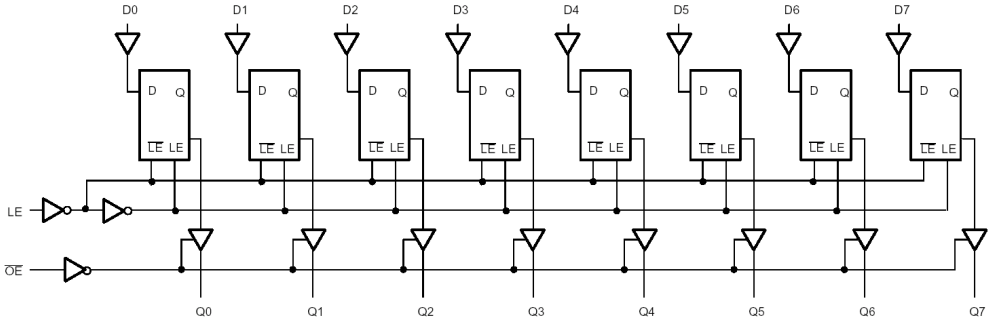


U7
8-Bit Latch
Philips 74LVC373APWDH



PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	$\overline{OE}$	Output enable input (active-Low)
3, 4, 7, 8, 13, 14, 17, 18	D0-D7	Data inputs
2, 5, 6, 9, 12, 15, 16, 19	Q0-Q7	Data outputs
11	LE	Latch enable input (active-High)
10	GND	Ground (0V)
20	V_{CC}	Positive supply voltage

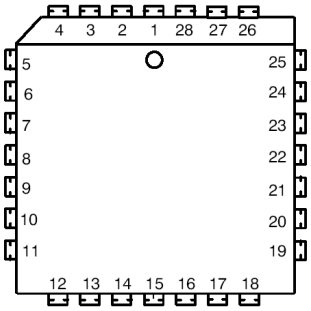


FUNCTION TABLE

OPERATING MODES	INPUTS			INTERNAL LATCHES	OUTPUTS
	$\overline{OE}$	LE	D_n		Q_0 to Q_7
Enable and read register (transparent mode)	L L	H H	L H	L H	L H
Latch and read register	L L	L L	l h	L H	H H
Latch register and disable outputs	H H	L L	l h	L H	Z Z

H = HIGH voltage level
h = HIGH voltage level one setup time prior to the HIGH-to-LOW LE transition
L = LOW voltage level
l = LOW voltage level one setup time prior to the HIGH-to-LOW LE transition
X = Don't care
Z = High impedance OFF-state

U9, U10 & U11
RF/PL/VDI Modem
Ericsson ROP 101 688/4C

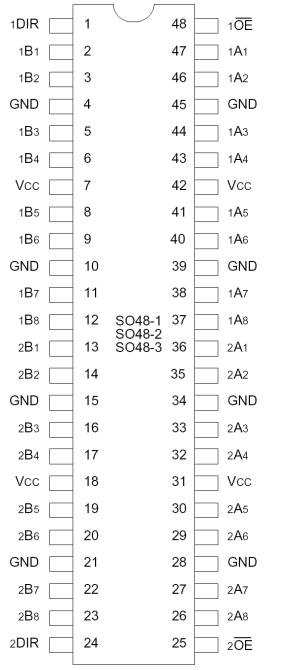


CONNECTIONS

Terminal	Symbol	Function
1	RE	Read enable (active low)
2	EN	Chip enable (active low)
3	RESOUT	Reset output (active high)
4	AD0	Bi-directional address/data bus
5	AD1	Bi-directional address/data bus
6	AD2	Bi-directional address/data bus
7	AD3	Bi-directional address/data bus
8	AD4	Bi-directional address/data bus
9	AD5	Bi-directional address/data bus
10	AD6	Bi-directional address/data bus
11	AD7	Bi-directional address/data bus
12	ALE	Address latch enable (active high)
13	VSS	Ground
14	CLK1	Buffered oscillator output
15	VDD	Power Supply
16	XTAL1	Oscillator input
17	XTAL2	Oscillator output
18	CLK2	640 kHz output
19	DRAIN	Received data input
20	SAT/G1	Received SAT input/G1 enable HC138 (active high)
21	TXDAT	Transmit data output
22	RCVCLK/ Q2	Recovered clock output/Q2 output for HC138
23	RCVDAT/ Q0	Recovered data output/Q0 output for HC138
24	INT	Interrupt request (active low o.d.)
25	RESIN	Reset input (active high)
26	CS	Chip select (active low)
27	CLK3/4	Transmit clock output/CLK 1/6 Output
28	WR	Write enable (active low)

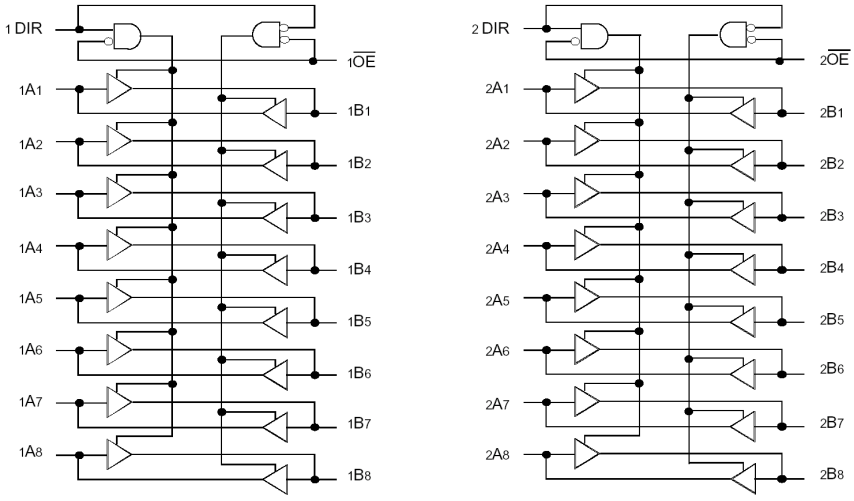
U12
Adder Bus Buffer
IDT74FCT163245APF

PIN CONFIGURATIONS



SSOP/
TSSOP/TVSOP
TOP VIEW

FUNCTIONAL BLOCK DIAGRAM



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Continued

PIN DESCRIPTION

Pin Names	Description
x$\overline{OE}$	Output Enable Input (Active LOW)
xDIR	Direction Control Input
xAx	Side A Inputs or 3-State Outputs
xBx	Side B Inputs or 3-State Outputs

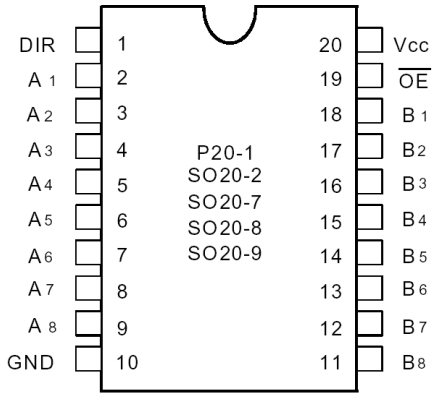
FUNCTION TABLE(1)

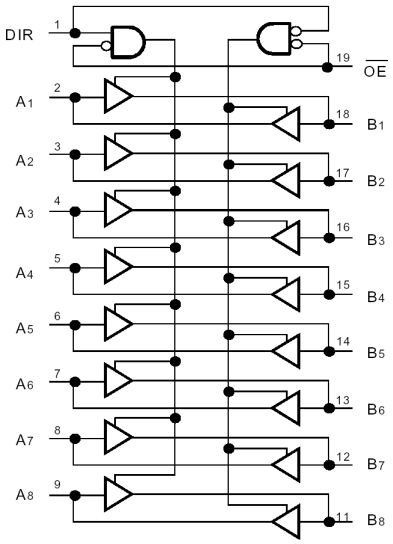
Inputs		Outputs
x$\overline{OE}$	xDIR	
L	L	Bus B Data to Bus A
L	H	Bus A Data to Bus B
H	X	High Z State

NOTE:

1. H = HIGH Voltage Level
   L = LOW Voltage Level
   X = Don't Care
   Z = High-Impedance

U13
Data Bus Buffer
IDT74FCT3245APG





PIN DESCRIPTION

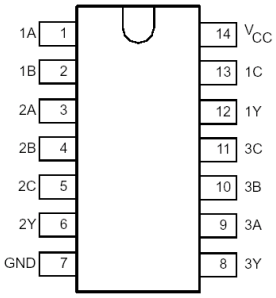
Pin Names	Description
$\overline{OE}$	Output Enable Input (Active LOW)
DIR	Direction Control Input
Ax	Side A Inputs or 3-State Outputs
Bx	Side B Inputs or 3-State Outputs

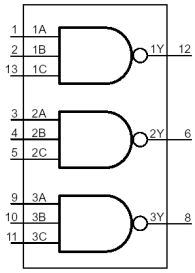
FUNCTION TABLE(1)

Inputs		Outputs
x$\overline{OE}$	xDIR	
L	L	Bus B Data to Bus A
L	H	Bus A Data to Bus B
H	X	High Z State

NOTE:
1. H = HIGH Voltage Level
   L = LOW Voltage Level
   X = Don't Care
   Z = High Impedance

U16
Triple 3-Input NAND Gates
Philips 74LVC10APWDH





PIN DESCRIPTION

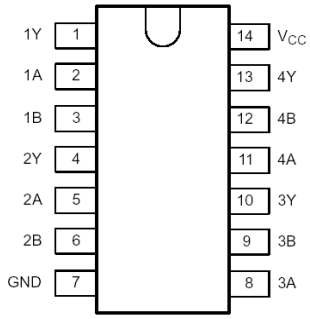
PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 9	1A – 3A	Data inputs
2, 4, 10	1B – 3B	Data inputs
7	GND	Ground (0 V)
12, 6, 8	1Y – 3Y	Data outputs
13, 5, 11	1C – 3C	Data inputs
14	V_{CC}	Positive supply voltage

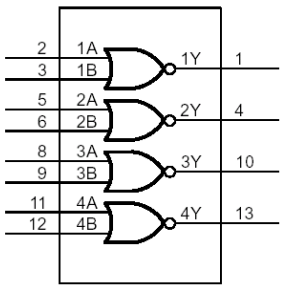
FUNCTION TABLE

INPUTS			OUTPUTS
nA	nB	nC	nY
L	L	L	H
L	L	H	H
L	H	L	H
L	H	H	H
H	L	L	H
H	L	H	H
H	H	L	H
H	H	H	L

NOTES:
H = HIGH voltage level
L = LOW voltage level

U17
Quad 2-Input NOR Gates
Philips 74LVC02APWDH



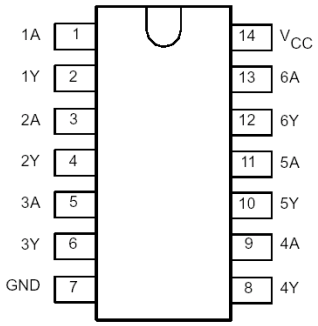


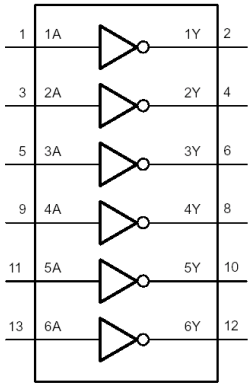
FUNCTION TABLE

INPUTS		OUTPUTS
nA	nB	nY
L	L	H
L	H	L
H	L	L
H	H	L

NOTES:
H = HIGH voltage level
L = LOW voltage level

U18
Inverters
Philips 74LVC04APWDH





PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 5, 9, 11, 13	1A to 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y to 6Y	Data outputs
7	GND	Ground (0 V)
14	V_{CC}	Positive supply voltage

Continued

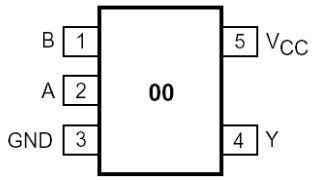
Continued

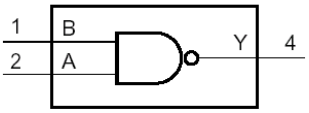
FUNCTION TABLE

INPUTS	OUTPUTS
nA	nY
L	H
H	L

NOTES:
H = HIGH voltage level
L = LOW voltage level

U19
2-Input NAND Gate
Philips 74AHC1G00GW





FUNCTION TABLE

See note 1.

INPUTS		OUTPUT
A	**B**	**Y**
L	L	H
L	H	H
H	L	H
H	H	L

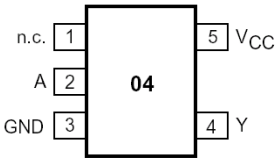
Note

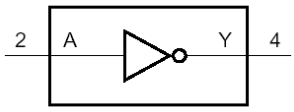
1. H = HIGH voltage level;
   L = LOW voltage level.

PINNING

PIN	SYMBOL	DESCRIPTION
1	B	data input B
2	A	data input A
3	GND	ground (0 V)
4	Y	data output Y
5	V_{CC}	supply voltage

U20, U21 & U22
Inverter
Philips 74AHC1G04GW





FUNCTION TABLE

See note 1.

INPUT	OUTPUT
A	**Y**
L	H
H	L

Note

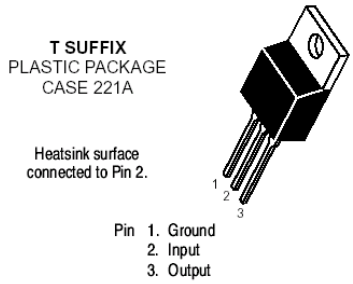
1. H = HIGH voltage level;
   L = LOW voltage level.

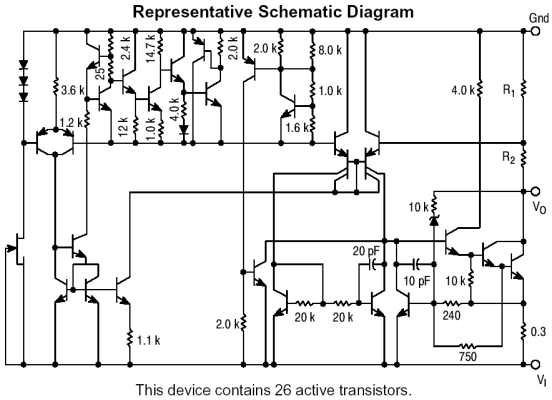
PINNING

PIN	SYMBOL	DESCRIPTION
1	n.c.	not connected
2	A	data input A
3	GND	ground (0 V)
4	Y	data output Y
5	V_{CC}	supply voltage

12.3 ANALOG FILTER BOARD (A4)

U2
Three-Terminal Negative Fixed Voltage Regulator
Motorola, MC79M05BT

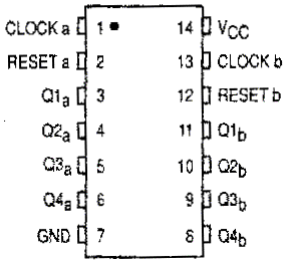




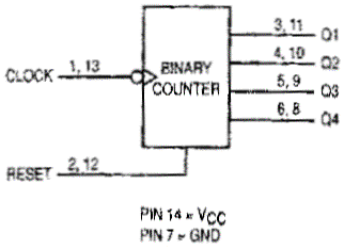
This device contains 26 active transistors.

U3
Dual 4-Stage Binary Ripple Counter
Motorola, MC74HC393AD

PIN ASSIGNMENT



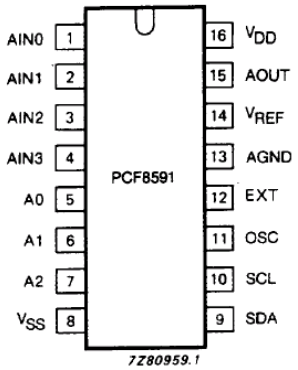
LOGIC DIAGRAM

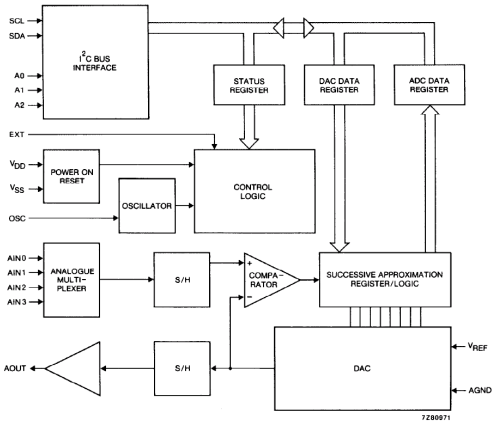


FUNCTION TABLE

Inputs		
Clock	Reset	Outputs
X	H	L
H	L	No Change
L	L	No Change
↓	L	No Change
↓	L	Advance to Next State

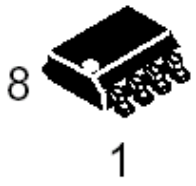
U4
Remote 16-Bit I/O Expander for I²C-Bus
(Philips, PCF8575CTS

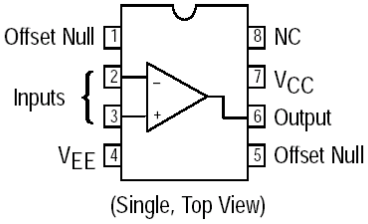




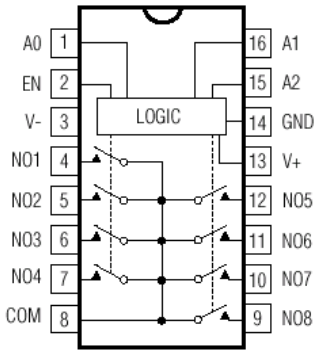
U5 & U10
High Slew Rate, Wide Bandwidth, Single Supply Operational Amplifier
Motorola, MC33074D

U6, U15, U17, U19 & U28
High Slew Rate, Wide Bandwidth, Single Supply Operational Amplifier
Motorola, MC33072D

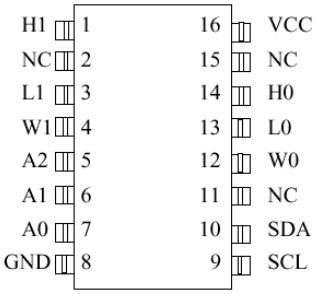




U7
Fault-Protected, High-Voltage Single 8-to-1/Dual 4-to-1 Multiplexers
Maxim, MAX4508ESE



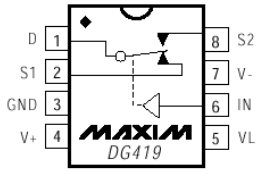
U8
Addressable Dual Digital Potentionmeter
Dallas, DS1803Z-010



PIN DESCRIPTION

L0, L1	-	Low End of Resistor
H0, H1	-	High End of Resistor
W0,W1	-	Wiper terminal of Resistor
V_{CC}	-	3V/5V Power Supply Input
A0..A2	-	Chip Select Inputs
SDA	-	Serial Data I/O
SCL	-	Serial Clock Input
GND	-	Ground
NC	-	No connection

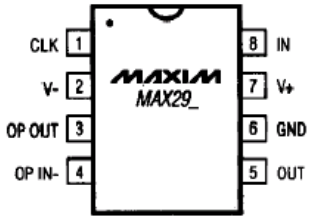
U9, U18 & U22
SPST/SPDT Analog Switches
Maxim, DG419DY

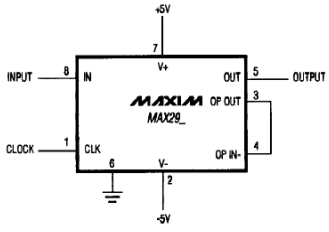


DIP/SO

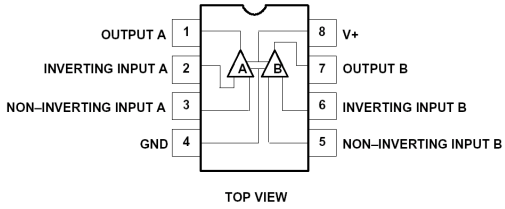
DG419		
LOGIC	SWITCH 1	SWITCH 2
0	ON	OFF
1	OFF	ON

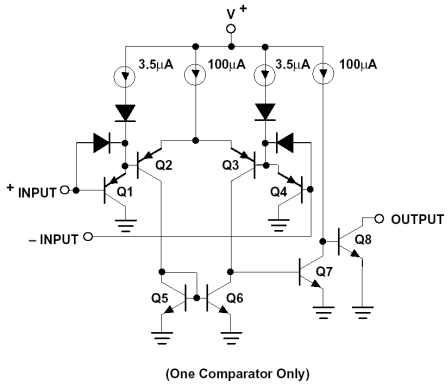
U11
8th-Order, Lowpass, Switched-Capacitor Filters
Maxim, MAX292ESA



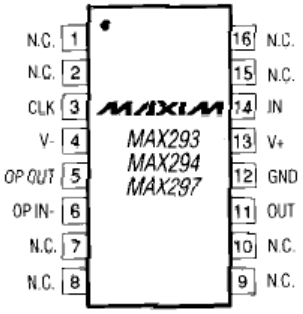


U12 & U33
Low Offset Voltage Dual Comparators
Motorola, LM393D





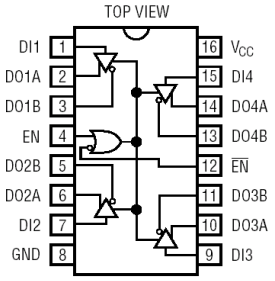
U14 & U20
8th-Order, Lowpass, Elliptic, Switched-Capacitor Filters
Maxim, MAX294EWE



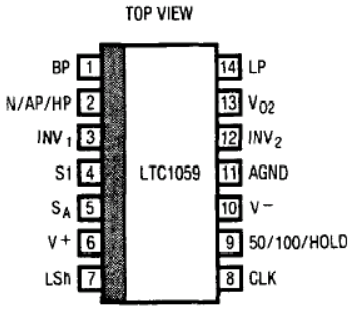
CONNECTIONS

PIN	NAME	FUNCTION
1	CLK	Clock input – use internal or external clock.
2	V-	Negative Supply pin. Dual supplies: -2.375V to –5.5V. *Single supply:* V-= 0V.
3	OP OUT	Uncommitted Op-Amp Output
4	OP IN	Inverting input to the uncommitted op amp. The noninverting op amp is internally tied to GND.
5	OUT	Filter Output
6	GND	Ground. In single-supply operation, GND must be biased to the mid-supply voltage level.
7	V+	Positive Supply pin. Dual supplies: +2.375V to +5.5V. Single supply: +4.75V to +11.0V
8	IN	Filter Input.

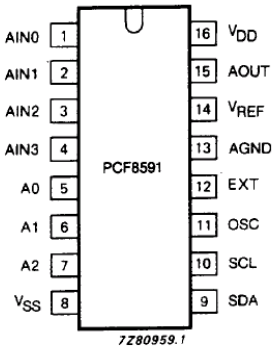
U16 & U25
Quad Low Power RS-232 Driver
Linear Tech, LTC4861S

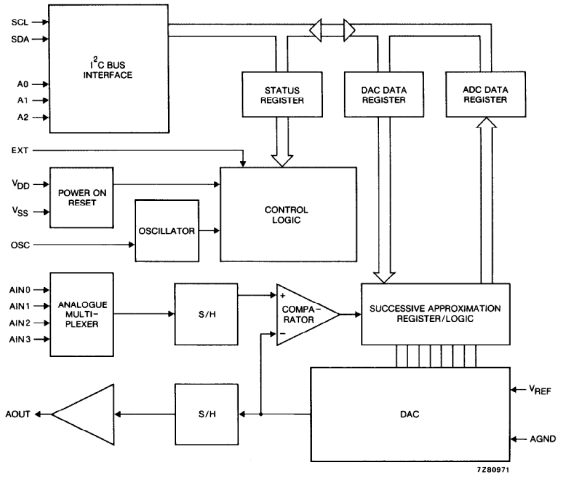


U21
High Performance Switched Capacitor Universal Filter
Linear Tech, LTC1059S

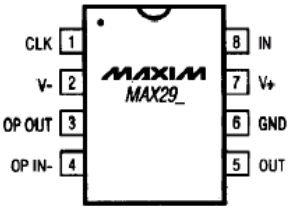


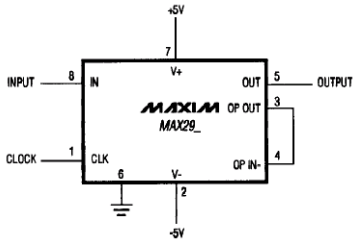
U23
8-Bit A/D and D/A Converter
Philips, PCF8591TD



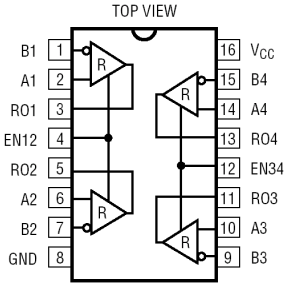


U24
+5V-Powered, Multi-Channel RS-232 Drivers/Receivers
Maxim, MAX232AESE

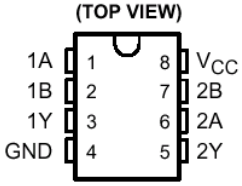




U26
Quad RS-485 Line Receiver
Linear Tech, LTC489S



U27
Dual Peripheral Drivers
TI, SN75451BD

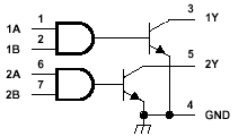


FUNCTION TABLE
(each driver)

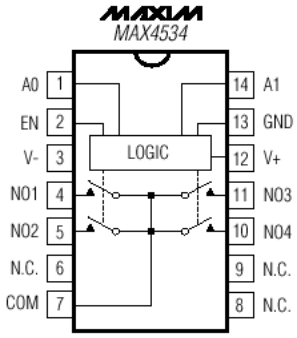
A	B	Y
L	L	H (off state)
L	H	H (off state)
H	L	H (off state)
H	H	L (on state)

positive logic:
$Y = \overline{AB}$ or $\overline{A}+\overline{B}$

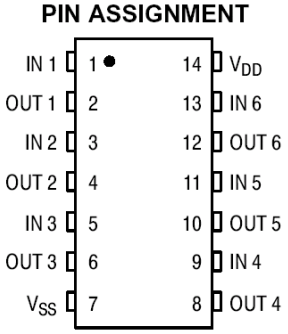
logic diagram (positive logic)

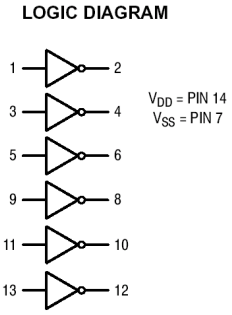


U31
Fault-Protected, High-Voltage, Single 4-to-1/Dual 2-to-1 Multiplexers
Maxim, MAX4534ESD

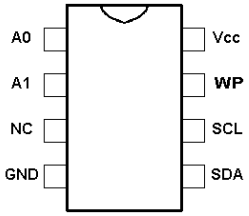


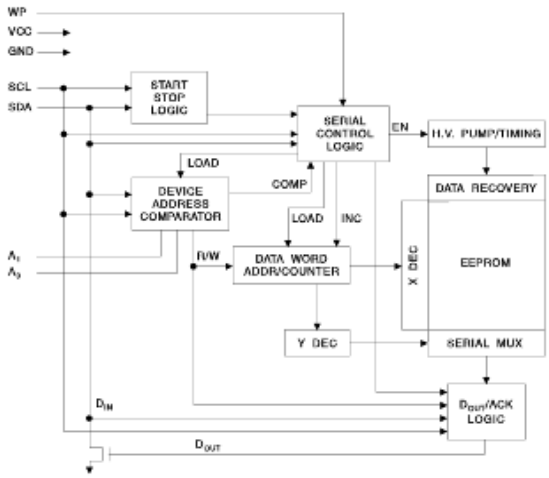
U32
HEX Inverter
Motorola, MC14069UBDR2





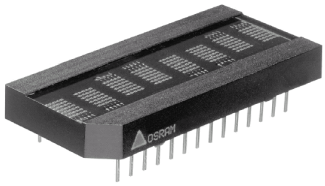
U34
EEPROM
Atmel AT24C128N-10SC-2.7



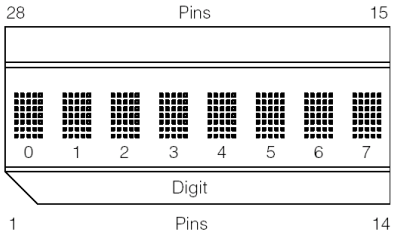


12.4 DISPLAY MODULE ASSEMBLY (A6)

U1
Smart LED Display Function
Siemens HSDP2112S



Top View

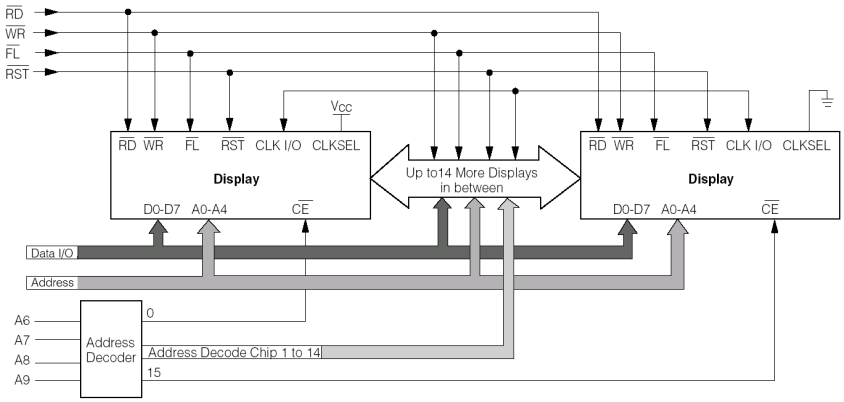


Pin Assignment

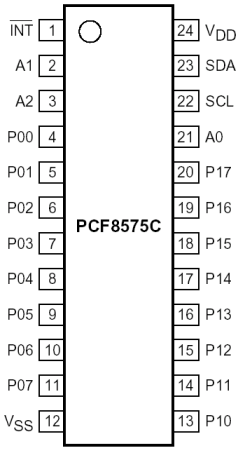
Pin	Function	Definition
1	$\overline{RST}$	Used to initialize a display and sychronize blinking for multiple displays
2	$\overline{FL}$	Low input accesses the Flash RAM
3	A0	Address input LSB
4	A1	Address input
5	A2	Address input MSB
6	A3	Mode selector
7	V_{CC}	Optional connection to positive power supply input.
8	V_{CC}	
9	V_{CC}	
10	A4	Mode Selector
11	$\overline{CLKSEL}$	Selects internal/high clock source

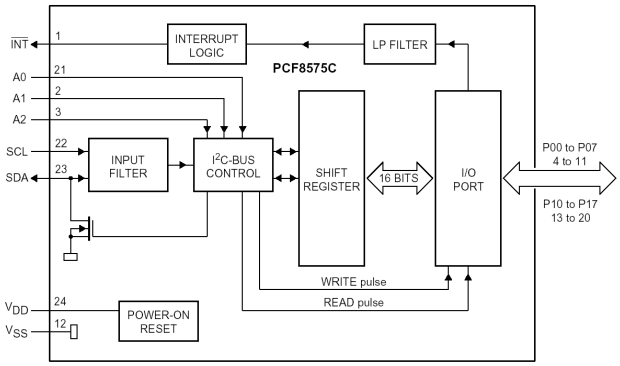
Pin Assignment (continued)

Pin	Function	Definition
12	CLK I/O	Outputs master clock or inputs external clock
13	$\overline{WR}$	A low will write data into the display if $\overline{CE}$ is low
14	V_{CC}	Positive power supply input
15	GND supply	Analog Ground for LED drivers
16	GND logic	Digital Ground for internal drivers
17	$\overline{CE}$	Enables access to the display
18	$\overline{RD}$	A low will read data from the display if $\overline{CE}$ is low. If read from display is not required, then $\overline{RD}$ can be tied to V_{CC}
19	D0	Data input LSB
20	D1	Data input
21	No pin	—
22	No pin	—
23	D2	Data input
24	D3	Data input
25	D4	Data input
26	D5	Data input
27	D6	Data input
28	D7	Data input MSB, selects ROM, page 1 or 2



U2
Remote 16-bit I/O Expander for I²C
Philips PCF8575TS





SYMBOL	PIN	DESCRIPTION
$\overline{INT}$	1	interrupt output (active LOW)
A1	2	address input 1
A2	3	address input 2
P00	4	quasi-bidirectional I/O 00
P01	5	quasi-bidirectional I/O 01
P02	6	quasi-bidirectional I/O 02
P03	7	quasi-bidirectional I/O 03
P04	8	quasi-bidirectional I/O 04
P05	9	quasi-bidirectional I/O 05
P06	10	quasi-bidirectional I/O 06
P07	11	quasi-bidirectional I/O 07
V_{SS}	12	supply ground
P10	13	quasi-bidirectional I/O 10
P11	14	quasi-bidirectional I/O 11
P12	15	quasi-bidirectional I/O 12
P13	16	quasi-bidirectional I/O 13
P14	17	quasi-bidirectional I/O 14
P15	18	quasi-bidirectional I/O 15
P16	19	quasi-bidirectional I/O 16
P17	20	quasi-bidirectional I/O 17
A0	21	address input 0
SCL	22	serial clock line input
SDA	23	serial data line input/output
V_{DD}	24	supply voltage

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